

CMOS 8-Bit Microcontroller

TMP87CM24AF, TMP87CP24AF

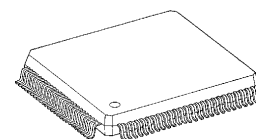
The TMP87CM24A/P24A are the high speed and high performance 8-bit single chip microcomputers. These MCU contain, large ROM, RAM, input/output ports, LCD driver, a 8-bit AD converter, four multi-function timer/counters, two serial interfaces, and two clock generators on chip.

Product No.	ROM	RAM	Package	OTP MCU
TMP87CM24A	32 K × 8 bits	2 K × 8 bits	P-LQFP100-1414-0.50C	TMP87PP24A
TMP87CP24A	48 K × 8 bits			

Features

- ◆ 8-bit single chip microcomputer TLCS-870 Series
- ◆ Instruction execution time: 0.5 μ s (at 8 MHz), 122 μ s (at 32 kHz)
- ◆ 129 types and 412 basic instructions
 - Multiplication and Division (8 bits × 8 bits, 16 bits ÷ 8 bits): Execution time 3.5 μ s (at 8 MHz)
 - Bit manipulations (Set/Clear/Complement/Load/Store/Test/Exclusive OR)
 - 16-bit data operations
 - 1-byte jump/call (Short relative jump/Vector call)
- ◆ 14 interrupt sources (External: 5, Internal: 9)
 - All sources have independent latches each, and nested interrupt control is available
 - 4 edge-selectable external interrupts with noise reject
 - High-speed task switching by register bank changeover
- ◆ 10-input/output ports (Max 69 pins)
- ◆ Two 16-bit timer/counters
 - Timer, Event counter, External trigger timer, Window, PPG output Pulse width measurement modes
- ◆ Two 8-bit timer/counters
 - Timer, Event counter, Capture (Pulse width/duty measurement), PWM output, PDO modes
- ◆ Time Base Timer (Interrupt frequency: 1 Hz to 16384 kHz)
- ◆ Divider output function (frequency: 1 kHz to 8 kHz)
- ◆ Watchdog Timer
- ◆ Two 8-bit Serial Interfaces
 - Each 8 bytes transmit/receive data buffer
 - Internal/external serial clock, and 4-/8-bit mode

P-LQFP100-1414-0.50C



TMP87CM24AF
TMP87CP24AF
TMP87PP24AF

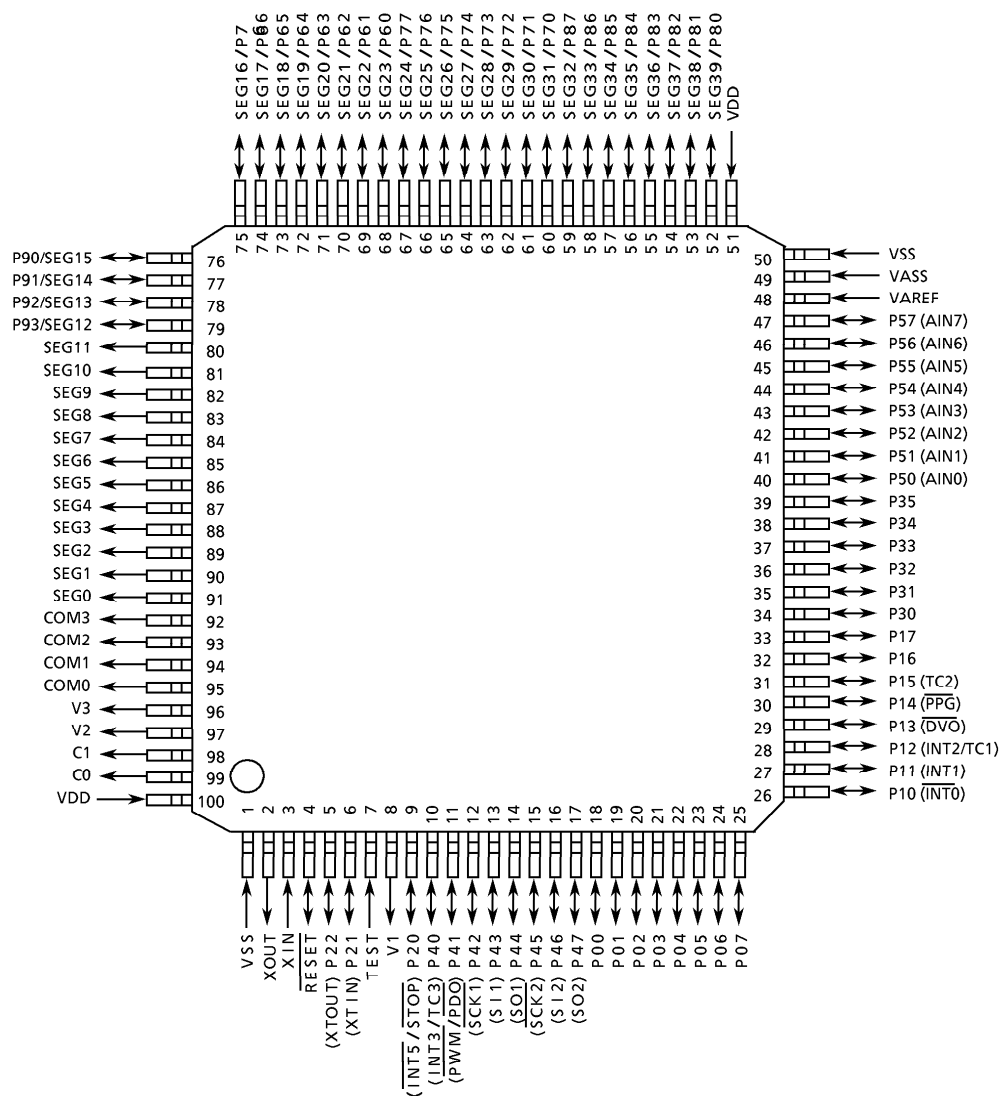
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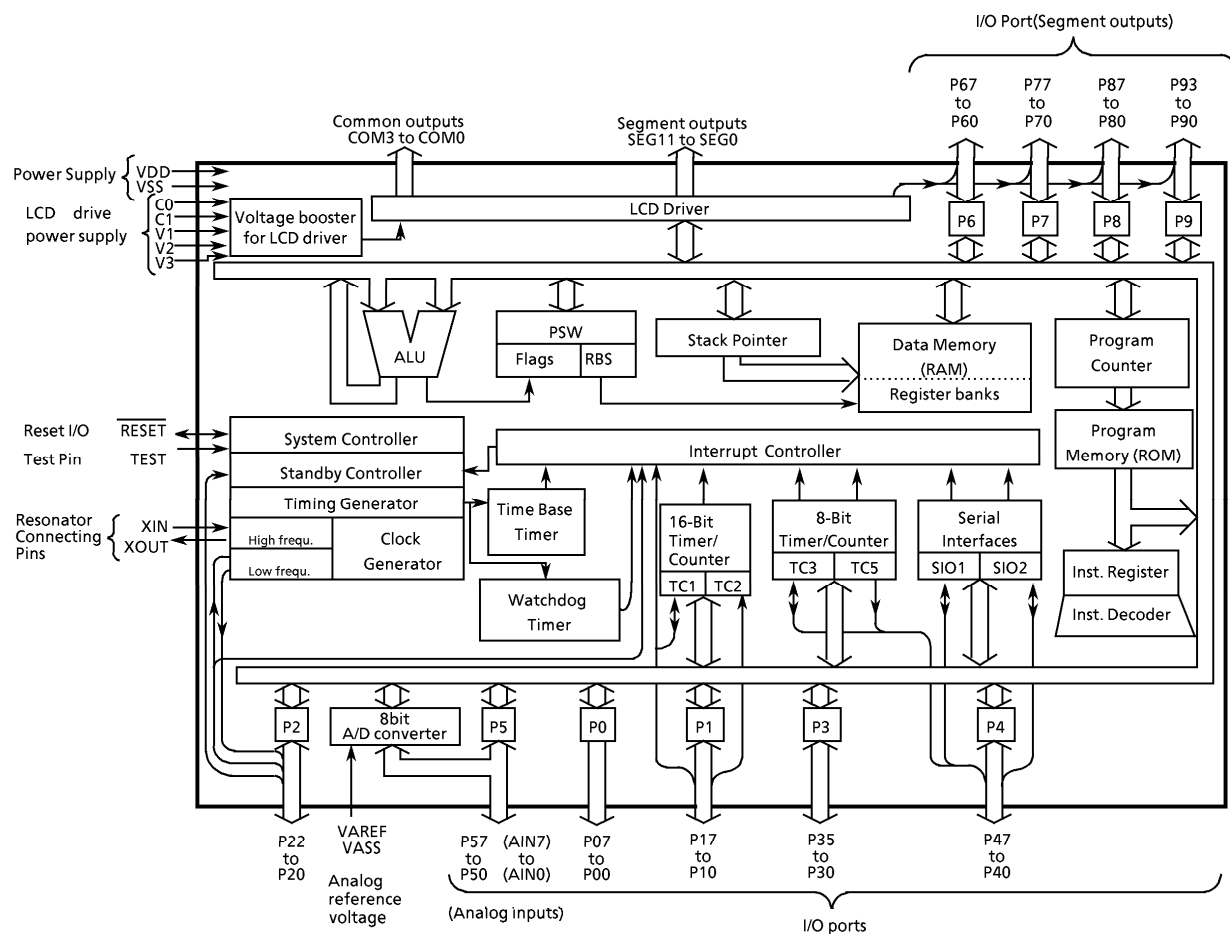
- ◆ LCD driver
 - Built-in voltage booster for LCD driver
 - With display memory (20 bytes)
 - LCD direct drive capability (Max 40 seg × 4 com)
 - 1/4, 1/3, 1/2 duty or static drive are programmably selectable
- ◆ 8-bit successive approximate type AD converter with sample and hold
 - 8 analog inputs
 - Conversion time: 23 μ s/92 μ s (at 8 MHz)
- ◆ Dual clock operation (optional)
- ◆ Five Power saving operating modes
 - STOP mode: Oscillation stops. Battery/Capacitor back-up. Port output hold/high-impedance.
 - SLOW mode: Low power consumption operation using low-frequency clock (32.768 kHz).
 - IDLE1 mode: CPU stops, and Peripherals operate using high-frequency clock.
Release by interrupts.
 - IDLE2 mode: CPU stops, and Peripherals operate using high and low frequency clock.
Release by interrupts.
 - SLEEP mode: CPU stops, and Peripherals operate using low-frequency clock.
Release by interrupts.
- ◆ Operating Voltage: 2.2 to 5.5 V at 4.2 MHz/32.768 kHz, 4.5 to 5.5 V at 8 MHz/32.768 kHz
- ◆ Emulation Pod: BM87CP24F0A

Pin Assignments (Top View)

P-LQFP100-1414-0.50C



Block Diagram



Pin Functions

Pin Name	Input/Output	Function	
P07 to P00 P17, P16	I/O	8-bit programmable input/output ports (tri-state).	
P15 (TC2)	I/O (Input)	Each bit of these ports can be individually configured as an input or an output under software control.	Timer/Counter 2 input
P14 (PPG)	I/O (Output)		Programmable pulse generator output
P13 (DVO)		When used as an input port, timer/counter input or external interrupt input, the P0CR/P1CR must be set to "0". When used as timer/counter output or divider output, the P0CR/P1CR must be set to "1" after setting output latch to "1".	Divider output
P12 (INT2/TC1)	I/O (Input)		External interrupt 2 input or Timer/Counter 1 input
P11 (INT1)			External interrupt 1 input
P10 (INT0)			External interrupt 0 input
P22 (XTOUT)	I/O (Output)	3-bit input/output port with latch.	Resonator connecting pins (32.768 kHz).
P21 (XTIN)	I/O (Input)	When used as an input port, external interrupt input or STOP mode release input, the output latch must be set to "1".	For inputting external clock, XTIN is used and XTOUT is opened.
P20 (INT5/STOP)			External interrupt 5 input or STOP mode release signal input
P35 to P30	I/O	6-bit input/output port with latch. When used as input port, the output latch must be set to "1".	
P47 (SO2)	I/O (Output)	8-bit input/output port with latch.	SIO2 serial data output
P46 (SI2)	I/O (Input)	When used as serial interface output or timer/counter output, the P4CR1 must be set to "1" after setting output latch to "1".	SIO2 serial data input
P45 (SCK2)	I/O (I/O)		SIO2 serial clock input/output
P44 (SO1)	I/O (Output)	When used as an input port, serial interface input or external interrupt input, the P4CR1 must be set to "0".	SIO1 serial data output
P43 (SI1)	I/O (Input)		SIO1 serial data input
P42 (SCK1)	I/O (I/O)		SIO1 serial clock input/output
P41 (PWM/PDO)	I/O (Output)		8-bit PWM output, 8-bit programmable divider output
P40 (INT3/TC3)	I/O (Input)		External interrupt 3 input, Timer/Counter 3 input
P57 (AIN07) to P50 (AIN00)	I/O (Input)	8-bit programmable input/output port (tri-state). Each bit of the port can be individually configured as an input or an output under software control. When used as analog input, the P5CR must be set to "0".	AD converter analog inputs
SEG39 (P80) to SEG32 (P87)	Output (I/O)	8-bit input/output port with latch.	LCD segment outputs. When used as segment output, the segment output control register must be set to "1".
SEG31 (P70) to SEG24 (P77)	Output (I/O)	When used as an input port, the segment output control register must be set to "0" after setting output latch to "1".	
SEG23 (P60) to SEG16 (P67)	Output (I/O)		
SEG15 (P90) to SEG12 (P93)	Output (I/O)	4-bit input/output port with latch. When used as an input port, the segment output control register must be set to "0" after setting output latch to "1".	
SEG11 to SEG0	Output	LCD segment outputs	
COM3 to COM0	Output	LCD common outputs	
XIN, XOUT	Input, Output	Resonator connecting pins for high-frequency clock. For inputting external clock, XIN is used and XOUT is opened.	
RESET	I/O	Reset signal input or watchdog timer output/address-trap-reset output	
TEST	Input	Test pin for out-going test. Be fixed to low.	
VDD, VSS	Power Supply	+ 5 V, 0 V (GND)	
VAREF, VASS		Analog reference voltage inputs (High, Low)	
C0, C1, V1, V2, V3	LCD voltage booster pin	LCD voltage booster pin. Capacitors are required between C0 and C1 pin and between V1/V2/V3 pin and GND.	

Operational Description

1. CPU Core Functions

The CPU core consists of a CPU, a system clock controller, an interrupt controller, and a watchdog timer. This section provides a description of the CPU core, the program memory (ROM), the data memory (RAM), and the reset circuit.

1.1 Memory Address Map

The TLCS-870 Series is capable of addressing 64K bytes of memory. Figure 1-1 shows the memory address maps of the TMP87CM24A/P24A. In the TLCS-870 Series, the memory is organized 4 address spaces (ROM, RAM, SFR, and DBR). It uses a memory mapped I/O system, and all I/O registers are mapped in the SFR/DBR address spaces. There are 16 banks of general-purpose registers. The register banks are also assigned to the first 128 bytes of the RAM address space.

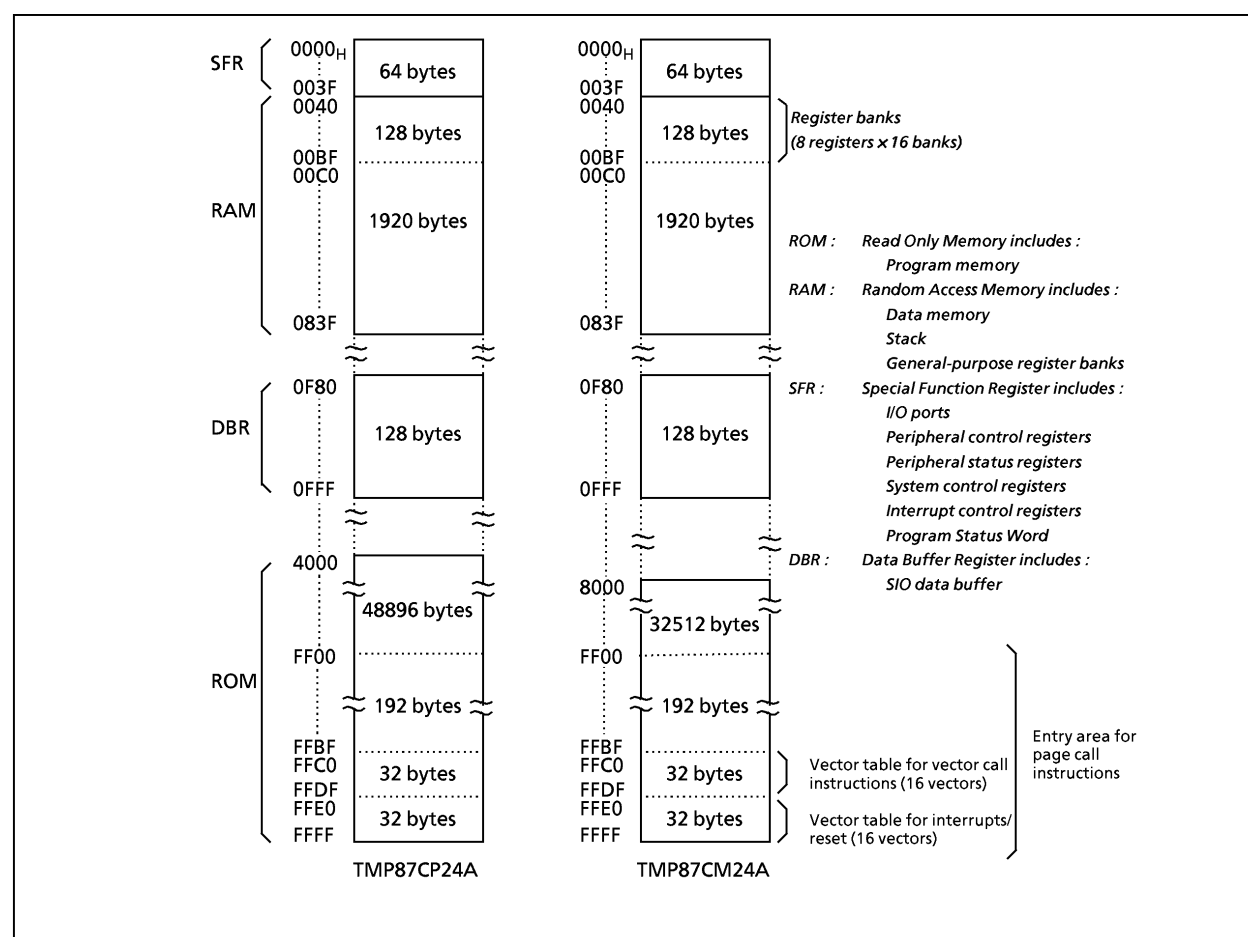


Figure 1-1. Memory Address Maps

1.2 Program Memory (ROM)

The TMP87CM24A has a $32K \times 8$ -bit (addresses 8000_H to $FFFF_H$), and the TMP87CP24A has a $48K \times 8$ -bit (addresses 4000_H to $FFFF_H$) of program memory (mask programmed ROM).

Addresses $FF00_H$ to $FFFF_H$ in the program memory can also be used for special purposes.

(1) **Interrupt/Reset vector table** (addresses $FFE0_H$ to $FFFF_H$)

This table consists of a reset vector and 15 interrupt vectors (2 bytes/vector). These vectors store a reset start address and interrupt service routine entry addresses.

(2) **Vector table for vector call instructions** (addresses $FFC0_H$ to $FFDF_H$)

This table stores call vectors (subroutine entry address, 2 bytes/vector) for the vector call instructions [CALLV n]. There are 16 vectors. The CALLV instruction increases memory efficiency when utilized for frequently used subroutine calls (called from 3 or more locations).

(3) **Entry area** (addresses $FF00_H$ to $FFFF_H$) for **page call instructions**

This is the subroutine entry address area for the page call instructions [CALLP n]. Addresses $FF00_H$ - $FFBF_H$ are normally used because address $FFC0_H$ to $FFFF_H$ are used for the vector tables.

Programs and fixed data are stored in the program memory. The instruction to be executed next is read from the address indicated by the current contents of the program counter (PC). There are relative jump and absolute jump instructions. The concepts of page or bank boundaries are not used in the program memory concerning any jump instruction.

Example: The relationship between the jump instructions and the PC.

① 5-bit PC-relative jump [JRS cc, \$ + 2 + d]

E8C4H: JRS T, \$ + 2 + 08H

When $JF = 1$, the jump is made to $E8CE_H$, which is 08_H added to the contents of the PC. (The PC contains the address of the instruction being executed + 2; therefore, in this case, the PC contents are $E8C4_H + 2 = E8C6_H$.)

② 8-bit PC-relative jump [JR cc, \$ + 2 + d]

E8C4H: JR Z, \$ + 2 + 80H

When $ZF = 1$, the jump is made to $E846_H$, which is $FF80_H$ (−128) added to the current contents of the PC.

③ 16-bit absolute jump [JP a]

E8C4H: JP 0C235H

An unconditional jump is made to address $C235_H$. The absolute jump instruction can jump anywhere within the entire 64-Kbyte space.

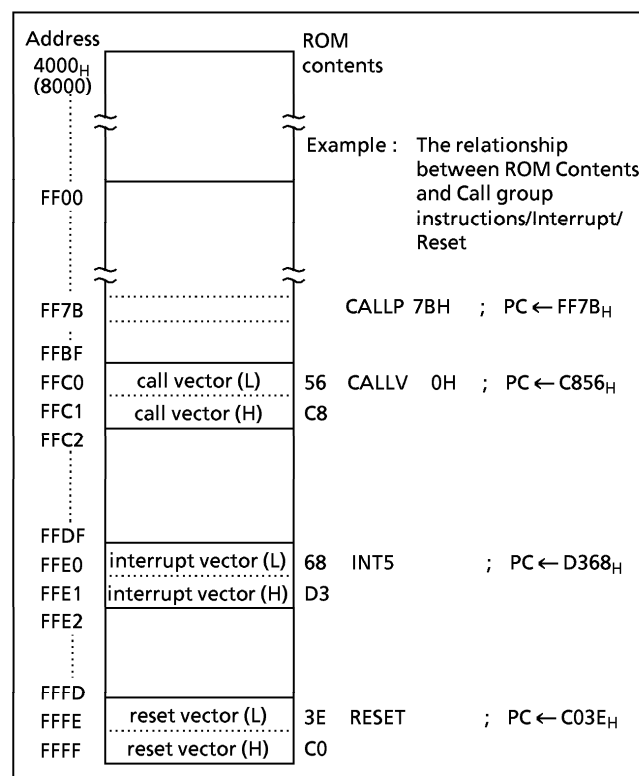


Figure 1-2. Program Memory Map

In the TLCS-870 Series, the same instruction used to access the data memory (e.g. [LD A, (HL)]) is also used to read out fixed data (ROM data) stored in the program memory. The register-offset PC-relative addressing (PC + A) instructions can also be used, and the code conversion, table look-up and n-way multiple jump processing can easily be programmed.

Example 1 : Loads the ROM contents at the address specified by the HL register pair contents into the accumulator (TMP87CM24A : $HL \geq 8000_H$):

```
LD    A, (HL)          ; A ← ROM (HL)
```

Example 2 : Converts BCD to 7-segment code (common anode LED). When A = 05_H , 92_H is output to port P6 after executing the following program:

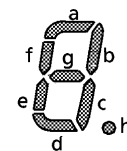
```
ADD    A, TABLE - $ - 4      ; P6 ← ROM (TABLE + A)
LD     (P6), (PC + A)
JRS    T, SNEXT              ; Jump to SNEXT
TABLE: DB    0C0H, 0F9H, 0A4H, 0B0H, 99H, 92H, 82H, 0D8H, 80H, 98H
SNEXT:
```

Notes : "\$" is a header address of ADD instruction.
DB is a byte data definition instruction.

Example 3 : N-way multiple jump in accordance with the contents of accumulator ($0 \leq A \leq 3$):

```
SHLC    A                  ; if A = 00_H then PC ← C234_H
JP      (PC + A)           ; if A = 01_H then PC ← C378_H
                          ; if A = 02_H then PC ← DA37_H
                          ; if A = 03_H then PC ← E1B0_H
DW      0C234H, 0C378H, 0DA37H, 0E1B0H
```

Note : DW is a word data definition instruction. Word = 2bytes



SHLC A
JP (PC + A)
34
C2
78
C3
37
DA
B0
E1

1.3 Program Counter (PC)

The program counter (PC) is a 16-bit register which indicates the program memory address where the instruction to be executed next is stored. After reset, the user defined reset vector stored in the vector table (addresses $FFFF_H$ and $FFFE_H$) is loaded into the PC ; therefore, program execution is possible from any desired address. For example, when $C0_H$ and $3E_H$ are stored at addresses $FFFF_H$ and $FFFE_H$, respectively, the execution starts from address $C03E_H$ after reset.

The TLC8-870 Series utilizes pipelined processing (instruction pre-fetch); therefore, the PC always indicates 2 addresses in advance. For example, while a 1-byte instruction stored at address $C123_H$ is being executed, the PC contains $C125_H$.

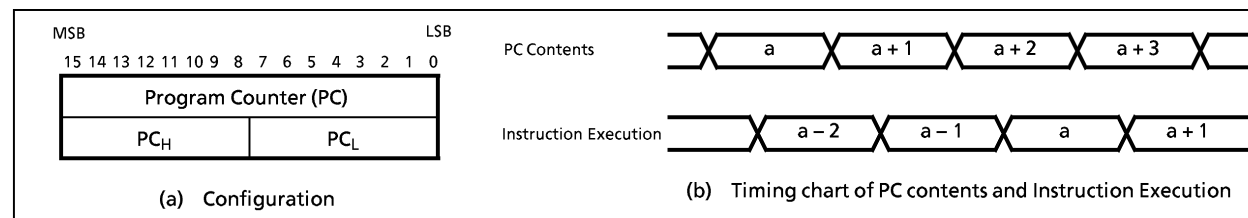


Figure 1-3. Program Counter

1.4 Data Memory (RAM)

The TMP87CM24A/P24A have a $2K \times 8$ -bit (address 0040_H to $083F_H$) of data memory (static RAM). Figure 1-4 shows the data memory map.

Addresses 0000_H to $00FF_H$ are used as a direct addressing area to enhance instructions which utilize this addressing mode; therefore, addresses 0040_H to $00FF_H$ in the data memory can also be used for user flags or user counters.

Example 1 : If bit 2 at data memory address $00C0_H$ is "1", 00_H is written to data memory at address $00E3_H$; otherwise, FF_H is written to the data memory at address $00E3_H$.

```

TEST      (00C0H).2          ; if (00C0H) 2 = 0 then jump
JRS       T,SZERO
CLR       (00E3H)             ; (00E3H) ← 00H
JRS       T,SNEXT
SZERO :   LD       (00E3H), 0FFH ; (00E3H) ← FFH
SNEXT :
```

Example 2 : Increments the contents of data memory at address $00F5_H$, and clears to 00_H when 10_H is exceeded.

```

INC       (00F5H)             ; (00F5H) ← (00F5H) + 1
AND       (00F5H), 0FH        ; (00F5H) ← (00F5H) ∧ 0FH
```

General-purpose register banks (8 registers \times 16 banks) are also assigned to the 128 bytes of addresses 0040_H – $00BF_H$. Access as data memory is still possible even when being used for registers. For example, when the contents of the data memory at address 0040_H is read out, the contents of the accumulator in the bank 0 are also read out. The stack can be located anywhere within the data memory except the register bank area. The stack depth is limited only by the free data memory size. For more details on the stack, see section "1.7 Stack and Stack Pointer".

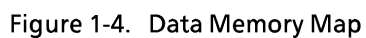
With the TMP87CM24A/P24A, programs in data memory cannot be executed. If the program counter indicates a specific data memory address (addresses 0040_H to $083F_H$), an address-trap-reset is generated due to bus error. (Output from the \overline{RESET} pin goes low.)

Example : Clears RAM to "00H" except the bank 0

```

LD        HL, 0048H           ; Sets start address to HL register pair
LD        A, H                ; Sets initial data (00H) to A register
LD        BC, 07F7H           ; Sets number of byte to BC register pair
SRAMCLR : LD        (HL+), A
DEC       BC
JRS       F, SRAMCLR
```

Note: The data memory contents become unstable when the power supply is turned on; therefore, the data memory should be initialized by an initialization routine. Note that the general-purpose registers are mapped in the RAM; therefore, do not clear RAM at the current bank addresses.



1.5 General-purpose Register Banks

General-purpose registers are mapped into addresses 0040_H to 00BF_H in the data memory as shown in Figure 1-4. There are 16 register banks, and each bank contains 8-bit registers W, A, B, C, D, E, H, and L. Figure 1-5 shows the general-purpose register bank configuration.

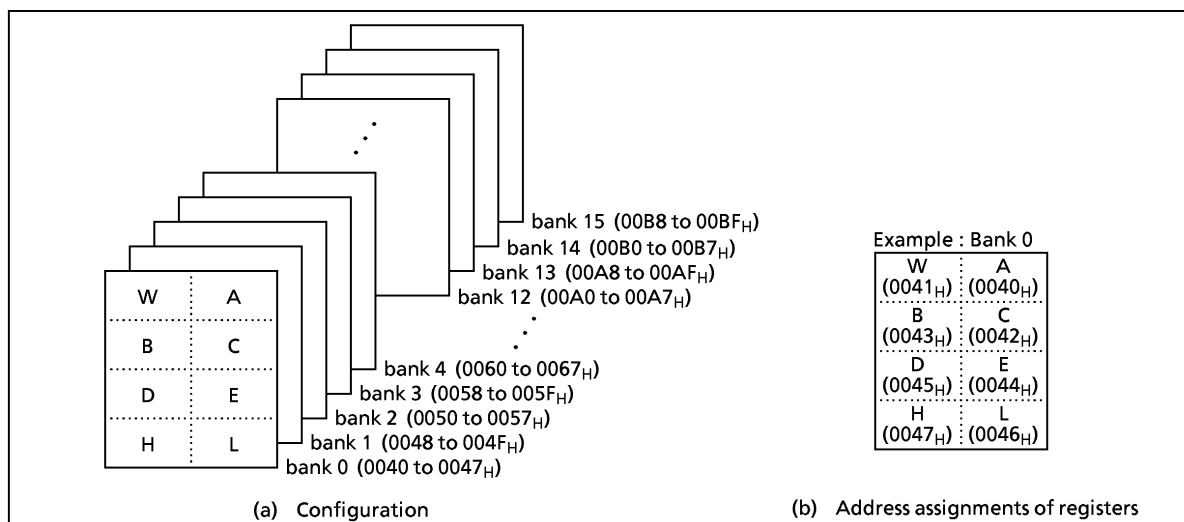


Figure 1-5. General-purpose Register Banks

In addition to access in 8-bit units, the registers can also be accessed in 16-bit units as the register pairs WA, BC, DE, and HL. Besides its function as a general-purpose register, the register also has the following functions:

(1) A, WA

The A register functions as an 8-bit accumulator and WA the register pair functions as a 16-bit accumulator (W is high byte and A is low byte). Registers other than A can also be used as accumulators for 8-bit operations.

Examples :

①	ADD A, B	; Adds B contents to A contents and stores the result into A.
②	SUB WA, 1234 _H	; Subtracts 1234 _H from WA contents and stores the result into WA.
③	SUB E, A	; Subtracts A contents from E contents, and stores the result into E.

(2) HL, DE

The HL and DE specify a memory address. The HL register pair functions as data pointer (HL) /index register (HL + d) /base register (HL + C), and the DE register pair function as a data pointer (DE). The HL also has an auto-post-increment and auto-pre-decrement functions. This function simplifies multiple digit data processing, software LIFO (last-in first-out) processing, etc.

Example 1 :

①	LD A, (HL)	; Loads the memory contents at the address specified by HL into A.
②	LD A, (HL + 52 _H)	; Loads the memory contents at the address specified by the value obtained by adding 52 _H to HL contents into A.
③	LD A, (HL + C)	; Loads the memory contents at the address specified by the value obtained by adding the register C contents to HL contents into A.
④	LD A, (HL +)	; Loads the memory contents at the address specified by HL into A. Then increments HL.
⑤	LD A, (- HL)	; Decrements HL. Then loads the memory contents at the address specified by new HL into A.

The TLCS-870 Series can transfer data directly memory to memory, and operate directly between memory data and memory data. This facilitates the programming of block processing.

Example 2 : Block transfer

```

LD      B, m           ; m = n - 1 (n : Number of bytes to transfer)
LD      HL, DSTA       ; Sets destination address to HL
LD      DE, SRCA       ; Sets source address to DE
SLOOP:  LD      (HL), (DE) ; HL ← DE
INC     HL             ; HL ← HL + 1
INC     DE             ; DE ← DE + 1
DEC     B             ; B ← B - 1
JRS     F, SLOOP       ; if B ≥ 0 then loop

```

(3) **B, C, BC**

Registers B and C can be used as 8-bit buffers or counters, and the BC register pair can be used as a 16-bit buffer or counter. The C register functions as an offset register for register-offset index addressing (refer to example 1 ③ above) and as a divisor register for the division instruction [DIV gg, C].

Example 1 : Repeat processing

```

LD      B, n           ; Sets n as the number of repetitions to B
SREPEAT: processing      ; (n + 1 times processing)
DEC     B
JRS     F, SREPEAT

```

Example 2 : Unsigned integer division (16-bit ÷ 8-bit)

```

DIV     WA, C          ; Divides the WA contents by the C contents, places the
                      ; quotient in A and the remainder in W.

```

The general-purpose register banks are selected by the 4-bit register bank selector (RBS). During reset, the RBS is initialized to "0". The bank selected by the RBS is called the current bank.

Together with the flag, the RBS is assigned to address 003FH in the SFR as the program status word (PSW). There are 3 instructions [LD RBS, n], [PUSH PSW], [POP PSW] to access the PSW. The PSW can be also operated by the memory access instruction.

Example 1 : Incrementing the RBS

```

INC     (003FH)        ; RBS ← RBS + 1

```

Example 2 : Reading the RBS

```

LD      A, (003FH)     ; A ← RBS (A3 to 0 ← RBS, A7 to 4 ← Flags)

```

Highly efficient programming and high-speed task switching are possible by using bank changeover to save registers during interrupt and to transfer parameters during subroutine processing.

During interrupt, the PSW is automatically saved onto the stack. The bank used before the interrupt was accepted is restored automatically by executing an interrupt return instruction [RETI]/[RETN] ; therefore, there is no need for the RBS save/restore software processing.

The TLCS-870 Series supports a maximum of 15 interrupt sources. One bank is assigned to the main program, and one bank can be assigned to each source. Also, to increase the efficiency of data memory usage, assign the same bank to interrupt sources which are not nested.

Example: Saving/restoring registers during interrupt task using bank changeover.

```

PINT1:  LD      RBS, n   ; RBS ← n (Bank changeover)
        Interrupt processing
        RETI           ; Maskable interrupt return (Bank restoring)

```

1.6 Program Status Word (PSW)

The program status word (PSW) consists of a register bank selector (RBS) and four flags, and the PSW is assigned to address 003FH in the SFR.

The RBS can be read and written using the memory access instruction (e.g. [LD A, (003FH)], [LD (003FH), A]), however the flags can only be read. When writing to the PSW, the change specified by the instruction is made without writing data to the flags. For example, when the instruction [LD (003FH), 05H] is executed, "5" is written to the RBS and the JF is set to "1", but the other flags are not affected.

[PUSH PSW] and [POP PSW] are the PSW access instructions.

1.6.1 Register Bank Selector (RBS)

The register bank selector (RBS) is a 4-bit register used to select general-purpose register banks. For example, when RBS = 2, bank 2 is currently selected. During reset, the RBS is initialized to "0".

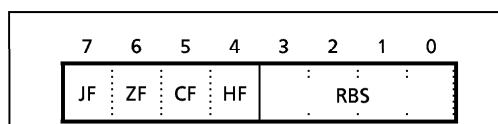


Figure 1-6. PSW (Flags, RBS) Configuration

1.6.2 Flags

The flags are configured with the upper 4 bits : a zero flag, a carry flag, a half carry flag and a jump status flag. The flags are set or cleared under conditions specified by the instruction. These flags except the half carry flag are used as jump condition "cc" for conditional jump instructions [JR cc, \$ + 2 + d]/[JRS cc, \$ + 2 + d]. After reset, the jump status flag is initialized to "1", other flags are not affected.

(1) Zero flag (ZF)

The ZF is set to "1" if the operation result or the transfer data is 00H (for 8-bit operations and data transfers)/0000H (for 16-bit operations); otherwise the ZF is cleared to "0".

During the bit manipulation instructions [SET, CLR, and CPL], the ZF is set to "1" if the contents of the specified bit is "0"; otherwise the ZF is cleared to "0".

This flag is set to "1" when the upper 8 bits of the product are 00H during the multiplication instruction [MUL], and when 00H for the remainder during the division instruction [DIV]; otherwise it is cleared to "0".

(2) Carry flag (CF)

The CF is set to "1" when a carry out of the MSB (most significant bit) of the result occurred during addition or when a borrow into the MSB of the result occurred during subtraction; otherwise the CF is cleared to "0". During division, this flag is set to "1" when the divisor is 00H (divided by zero error), or when the quotient is 100H or higher (overflow error); otherwise it is cleared. The CF is also affected during the shift/rotate instructions [SHLC, SHRC, ROLC, and RORC]. The data shifted out from a register is set to the CF.

This flag is also a 1-bit register (a boolean accumulator) for the bit manipulation instructions.

Set/clear/complement are possible with the CF manipulation instructions.

Example 1 : Bit manipulation (The result of exclusive-OR between bit 5 content of address 07H and bit 0 content of address 9AH is written to bit 2 of address 01H.)

```
LD      CF, (0007H) . 5      ; (0001H)2 ← (0007H)5 ∨ (009AH)0
XOR     CF, (009AH) . 0
LD      (0001H) . 2, CF
```

(3) Half carry flag (HF)

The HF is set to "1" when a carry occurred between bits 3 and 4 of the operation result during an 8-bit addition, or when a borrow occurred from bit 4 into bit 3 of the result during an 8-bit subtraction; otherwise the HF is cleared to "0". This flag is useful in the decimal adjustment for BCD operations (adjustments using the [DAA r], or [DAS r] instructions).

Example : BCD operation

(The A becomes 47_H after executing the following program when A = 19_H, B = 28_H)

```

ADD    A, B          ; A ← 41H, HF ← 1, CF ← 0
DAA    A              ; A ← 41H + 06H = 47H (decimal-adjust)

```

(4) Jump status flag (JF)

Zero or carry information is set to the JF after operation (e. g. INC, ADD, CMP, TEST).

The JF provides the jump condition for conditional jump instructions [JRS T/F, \$ + 2 + d], [JR T/F, \$ + 2 + d] (T or F is a condition code). Jump is performed if the JF is "1" for a true condition (T), or the JF is "0" for a false condition (F).

The JF is set to "1" after executing the load/exchange/swap/nibble rotate/jump instruction, so that [JRS T, \$ + 2 + d] and [JR T, \$ + 2 + d] can be regarded as an unconditional jump instruction.

Example : Jump status flag and conditional jump instruction

```

INC    A
JRS    T, SLABLE1      ; Jump when a carry is caused by the immediately
                        ; preceding operation instruction.
:
LD     A, (HL)
JRS    T, SLABLE2      ; JF is set to "1" by the immediately preceding
                        ; instruction, making it an unconditional jump
                        ; instruction.
:

```

Example : The accumulator and flags become as shown below after executing the following instructions when the WA register pair, the HL register pair, the data memory at address 00C5_H, the carry flag and the half carry flag contents being "219A_H", "00C5_H", "D7_H", "1" and "0", respectively.

Instruction	Acc. after execution	Flag after execution			
		JF	ZF	CF	HF
ADDC A, (HL)	72	1	0	1	1
SUBB A, (HL)	C2	1	0	1	0
CMP A, (HL)	9A	0	0	1	0
AND A, (HL)	92	0	0	1	0
LD A, (HL)	D7	1	0	1	0
ADD A, 66H	00	1	1	1	1

Instruction	Acc. after execution	Flag after execution			
		JF	ZF	CF	HF
INC A	9B	0	0	1	0
ROL A	35	1	0	1	0
ROR A	CD	0	0	0	0
ADD WA, 0F508H	16A2	1	0	1	0
MUL W, A	13DA	0	0	1	0
SET A.5	BA	1	1	1	0

1.7 Stack and Stack Pointer

1.7.1 Stack

The stack provides the area in which the return address or status, etc. are saved before a jump is performed to the processing routine during the execution of a subroutine call instruction or the acceptance of an interrupt. On a subroutine call instruction [CALL a]/[CALLP n]/[CALLV n], the contents of the PC (the return address) is saved; on an interrupt acceptance, the contents of the PC and the PSW are saved (the PSW is pushed first, followed by PC_H and PC_L). Therefore, a subroutine call occupies two bytes on the stack; an interrupt occupies three bytes.

When returning from the processing routine, executing a subroutine return instruction [RET] restores the contents to the PC from the stack; executing an interrupt return instruction [RETI]/[RETN] restores the contents to the PC and the PSW (the PC_L is popped first, followed by PC_H and PSW).

The stack can be located anywhere within the data memory space except the register bank area, therefore the stack depth is limited only by the free data memory size.

1.7.2 Stack Pointer (SP)

The stack pointer (SP) is a 16-bit register containing the address of the next free locations on the stack.

The SP is post-decremented when a subroutine call or a push instruction is executed, or when an interrupt is accepted; and the SP is pre-incremented when a return or a pop instruction is executed. Figure 1-8 shows the stacking order.

The SP is not initialized hardware-wise but requires initialization by an initialize routine (sets the highest stack address). [LD SP, mn], [LD SP, gg] and [LD gg, SP] are the SP access instructions (mn; 16-bit immediate data, gg; register pair).

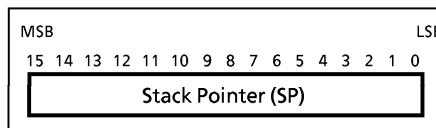


Figure 1-7. Stack Pointer

Example 1 : To initialize the SP

```
LD    SP, 083FH    ; SP ← 083FH
```

Example 2 : To read the SP

```
LD    HL, SP        ; HL ← SP
```

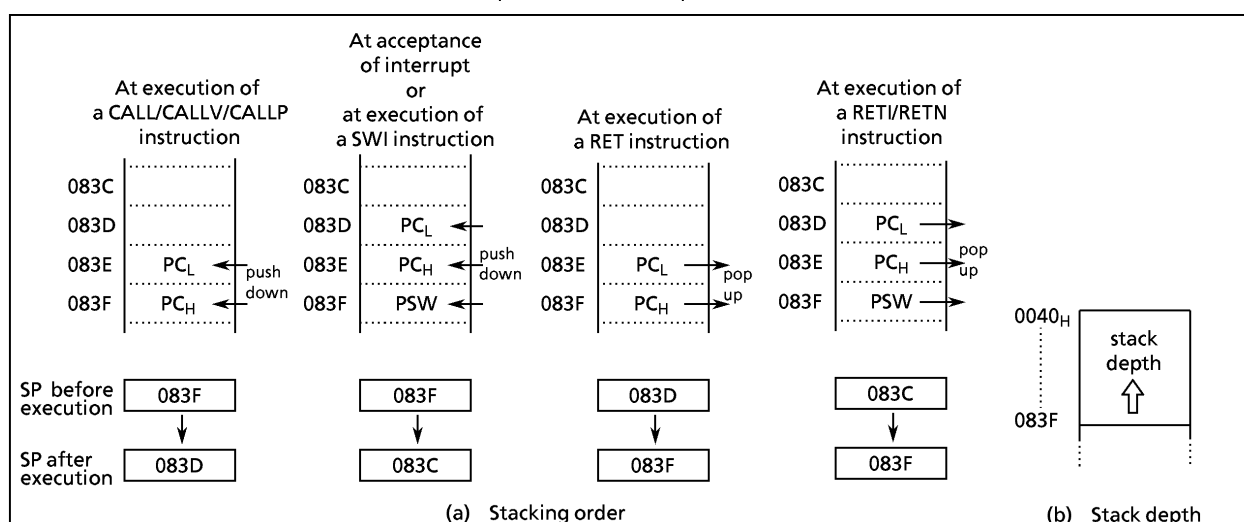


Figure 1-8. Stack

1.8 System Clock Controller

The system clock controller consists of a clock generator, a timing generator, and a stand-by controller.

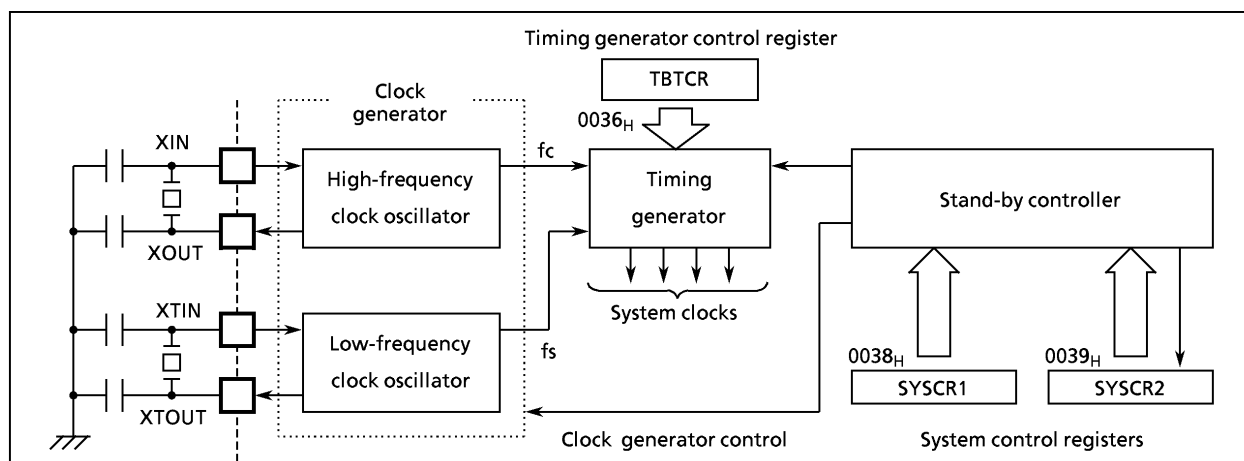


Figure 1-9. System Clock Controller

1.8.1 Clock Generator

The clock generator generates the basic clock which provides the system clocks supplied to the CPU core and peripheral hardware. It contains two oscillation circuits: one for the high-frequency clock and one for the low-frequency clock. Power consumption can be reduced by switching of the system clock controller to low-power operation based on the low-frequency clock.

The high-frequency (f_c) and low-frequency (f_s) clocks can be easily obtained by connecting a resonator between the XIN/XOUT and XTIN/XTOUT pins, respectively. Clock input from an external oscillator is also possible. In this case, external clock is applied to the XIN/XTIN pin with the XOUT/XTOUT pin not connected. The TMP87CM24A/P24A are not provided an RC oscillation.

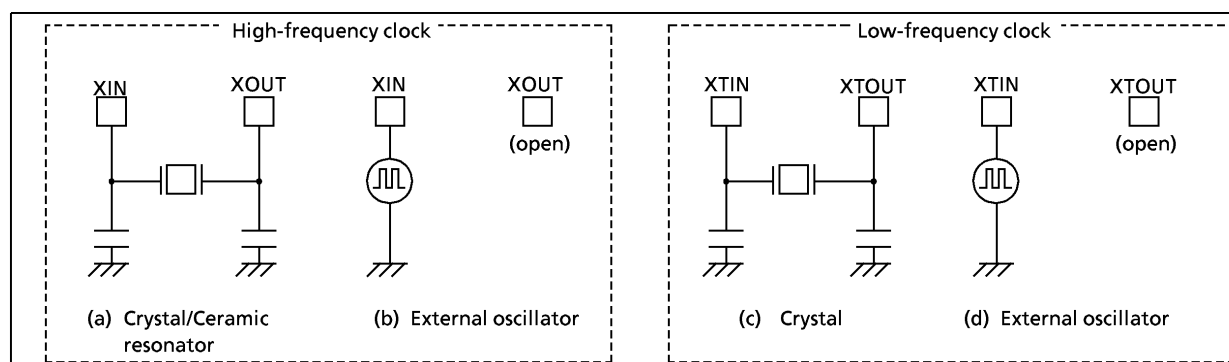


Figure 1-10. Examples of Resonator Connection

Note: *Accurate Adjustment of the Oscillation Frequency:*
 Although no hardware to externally and directly monitor the basic clock pulse is not provided, the oscillation frequency can be adjusted by making the program to output fixed frequency pulses to the port while disabling all interrupts and monitoring this pulse. With a system requiring adjustment of the oscillation frequency, the adjusting program must be created beforehand.

1.8.2 Timing Generator

The timing generator generates from the basic clock the various system clocks supplied to the CPU core and peripheral hardware. The timing generator provides the following functions :

- ① Generation of main system clock
- ② Generation of divider output (\overline{DVO}) pulses
- ③ Generation of source clocks for time base timer
- ④ Generation of source clocks for watchdog timer
- ⑤ Generation of internal source clocks for timer/counters TC1 – TC3, TC5
- ⑥ Generation of internal clocks for serial interfaces SIO1 and SIO2
- ⑦ Generation of warm-up clocks for releasing STOP mode
- ⑧ Generation of a clock for releasing reset output

(1) Configuration of Timing Generator

The timing generator consists of a 21-stage divider with a divided-by-4 prescaler, a main system clock generator, and machine cycle counters. An input clock to the 7th stage of the divider depends on the operating mode and DV7CK (bit 4 in TBTCR) shown in Figure 1-11 as follows.

During reset and at releasing STOP mode, the divider is cleared to "0", however, the prescaler is not cleared.

- ① In the single-clock mode
A divided-by-256 of high-frequency clock ($f_c/2^8$) is input to the 7th stage of the divider.
Do not set DVCK to "1" in the single-clock mode.
- ② In the dual-clock mode
During NORMAL2 or IDLE2 mode (SYSCK = 0), an input clock to the 7th stage of the divider can be selected either " $f_c/2^8$ " or " f_s " with DV7CK.
During SLOW or SLEEP mode (SYSCK = 1), f_s is automatically input to the 7th stage. To input clock to the 1st stage is stopped ; output from the 1st to 6th stages is also stopped.

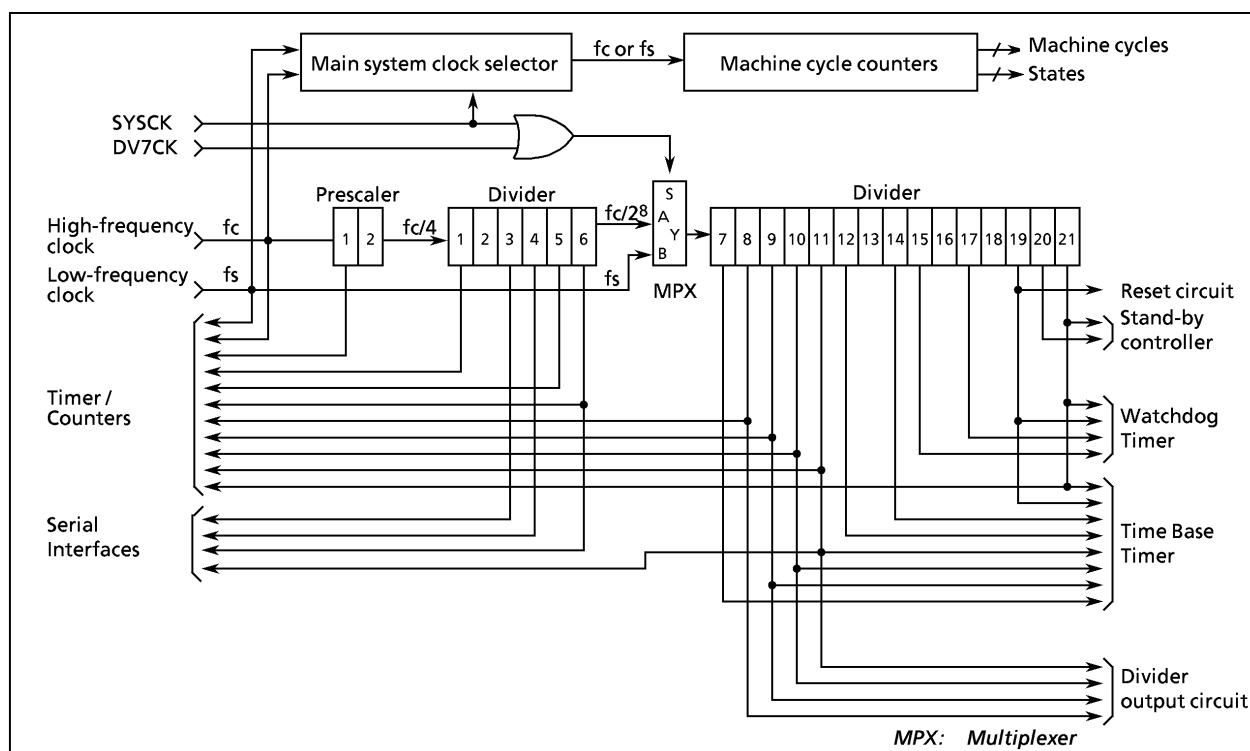


Figure 1-11. Configuration of Timing Generator

TBTCR (0036 _H)	7	6	5	4	3	2	1	0	(Initial value: 0*0 0**)	
	(DVOEN)	(DVOCK)	DV7CK	(TBTEN)			(TBTCK)			
	DV7CK	Selection of input clock to the 7th stage of the divider				0 : $f_c/2^8$ [Hz] 1 : f_s			R/W	

Note 1: f_c : High-frequency clock [Hz], f_s : Low-frequency clock [Hz], * : Don't care
 Note 2: Do not set DV7CK to "1" in the single-clock mode.
 Note 3: Do not set DV7CK to "1" before low-frequency clock is stable in the dual-clock mode.

Figure 1-12. Timing Generator Control Register

(2) Machine Cycle

Instruction execution and peripheral hardware operation are synchronized with the main system clock. The minimum instruction execution unit is called an "machine cycle". There are a total of 10 different types of instructions for the TLC8-870 Series: ranging from 1-cycle instructions which require one machine cycle for execution to 10-cycle instructions which require 10 machine cycles for execution.

A machine cycle consists of 4 states (S0 - S3), and each state consists of one main system clock.

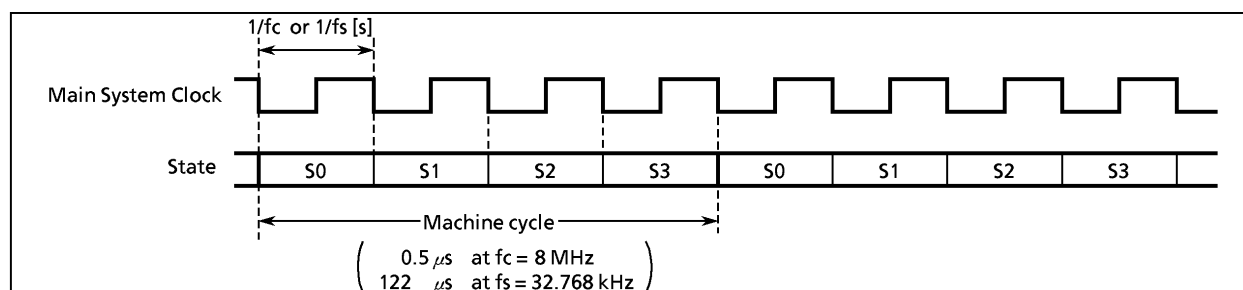


Figure 1-13. Machine Cycle

1.8.3 Stand-by Controller

The stand-by controller starts and stops the oscillation circuits for the high-frequency and low-frequency clocks, and switches the main system clock. There are two operating modes: single-clock and dual-clock. These modes are controlled by the system control registers (SYSCR1, SYSCR2).

Figure 1-14 shows the operating mode transition diagram and Figure 1-15 shows the system control registers. Either the single-clock or the dual-clock mode can be selected by an option during reset.

TMP87PP24 is only fixed on the single-clock after reset release. When using the dual-clock mode, turn on the oscillation circuits for low-frequency clocks at the beginning of program.

(1) Single-clock mode

Only the oscillation circuit for the high-frequency clock is used, and P21 (XTIN) and P22 (XTOUT) pins are used as input/output ports. As main system clock is mode from high frequency clock, in the single-clock mode, the machine cycle time is $4/f_c$ [s] ($0.5 \mu s$ at $f_c = 8 \text{ MHz}$).

① NORMAL1 mode

In this mode, both the CPU core and on-chip peripherals operate using the high-frequency clock. In the case where the single-clock mode has been selected as an option, the TMP87CM24A/P24A are placed in this mode after reset.

② IDLE1 mode

In this mode, the internal oscillation circuit remains active, and the CPU and the watchdog timer are halted; however, on-chip peripherals remain active (operate using the high-frequency clock). IDLE1 mode is started by setting IDLE bit in the system control register 2 (SYSCR2), and IDLE1 mode is released to NORMAL1 mode by an interrupt request from on-chip peripherals or external interrupt inputs. When IMF (interrupt master enable flag) is "1" (interrupt enable), the execution will resume upon acceptance of the interrupt, and the operation will return to normal after the interrupt service is completed. When IMF is "0" (interrupt disable), the execution will resume with the instruction which follows IDLE mode start instruction.

③ STOP1 mode

In this mode, the internal oscillation circuit is turned off, causing all system operations to be halted. The internal status immediately prior to the halt is held with the lowest power consumption during this mode. The output status of all output ports can be set to either output hold or high-impedance under software control.

STOP1 mode is started by setting STOP bit in the system control register 1 (SYSCR1), and STOP1 mode is released by an input (either level-sensitive or edge-sensitive can be programmably selected) to the $\overline{\text{STOP}}$ pin. After the warming-up period is completed, the execution resumes with the next instruction which follows the STOP mode start instruction.

(2) Dual-clock mode

Both high-frequency and low-frequency oscillation circuits are used in this mode. Pins P21 (XTIN) and P22 (XTOUT) cannot be used as input/output ports. The main system clock is obtained from the high-frequency clock in NORMAL2 and IDLE2 modes, and is obtained from the low-frequency clock in SLOW and SLEEP modes. The machine cycle time is $4/f_c$ [s] ($0.5 \mu\text{s}$ at $f_c = 8 \text{ MHz}$) in NORMAL2 and IDLE2 modes, and $4/f_s$ [s] ($122 \mu\text{s}$ at $f_s = 32.768 \text{ kHz}$) in SLOW and SLEEP modes. *Note that the TMP87PP24 is placed in the single-clock mode during reset.* To use the dual-clock mode, the low-frequency oscillator should be turned on by executing [SET (SYSCR2).XTEN] instruction.

① NORMAL2 mode

In this mode, the CPU core operates using the high-frequency clock. On-chip peripherals operate using the high-frequency clock and/or low-frequency clock. In case that the dual-clock mode has been selected by an option, the TMP87CM24A/P24A are placed in this mode after reset.

② SLOW mode

This mode can be used to reduce power-consumption by turning off oscillation of the high-frequency clock. The CPU core and on-chip peripherals operate using the low-frequency clock.

Switching back and forth between NORMAL2 and SLOW modes is performed by the system control register 2.

③ IDLE2 mode

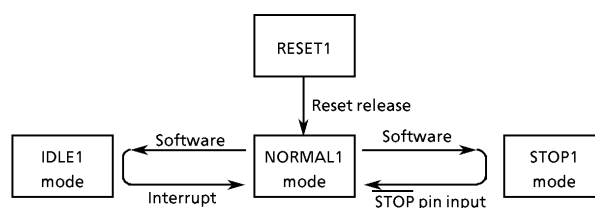
In this mode, the internal oscillation circuits remain active. The CPU and the watchdog timer are halted; however, on-chip peripherals remain active (operate using the high-frequency clock and/or the low-frequency clock). Starting and releasing of IDLE2 mode are the same as for IDLE1 mode, except that operation returns to NORMAL2 mode.

④ SLEEP mode

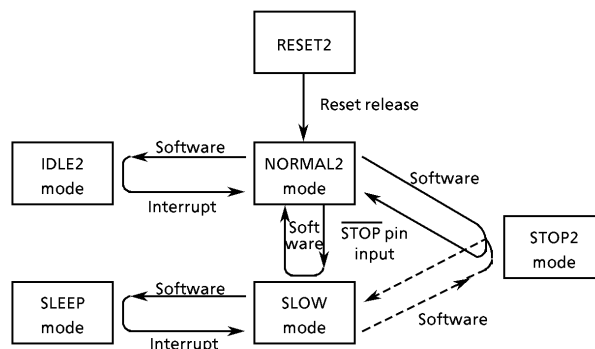
In this mode, the internal oscillation circuit of the low-frequency clock remains active. The CPU, the watchdog timer, and the internal oscillation circuit of the high-frequency clock are halted; however, on-chip peripherals remain active (operate using the low-frequency clock). Starting and releasing of SLEEP mode is the same as for IDLE1 mode, except that operation returns to SLOW mode.

⑤ STOP2 mode

As in STOP1 mode, all system operations are halted in this mode.



(a) Single-clock mode



(b) Dual-clock mode

Note 1 : *NORMAL1 and NORMAL2 modes are generically called NORMAL; STOP1 and STOP2 are called STOP; and IDLE1, IDLE2 and SLEEP are called IDLE.*

Note 2 : *The TMP87PP24 doesn't have RESET2 mode.*

Operating mode		Frequency		CPU core	On-chip Peripherals	Machine cycle time
		High-frequency	Low-frequency			
Single-Clock	RESET1	Turning on oscillation	Turning off oscillation	Reset	Reset	4/fc [s]
	NORMAL1			Operate	Operate	
	IDLE1			Halt		Halt
	STOP1	Turning off oscillation				
Dual-Clock	RESET2	Turning on oscillation	Turning on oscillation	Reset	Reset	4/fc [s]
	NORMAL2			High-frequency	Operate (High and/or Low)	
	IDLE2			Halt		
	SLOW	Turning off oscillation	Turning off oscillation	Low-frequency	Low-frequency	4/fs [s]
	SLEEP			Halt	Halt	—
	STOP2					

Figure 1-14. Operating Mode Transition Diagram

System Control Register 1

SYSCR1 (0038 _H)	7	6	5	4	3	2	1	0	
	STOP	RELM	RETM	OUTEN	WUT				

(Initial value: 0000 00**)

STOP	STOP mode start	0 : CPU core and peripherals remain active 1 : CPU core and peripherals are halted (start STOP mode)	R/W
RELM	Release method for STOP mode	0 : Edge-sensitive release 1 : Level-sensitive release	
RETM	Operating mode after STOP mode	0 : Return to NORMAL mode 1 : Return to SLOW mode	
OUTEN	Port output control during STOP mode	0 : High-impedance 1 : Remain unchanged	
WUT	Warming-up time at releasing STOP mode	00 : $3 \times 2^{19}/f_c$ or $3 \times 2^{13}/f_s$ [s] 01 : $2^{19}/f_c$ or $2^{13}/f_s$ 1* : Reserved	

Note 1: Always set RETM to "0" when transiting from NORMAL1 mode to STOP1 mode and from NORMAL2 mode to STOP2 mode. Always set RETM to "1" when transiting from SLOW mode to STOP2 mode.

Note 2: When STOP mode is released with RESET pin input, a return is made to NORMAL mode regardless of the RETM contents.

Note 3: f_c : High-frequency clock [Hz]

f_s : Low-frequency clock [Hz]

*: Don't care

Note 4: Bits 1 and 0 in SYSCR1 are read in as undefined data when a read instruction is executed.

Note 5: When the STOP mode is started by specifying OUTEN = "0", the internal input of port is fixed to "0" and the interrupt of the falling edge may be set.

System Control Register 2

SYSCR2 (0039 _H)	7	6	5	4	3	2	1	0	
	XEN	XTEN	SYSCK	IDLE					

(Initial value: 10/100 ****)

XEN	High-frequency oscillator control	0 : Turn off oscillation 1 : Turn on oscillation	R/W
XTEN	Low-frequency oscillator control	0 : Turn off oscillation 1 : Turn on oscillation	
SYSCK	Main system clock select (write)/main system clock monitor (read)	0 : High-frequency clock 1 : Low-frequency clock	
IDLE	IDLE mode start	0 : CPU and watchdog timer remain active 1 : CPU and watchdog timer are stopped (start IDLE mode)	

Note 1: A reset is applied (RESET pin output goes low) if both XEN and XTEN are cleared to "0".

Note 2: Do not clear XEN to "0" when SYSCK = 0, and do not clear XTEN to "0" when SYSCK = 1.

Note 3: WDT: watchdog timer, *: Don't care

Note 4: Bits 3 to 0 in SYSCR2 are always read in as "1" when a read instruction is executed.

Note 5: An optional initial value can be selected for XTEN. Always specify when ordering ES (engineering sample).

XTEN	operating mode after reset
0	Single-clock mode (NORMAL1)
1	Dual-clock mode (NORMAL2)

Note 6: The instruction for specifying Masking Option (Operating Mode) in ES Order Sheet is described in ADDITIONAL INFORMATION "Notice for Masking Option of TLC8-870 series" section 8.

Figure 1-15. System Control Registers

1.8.4 Operating Mode Control

(1) STOP mode (STOP1, STOP2)

STOP mode is controlled by the system control register 1 (SYSCR1) and the $\overline{\text{STOP}}$ pin input. The $\overline{\text{STOP}}$ pin is also used both as a port P20 and an $\overline{\text{INT5}}$ (external interrupt input 5) pin. STOP mode is started by setting STOP (bit 7 in SYSCR1) to "1". During STOP mode, the following status is maintained.

- ① Oscillations are turned off, and all internal operations are halted.
- ② The data memory, registers (except for DBR) and port output latches are all held in the status in effect before STOP mode was entered. The port output can be select either output hold or high-impedance by setting OUTEN (bit 4 in SYSCR1).
- ③ The divider of the timing generator is cleared to "0".
- ④ The program counter holds the address of the instruction following the instruction which started the STOP mode.

STOP mode includes a level-sensitive release mode and an edge-sensitive release mode, either of which can be selected with RELM (bit 6 in SYSCR1).

a. Level-sensitive release mode (RELM = 1)

In this mode, STOP mode is released by setting the $\overline{\text{STOP}}$ pin high. This mode is used for capacitor back-up when the main power supply is cut off and long term battery back-up.

When the $\overline{\text{STOP}}$ pin input is high, executing an instruction which starts the STOP mode will not place in STOP mode but instead will immediately start the release sequence (warm-up). Thus, to start STOP mode in the level-sensitive release mode, it is necessary for the program to first confirm that the $\overline{\text{STOP}}$ pin input is low. The following method can be used for confirmation:

- Using an external interrupt input $\overline{\text{INT5}}$ ($\overline{\text{INT5}}$ is a falling edge-sensitive input).

Example : Starting STOP mode with an INT5 interrupt.

```

PINT5 :   TEST    (P2) . 0           ; To reject noise, the STOP mode does not start if
        JRS      F, SINT5           port P20 is at high
        LD       (SYSCR1), 01000000B ; Sets up the level-sensitive release mode.
        SET      (SYSCR1) . 7       ; Starts STOP mode
        LDW      (IL), 111001110101011B ; IL12, 11, 7, 5, 3 ← 0
SINT5 :   RETI
  
```

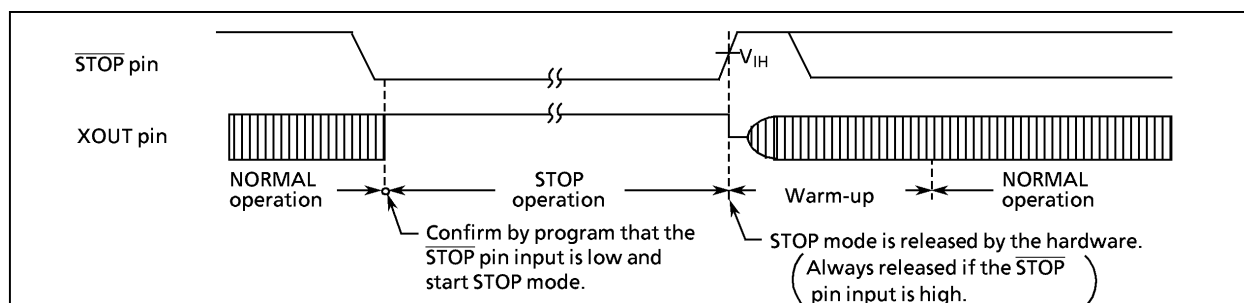


Figure 1-16. Level-sensitive Release Mode

Note 1: After warm-up start, even if $\overline{\text{STOP}}$ pin input is low again, STOP mode does not restart.

Note 2: When changing to the level-sensitive release mode from the edge-sensitive release mode, the release mode is not switched until a rising edge of the $\overline{\text{STOP}}$ pin input is detected.

b. Edge-sensitive release mode (RELM = 0)

In this mode, STOP mode is released by a rising edge of the $\overline{\text{STOP}}$ pin input. This is used in applications where a relatively short program is executed repeatedly at periodic intervals. This periodic signal (for example, a clock from a low-power consumption oscillator) is input to the $\overline{\text{STOP}}$ pin.

In the edge-sensitive release mode, STOP mode is started even when the $\overline{\text{STOP}}$ pin input is high.

Example : Starting STOP mode operation in the edge-sensitive release mode

```
LD      (SYSCR1), 10000000B ; OUTEN ← 0 (specifies high-impedance)
DI      ; IMF ← 0 (disables interrupt service)
SET     (SYSCR1).STOP      ; STOP ← 1 (activates stop mode)
LDW     (IL), 1110011101010111B ; IL12, 11, 7, 5, 3 ← 0
                                   (clears interrupt latches)
EI      ; IMF ← 1 (enables interrupt service)
```

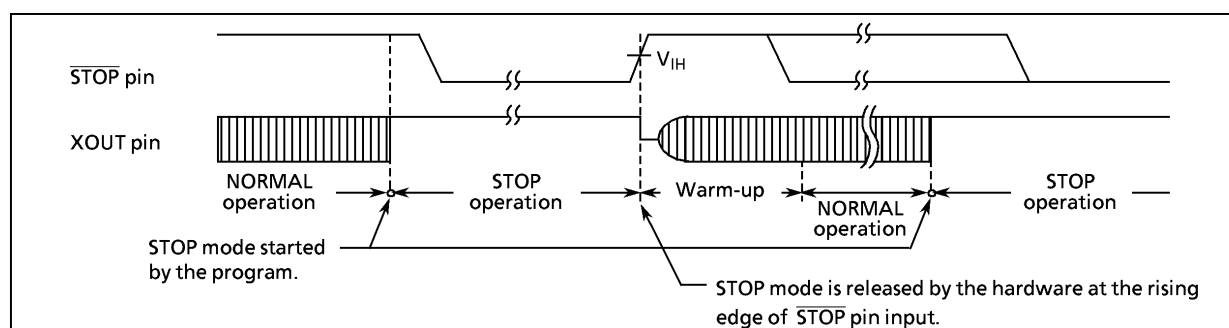


Figure 1-17. Edge-sensitive Release Mode

STOP mode is released by the following sequence:

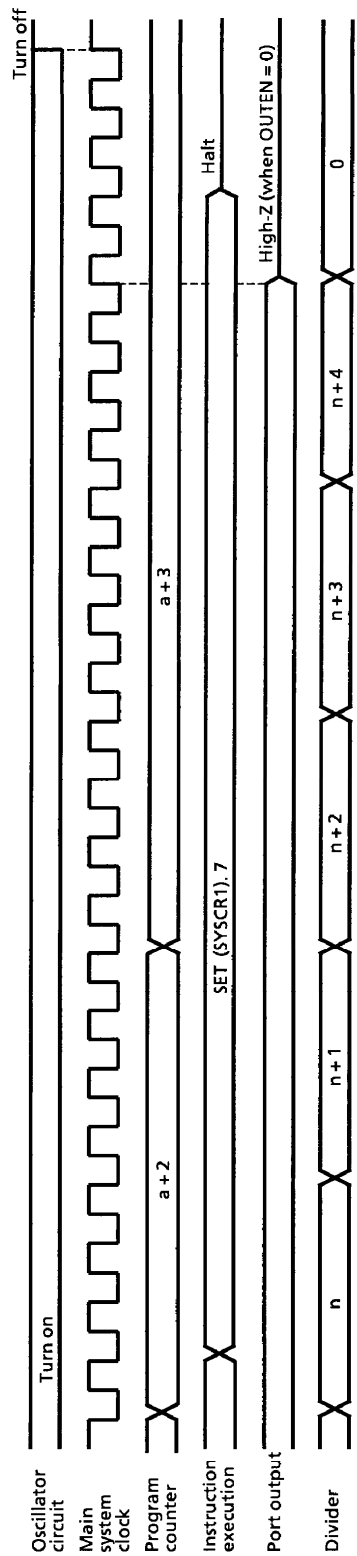
- ① When returning to NORMAL2, both the high-frequency and low-frequency clock oscillators are turned on ; when returning to SLOW mode, only the low-frequency clock oscillator is turned on. When returning to NORMAL 1, only the high-frequency clock oscillator is turned on.
- ② A warming-up period is inserted to allow oscillation time to stabilize. During warm-up, all internal operations remain halted. Two different warming-up times can be selected with WUT (bits 2 and 3 in SYSCR1) as determined by the resonator characteristics.
- ③ When the warming-up time has elapsed, normal operation resumes with the instruction following the STOP mode start instruction (e.g. [SET (SYSCR1). 7]). The start is made after the divider of the timing generator is cleared to "0".

Table 1-1. Warming-up Time example

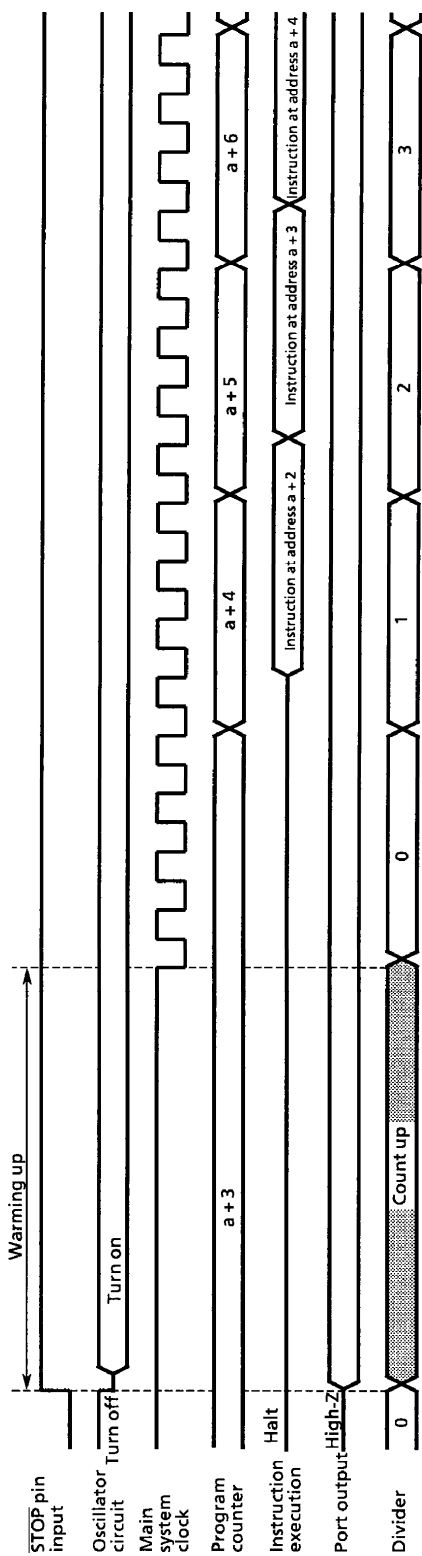
Return to NORMAL1 mode			Return to SLOW mode	
WUT	At $f_c = 4.194304$ MHz	At $f_c = 8$ MHz	WUT	At $f_s = 32.768$ kHz
$3 \times 2^{19}/f_c$ [s]	375 [ms]	196.6 [ms]	$3 \times 2^{13}/f_s$ [s]	750 [ms]
$2^{19}/f_c$	125	65.5	$2^{13}/f_s$	250

Note: The warming-up time is obtained by dividing the basic clock by the divider: therefore, the warming-up time may include a certain amount of error if there is any fluctuation of the oscillation frequency when STOP mode is released. Thus, the warming-up time must be considered an approximate value.

STOP mode can also be released by setting the $\overline{\text{RESET}}$ pin low, which immediately performs the normal reset operation. In this case, even if the setting is to return to the SLOW mode, it starts from the NORMAL mode. (If the initial XTEN of TMP87CM24A/P24A are set to "1" by mask option, they start from the NORMAL2 mode. In case of TMP87PP24, starts from NORMAL1 mode.



(a) STOP Mode Start (Example : Start with SET (SYSCR1). 7 instruction located at address a)



(b) STOP Mode Release

Figure 1-18. STOP Mode Start / Release

Note: When STOP mode is released with a low hold voltage, the following cautions must be observed. The power supply voltage must be at the operating voltage level before releasing STOP mode. The RESET pin input must also be high, rising together with the power supply voltage. In this case, if an external time constant circuit has been connected, the RESET pin input voltage will increase at a slower rate than the power supply voltage. At this time, there is a danger that a reset may occur if input voltage level of the RESET pin drops below the non-inverting high-level input voltage (hysteresis input).

(2) IDLE mode (IDLE1, IDLE2, SLEEP)

IDLE mode is controlled by the system control register 2 and maskable interrupts. The following status is maintained during IDLE mode.

- ① Operation of the CPU and watchdog timer is halted. On-chip peripherals continue to operate.
- ② The data memory, CPU registers and port output latches are all held in the status in effect before IDLE mode was entered.
- ③ The program counter holds the address of the instruction following the instruction which started IDLE mode.

Example : Starting IDLE mode.

```
SET      (SYSCR2).4      ; IDLE←1
```

IDLE mode includes a normal release mode and an interrupt release mode. Selection is made with the interrupt master enable flag (IMF). Releasing the IDLE mode returns from IDLE1 to NORMAL1, from IDLE2 to NORMAL2, and from SLEEP to SLOW mode.

a. Normal release mode (IMF = "0")

IDLE mode is released by any interrupt source enabled by the individual interrupt enable flag (EF) or an external interrupt 0 (INT0 pin) request. Execution resumes with the instruction following the IDLE mode start instruction (e.g. [SET (SYSCR2).4]).

The interrupt latch (IL) of the interrupt source for releasing the IDLE mode must be cleared to "0" by load instruction.

b. Interrupt release mode (IMF = "1")

IDLE mode is released and interrupt processing is started by any interrupt source enabled with the individual interrupt enable flag (EF) or an external interrupt 0 (INT0 pin) request. After the interrupt is processed, the execution resumes from the instruction following the instruction which started IDLE mode.

IDLE mode can also be released by setting the RESET pin low, which immediately performs the reset operation. After reset, the TMP87CM24A/P24A are placed in NORMAL2 mode (the TMP87PP24 is placed in NORMAL1 mode).

Note: When a watchdog timer interrupt is generated immediately before the IDLE mode is started, the watchdog timer interrupt will be processed but IDLE mode will not be started.

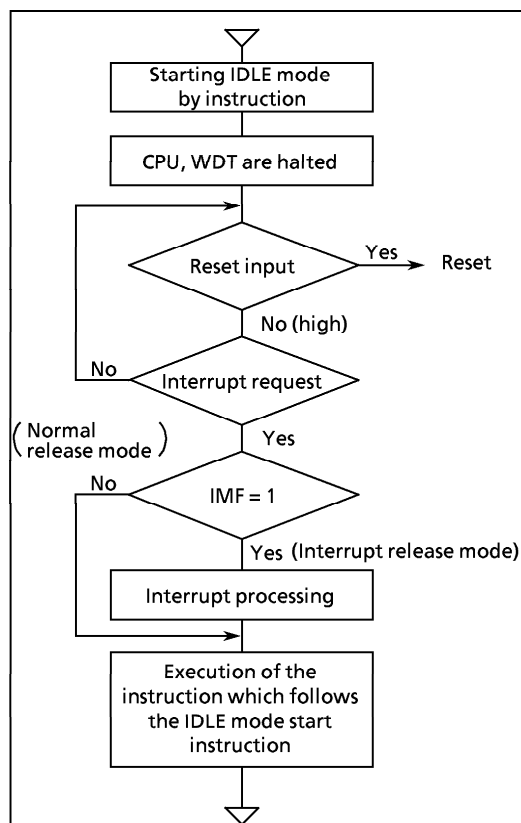
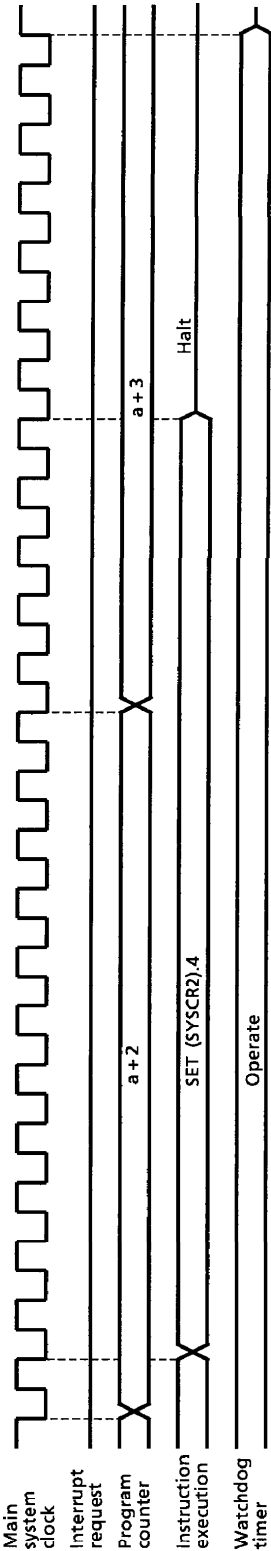
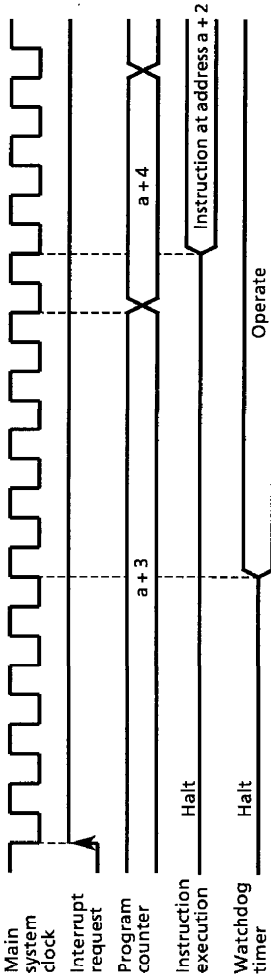


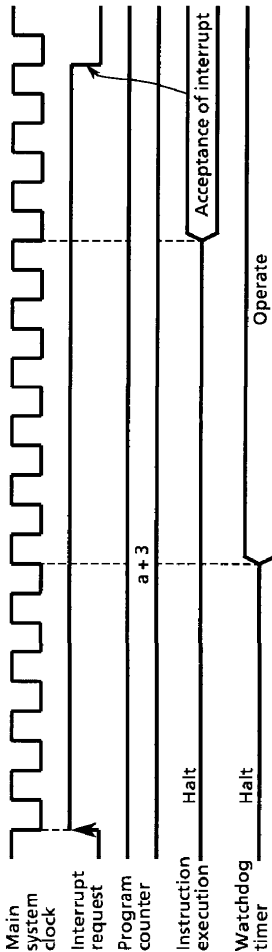
Figure 1-19. IDLE Mode



(a) IDLE Mode Start (Example: starting with the SET instruction located at address a)



① Normal Release Mode



② Interrupt Release Mode

(b) IDLE Mode Release

Figure 1-20. IDLE Mode Start/Release

(3) **SLOW** mode

SLOW mode is controlled by the system control register 2 (SYSCR2) and the timer/counter 2 (TC2).

a. Switching from NORMAL2 mode to SLOW mode

First, set SYSCK (bit 5 in SYSCR2) to switch the main system clock to the low-frequency clock. Next, clear XEN (bit 7 in SYSCR2) to turn off high-frequency oscillation.

When the low-frequency clock oscillation is unstable, wait until oscillation stabilizes before performing the above operations. The timer/counter 2 (TC2) can conveniently be used to confirm that low-frequency clock oscillation has stabilized.

Note: *The high frequency clock can be continued oscillation in order to return to NORMAL2 mode from SLOW mode quickly. Always turn off oscillation of high frequency clock when switching from SLOW mode to STOP mode.*

Example1 : Switching from NORMAL2 mode to SLOW mode.

```

SET      (SYSCR2).5      ; SYSCK←1 (Switches the main system clock to the
                             low-frequency clock)
CLR      (SYSCR2).7      ; XEN←0  (turns off high-frequency oscillation)

```

Example2 : Switching to SLOW mode after low-frequency clock oscillation has stabilized.

```

LD      (TC2CR), 14H      ; Sets TC2 mode
                             (timer mode, source clock : fs)
LDW     (TREG2), 8000H    ; Sets warming-up time
                             (according to Xtal characteristics)
SET     (EIRH).EF14      ; Enable INTTC2
LD      (TC2CR), 34H      ; Starts TC2
:
PINTTC2 : LD      (TC2CR), 10H ; Stops TC2
          SET     (SYSCR2).5    ; SYSCK←1
          CLR     (SYSCR2).7    ; XEN←0
          RETI
          :
VINTTC2 : DW      PINTTC2      ; INTTC2 vector table

```

b. Switching from SLOW mode to NORMAL2 mode

First, set XEN (bit 7 in SYSCR2) to turn on the high-frequency oscillation. When time for stabilization (warm-up) has been taken by the timer/counter 2 (TC2), clear SYSCK (bit 5 in SYSCR2) to switch the main system clock to the high-frequency clock.

SLOW mode can also be released by setting the RESET pin low, which immediately performs the reset operation. After reset, the TMP87CM24A/P24A are placed in NORMAL mode.

Example : Switching from SLOW mode to NORMAL2 mode ($f_c = 8$ MHz, warming-up time is about 7.9 ms).

```

                SET      (SYSCR2) . 7      ; XEN←1      (turns on high-frequency oscillation)
                LD        (TC2CR), 10H      ; Sets TC2 mode
                                           (timer mode, source clock:  $f_c$ )
                LD        (TREG2 + 1), 0F8H ; Sets the warming-up time
                                           (according to frequency and resonator characteristics)
                SET      (EIRH). EF14      ; Enable INTTC2
                LD        (TC2CR), 30H      ; Starts TC2
                ⋮
PINTTC2 :      LD        (TC2CR), 10H      ; Stops TC2
                CLR      (SYSCR2) . 5      ; SYSCK←0    (Switches the main system clock to the
                                           high-frequency clock)
                RETI
                ⋮
VINTTC2 :      DW        PINTTC2          ; INTTC2 vector table

```

Note 1: After the SYSCK is cleared to "0", the CPU core operate using low frequency clock when the main system clock is switching from low frequency clock to high frequency clock.

Note 2: SLOW mode can also be released by setting the RESET pin low, which immediately performs the reset operation. After reset, the TMP87CM24A/P24A are placed in NORMAL2 mode. (The TMP87PP24A is placed in NORMAL1 mode)

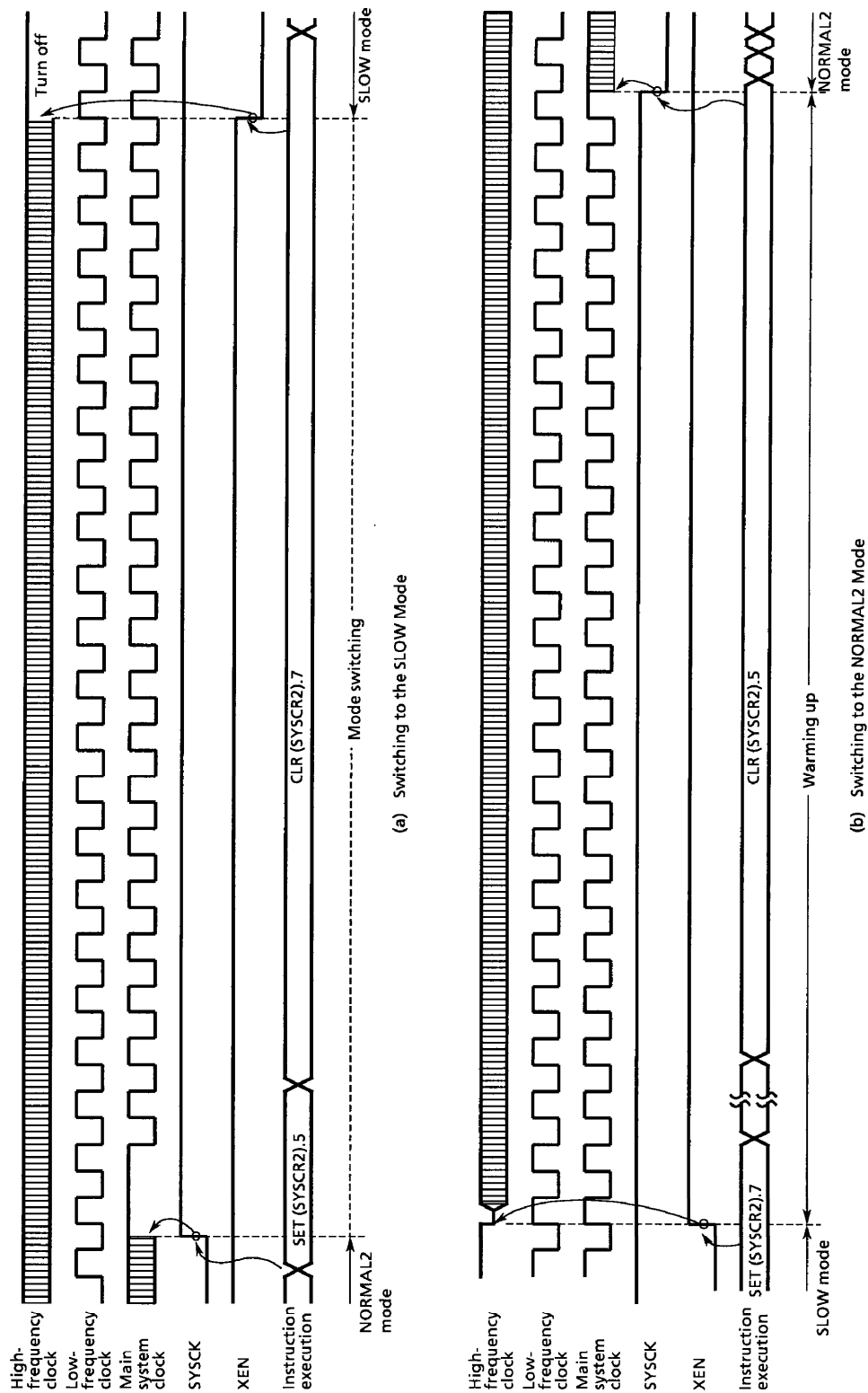


Figure 1-21. Switching between the NORMAL2 and SLOW Modes

1.9 Interrupt Controller

The TMP87CM24A/P24A each have a total of 14 interrupt sources: 5 externals and 9 internals. Nested interrupt control with priorities is also possible. Two of the internal sources are pseudo non-maskable interrupts; the remainder are all maskable interrupts.

Interrupt latches (IL) that hold the interrupt requests are provided for interrupt sources. Each interrupt vector is independent.

The interrupt latch is set to "1" when an interrupt request is generated and requests the CPU to accept the interrupt. The acceptance of maskable interrupts can be selectively enabled and disabled by the program using the interrupt master enable flag (IMF) and the individual interrupt enable flags (EF). When two or more interrupts are generated simultaneously, the interrupt is accepted in the highest priority order as determined by the hardware. Figure 1-22 shows the interrupt controller.

Table 1-2. Interrupt Sources

Interrupt Source		Enable Condition	Interrupt Latch	Vector Table Address	Priority
Internal/ External	(Reset)	Non-Maskable	—	FFFE _H	High 0
Internal	INTSW (Software interrupt)	Pseudo	—	FFFC _H	1
Internal	INTWDT (Watchdog Timer interrupt)	non-maskable	IL ₂	FFFA _H	2
External	INT0 (External interrupt 0)	IMF = 1, INT0EN = 1	IL ₃	FFF8 _H	3
Internal	INTTC1 (16-bit TC1 interrupt)	IMF · EF ₄ = 1	IL ₄	FFF6 _H	4
External	INT1 (External interrupt 2)	IMF · EF ₅ = 1	IL ₅	FFF4 _H	5
Internal	INTTBT (Time Base Timer interrupt)	IMF · EF ₆ = 1	IL ₆	FFF2 _H	6
External	INT2 (External interrupt 2)	IMF · EF ₇ = 1	IL ₇	FFF0 _H	7
Internal	INTTC3 (8-bit TC3 interrupt)	IMF · EF ₈ = 1	IL ₈	FFEE _H	8
Internal	INTSIO1 (Serial Interface 1 interrupt)	IMF · EF ₉ = 1	IL ₉	FFEC _H	9
Internal	INTTC5 (8-bit TC5 interrupt)	IMF · EF ₁₀ = 1	IL ₁₀	FFEA _H	10
External	INT3 (External interrupt 3)	IMF · EF ₁₁ = 1	IL ₁₁	FFE8 _H	11
	Reserved	IMF · EF ₁₂ = 1	IL ₁₂	FFE6 _H	12
Internal	INTSIO2 (Serial Interface 2 interrupt)	IMF · EF ₁₃ = 1	IL ₁₃	FFE4 _H	13
Internal	INTTC2 (16-bit TC2 interrupt)	IMF · EF ₁₄ = 1	IL ₁₄	FFE2 _H	14
External	INT5 (External interrupt 5)	IMF · EF ₁₅ = 1	IL ₁₅	FFE0 _H	Low 15

(1) Interrupt Latches (IL₁₅ to 2)

Interrupt latches are provided for each source, except for a software interrupt. The latch is set to "1" when an interrupt request is generated, and requests the CPU to accept the interrupt. The latch is cleared to "0" just after the interrupt is accepted. All interrupt latches are initialized to "0" during reset.

The interrupt latches are assigned to addresses 003C_H and 003D_H in the SFR. Each latch can be cleared to "0" individually by an instruction; *however, the read-modify-write instruction such as bit manipulation or operation instructions cannot be used* (Do not clear the IL₂ for a watchdog timer interrupt to "0"). Thus, interrupt requests can be cancelled and initialized by the program. Note that interrupt latches cannot be set to "1" by any instruction.

The contents of interrupt latches can be read out by an instruction. Therefore, testing interrupt requests by software is possible.

Example 1 : Clears interrupt latches

```

DI                      ; IMF←0
LDW      (IL), 1110100000111111B ; IL12, IL10 to IL6←0
EI                      ; IMF←1

```

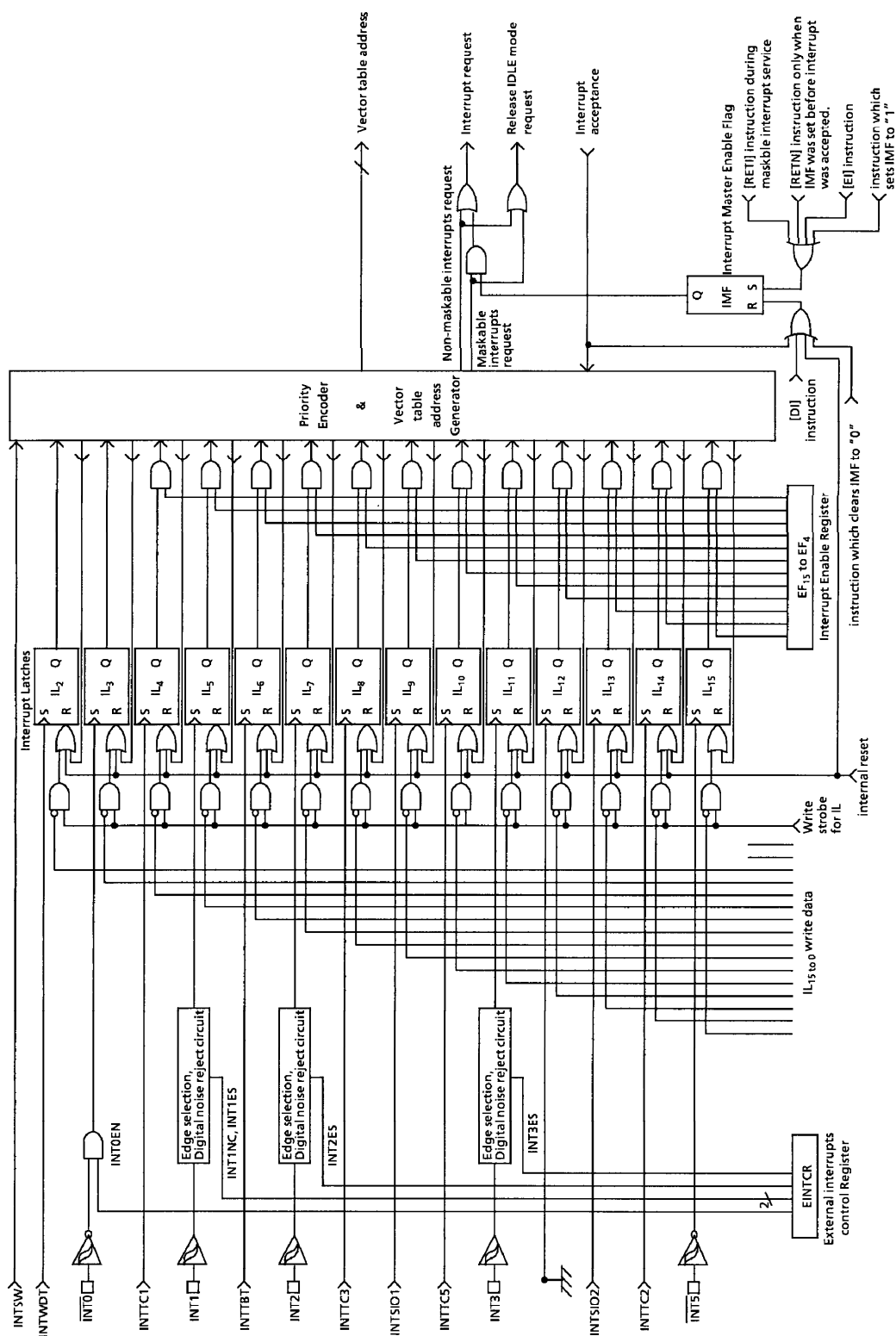


Figure 1-22. Interrupt Controller Block Diagram

Example 2 : Reads interrupt latches

```
LD      WA, (IL)      ; W←ILH, A←ILL
```

Example 3: Tests an interrupt latch

```
TEST    (IL).7        ; if IL7 = 1 then jump
JR      F, SSET
```

(2) Interrupt Enable Register (EIR)

The interrupt enable registers (EIR) enable and disable the acceptance of interrupts except for the pseudo non-maskable interrupts (software and watchdog timer interrupts). Pseudo non-maskable interrupts are accepted regardless of the contents of the EIR; however, the pseudo non-maskable interrupts cannot be nested more than once at the same time.

The EIR consists of an interrupt master enable flag (IMF) and individual interrupt enable flags (EF). These registers are assigned to addresses 003A_H and 003B_H in the SFR, and can be read and written by an instruction (including read-modify-write instructions such as bit manipulation instructions).

① Interrupt Master enable Flag (IMF)

The interrupt master enable flag (IMF) enables and disables the acceptance of all interrupts, except for pseudo non-maskable interrupts. Clearing this flag to "0" disables the acceptance of all maskable interrupts. Setting to "1" enables the acceptance of interrupts. When an interrupt is accepted, this flag is cleared to "0" to temporarily disable the acceptance of maskable interrupts. After execution of the interrupt service program, this flag is set to "1" by the maskable interrupt return instruction [RETI] to again enable the acceptance of interrupts. If an interrupt request has already been occurred, interrupt service starts immediately after execution of the [RETI] instruction.

Pseudo non-maskable interrupts are returned by the [RETN] instruction. In this case, the IMF is set to "1" only when pseudo non-maskable interrupt service is started with interrupt acceptance enabled (IMF = 1). Note that IMF remains "0" when cleared in the interrupt service program.

The IMF is assigned to bit 0 at address 003A_H in the SFR, and can be read and written by an instruction. IMF is normally set and cleared by the [EI] and [DI] instructions, and the IMF is initialized to "0" during reset.

② Individual interrupt Enable Flags (EF₁₅ to EF₄)

These flags enable and disable the acceptance of individual maskable interrupts, except for an external interrupt 0. Setting the corresponding bit of an individual interrupt enable flag to "1" enables acceptance of an interrupt, setting the bit to "0" disables acceptance.

Example 1 : Sets EF for individual interrupt enable, and sets IMF to "1".

```
DI      ; IMF←0
LDW     (EIR), 1110100010100000B ; EF15 to EF13, EF11, EF7, EF5
EI      ; IMF←1
```

Example 2 : Sets an individual interrupt enable flag to "1".

```
DI      ; IMF←0
SET     (EIRH).4      ; EF12←1
EI      ; IMF←1
```

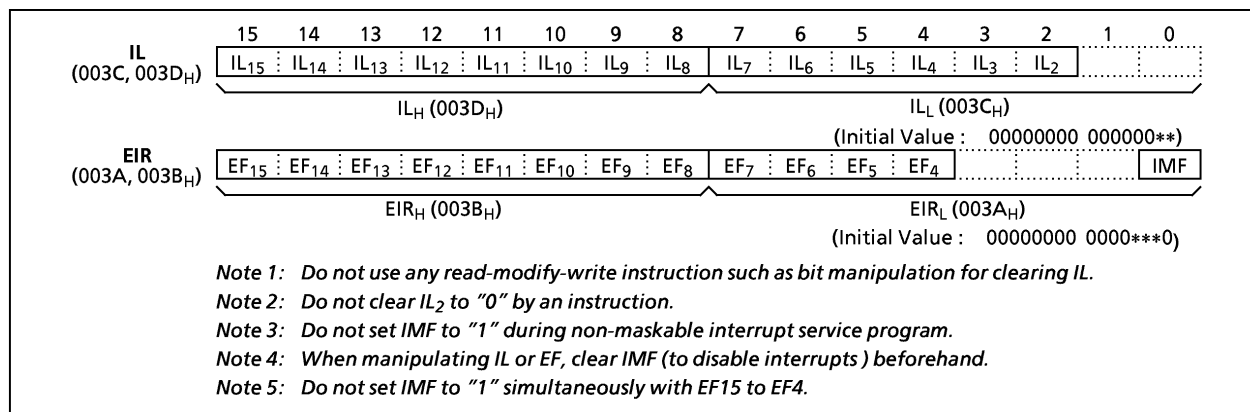



Figure 1-23. Interrupt Latch (IL) and Interrupt Enable Register (EIR)

1.9.1 Interrupt Sequence

An interrupt request is held until the interrupt is accepted or the interrupt latch is cleared to "0" by a reset or an instruction. Interrupt acceptance sequence requires 8 machine cycles (4 μ s at $f_c = 8$ MHz in NORMAL mode) after the completion of the current instruction execution. The interrupt service task terminates upon execution of an interrupt return instruction [RETI] (for maskable interrupts) or [RETN] (for pseudo non-maskable interrupts).

(1) Interrupt acceptance processing

- ① The interrupt master enable flag (IMF) is cleared to "0" to temporarily disable the acceptance of any following maskable interrupts. When a non-maskable interrupt is accepted, the acceptance of any following interrupts is temporarily disabled.
- ② The interrupt latch (IL) for the interrupt source accepted is cleared to "0".
- ③ The contents of the program counter (PC) and the program status word are saved (pushed) onto the stack. (Pushed down in order of PSW, PC_H, PC_L). The contents of stack pointer (SP) is decreased by 3.
- ④ The entry address of the interrupt service program is read from the vector table address corresponding to the interrupt source, and the entry address is loaded to the program counter.
- ⑤ The instruction stored at the entry address of the interrupt service program is executed.

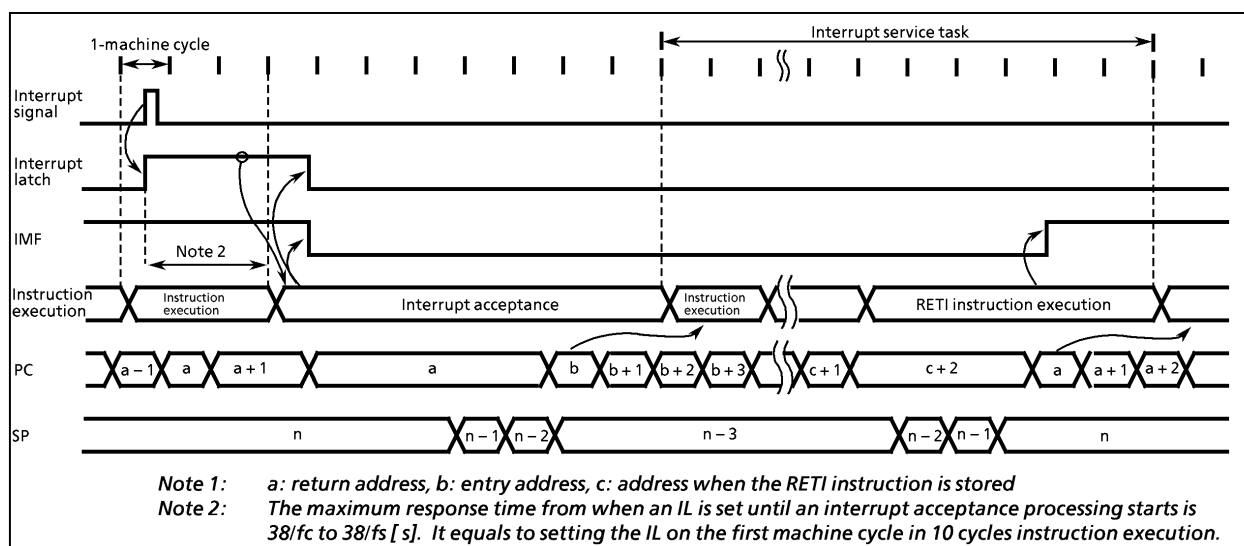
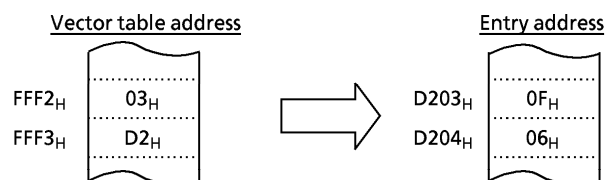


Figure 1-24. Timing Chart of Interrupt Acceptance and Interrupt Return Instruction

Example : Correspondence between vector table address for INTTB_T and the entry address of the interrupt service program.



A maskable interrupt is not accepted until the IMF is set to "1" even if a maskable interrupt of higher priority than that of the current interrupt being serviced.

When nested interrupt service is necessary, the IMF is set to "1" in the interrupt service program. In this case, acceptable interrupt sources are selectively enabled by the individual interrupt enable flags.

However, an acceptance of external interrupt 0 cannot be disabled by the EF; therefore, if disablement is necessary, either the external interrupt function must be disabled with INTOEN in the external interrupt control register (INTOEN) or interrupt processing must be avoided by the program. (When INTOEN = 0, the interrupt latch IL3 is not set, therefore, the falling edge of the INTO pin input cannot be detected.)

Example 1 : Disables an external interrupt 0 using INTOEN:

```
LD      (EINTCR), 00000000B ; INTOEN ← 0
```

Example 2 : Disables the processing of external interrupt 0 under the software control (using bit 0 at address 00F0_H as the interrupt processing disable switch):

```
PINT0 :   TEST      (00F0H) . 0      ; Returns without interrupt processing if (00F0H)0 = 1
          JRS       T, SINT0
          RETI
SINT0 :   [Interrupt processing]
          RETI
          ⋮
VINT0 :   DW        PINT0
```

(2) General-Purpose register save/restore processing

During interrupt acceptance processing, the program counter and the program status word are automatically saved on the stack, but not the accumulator and other registers. These registers are saved by the program if necessary. Also, when nesting multiple interrupt services, it is necessary to avoid using the same data memory area for saving registers.

The following method is used to save/restore the general-purpose registers:

① General-purpose register save/restore by register bank changeover:

General-purpose registers can be saved at high-speed by switching to a register bank that is not in use. Normally, bank 0 is used for the main task and banks 1 to 15 are assigned to interrupt service tasks. To increase the efficiency of data memory utilization, the same bank is assigned for interrupt sources which are not nested.

The switched bank is automatically restored by executing an interrupt return instruction [RETI] or [RETN]. Therefore, it is not necessary for a program to save the RBS.

Example : Register Bank Changeover

```
PINTxx :   LD      RBS, n      ; Switches to bank n (1 μs at 8MHz)
          [Interrupt processing]
          RETI                ; Restores bank and Returns
```

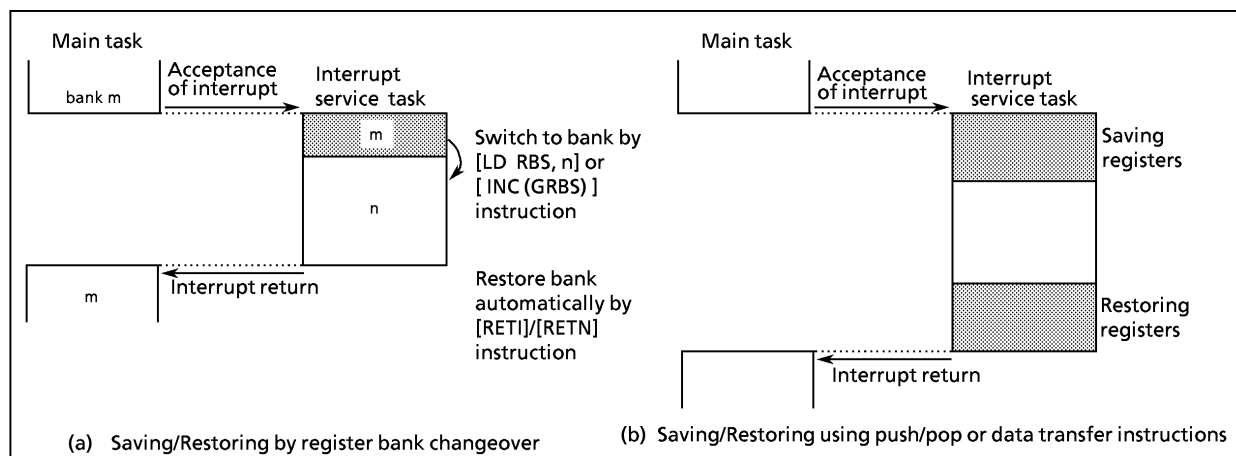
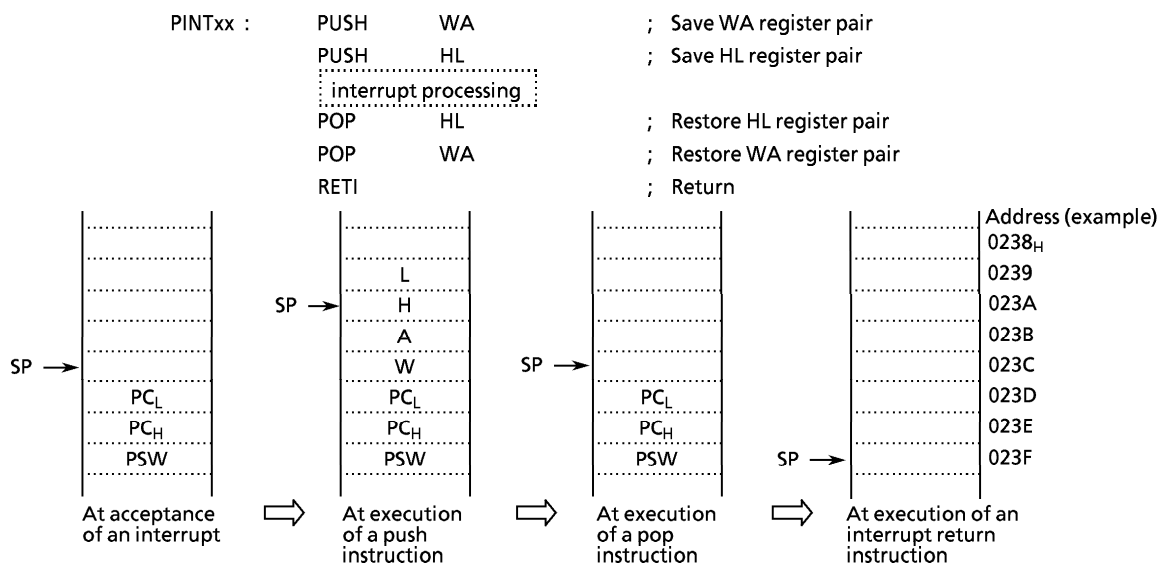


Figure 1-25. Saving/Restoring General-purpose Registers

② General-purpose register save/restore using push and pop instructions:

To save only a specific register, and when the same interrupt source occurs more than once, the general-purpose registers can be saved/restored using push/pop instructions.

Example : Register save using push and pop instructions



③ General-purpose registers save/restore using data transfer instruction:

Data transfer instructions can be used to save only a specific general-purpose register during processing of a single interrupt.

Example : Saving/restoring a register using data transfer instructions

```

PINTxx :   LD      (GSAVA), A    ; Save A register
           [interrupt processing]
           LD      A, (GSAVA)    ; Restore A register
           RETI                ; Return
  
```

The interrupt return instructions [RETI]/[RETN] perform the following operations.

[RETI] Maskable interrupt return	[RETN] Non-maskable interrupt return
① The contents of the program counter and the program status word are restored from the stack.	① The contents of the program counter and program status word are restored from the stack.
② The stack pointer is incremented 3 times.	② The stack pointer is incremented 3 times.
③ The interrupt master enable flag is set to "1".	③ The interrupt master enable flag is set to "1" only when a non-maskable interrupt is accepted in interrupt enable status. However, the interrupt master enable flag remains at "0" when so clear by an interrupt service program.

Interrupt requests are sampled during the final cycle of the instruction being executed. Thus, the next interrupt can be accepted immediately after the interrupt return instruction is executed.

Note: When the interrupt processing time is longer than the interrupt request generation time, the interrupt service task is performed but not the main task.

1.9.2 Software Interrupt (INTSW)

Executing the [SWI] instruction generates a software interrupt and immediately starts interrupt processing (INTSW is highest prioritized interrupt). However, if processing of a non-maskable interrupt is already underway, executing the SWI instruction will not generate a software interrupt but will result in the same operation as the [NOP] instruction. Thus, the [SWI] instruction behaves like the [NOP] instruction.

Note: Software interrupt generates during non-maskable interrupt processing to use SWI instruction for software break in a development tool.

Use the [SWI] instruction only for detection of the address error or for debugging.

① Address Error Detection

FF_H is read if for some cause such as noise the CPU attempts to fetch an instruction from a non-existent memory address. Code FF_H is the SWI instruction, so a software interrupt is generated and an address error is detected. The address error detection range can be further expanded by writing FF_H to unused areas of the program memory. Address trap reset is generated for instruction fetch from a part of RAM area (address 0040_H to 083F_H) or SFR area (0000_H to 003F_H).

Note: The fetch data from addresses 3F80_H to 3FFF_H (test ROM area) for TMP87CM24A/P24A is not "FF_H".

② Debugging

Debugging efficiency can be increased by placing the SWI instruction at the software break point setting address.

1.9.3 External Interrupts

The TMP87CM24A/P24A have five external interrupts (INT0 to INT5 : $\overline{\text{INT0}}$, INT1, INT2, INT3, $\overline{\text{INT5}}$). Three of these (INT1, INT2, INT3) have digital noise cancellation circuits (pulse inputs of less than a fixed time are cancelled as noise). Edge selection is possible with pins INT1, INT2, and INT3.

The $\overline{\text{INT0}}$ /P10 pin can be selected either as an external interrupt input pin or as an I/O port. At reset, it is initialized as an input port.

Edge selection, noise cancellation control, and $\overline{\text{INT0}}$ /P10 pin function selection are performed by the external interrupt control register 1 (EINTCR).

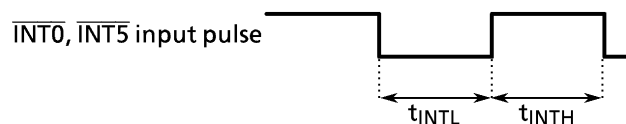
The both-edge detect function of the INT3 pin is selected by the external interrupt control register 1 (EINTCR) and the external interrupt control register 2 (EINT3CR).

Table 1-3 lists enable conditions, edge select, noise cancellation conditions. The following are notes on the usage of external interrupts:

Notes on usage of external interrupts:

Note 1: When $\overline{INT0}$ to $\overline{INT5}$ ($\overline{INT0}$, $\overline{INT1}$, $\overline{INT2}$, $\overline{INT3}$, $\overline{INT5}$) are used in SLOW or SLEEP mode, the noise cancellation function is disabled. Noise cancellation time for a pulse input during operating mode transition is indeterminate.

Note 2: Input pulse width for $\overline{INT0}$ and $\overline{INT5}$ must be one machine cycle or more at both high and low levels.



$$t_{INTL}, t_{INTH} > t_{cyc}$$

$$t_{cyc} = 4/fc [s] \text{ (at NORMAL 1/2 and IDLE 1/2 modes)}$$

$$4/fs [s] \text{ (at SLOW and SLEEP modes)}$$

Note 3: If a signal without noise is input to the external interrupt pin in NORMAL 1/2 or IDLE 1/2 mode, the maximum times from input signal edge to input latch set are as described below:

- ① $\overline{INT1}$ pin $49/fc [s]$ (when $\overline{INT1NC} = 1$)
 $193/fc [s]$ (when $\overline{INT1NC} = 0$)
- ② $\overline{INT2}$ pin $25/fc [s]$
- ③ $\overline{INT3}$ pin $25/fc [s]$ (when #0037H: $\overline{INT3W} = 0$, falling or rising edge)
 $25/fc [s]$ (when #0037H: $\overline{INT3W} = 1$ and #001FH: NCS (0, 0, 0))
 $(26/fc) \times 8.5 + 19/fc [s]$ (when #0037H: $\overline{INT3W} = 1$ and #001FH: NCS (0, 0, 1))
 $(27/fc) \times 8.5 + 19/fc [s]$ (when #0037H: $\overline{INT3W} = 1$ and #001FH: NCS (0, 1, 0))
 $(28/fc) \times 8.5 + 19/fc [s]$ (when #0037H: $\overline{INT3W} = 1$ and #001FH: NCS (0, 1, 1))
 $(29/fc) \times 8.5 + 19/fc [s]$ (when #0037H: $\overline{INT3W} = 1$ and #001FH: NCS (1, 0, 0))
 $(210/fc) \times 8.5 + 19/fc [s]$ (when #0037H: $\overline{INT3W} = 1$ and #001FH: NCS (1, 0, 1))
 $(211/fc) \times 8.5 + 19/fc [s]$ (when #0037H: $\overline{INT3W} = 1$ and #001FH: NCS (1, 1, 0))
 $(212/fc) \times 8.5 + 19/fc [s]$ (when #0037H: $\overline{INT3W} = 1$ and #001FH: NCS (1, 1, 1))

Note 4: Noise cancellation/pulse receive conditions for timer/counter are as described below:

- ① TC1 pin : Less than $7/fc [s]$ (noise cancellation) and $24/fc [s]$ or more (pulse receive)
- ② TC3 pin : When $\overline{INT3W} = 0$, less than $7/fc [s]$ (noise cancellation) and $24/fc [s]$ or more (pulse receive).
 For when $\overline{INT3W} = 1$, see Table 1-3 (b).

Note 5: When $\overline{INT0EN} = 0$, interrupt latch IL3 is not set even if a falling edge is detected for $\overline{INT0}$ pin input.

Note 6: Change EINTCR only when IMF=0. After changing EINTCR, interrupt latches of external interrupt inputs must be cleared to "0" using load instruction.

Example : Changes INT2 edge selection from rising edge to falling edge

```
DI                      ; IMF ← 0 (disables interrupt service)
LD (EINTCR), 10000110B ; INT2ES ← 1 (changes edge selection)
LD (ILL), 01111111B    ; IL7 ← 0 (clears interrupt latch)
EI                      ; IMF ← 1 (enables interrupt service)
```

Note 7: If changing the contents of INT1ES during NORMAL1/2 mode, interrupt latch of external interrupt input INT1 must be cleared after 14 machine cycles (when INT1NC = 1) or 50 machine cycles (when INT1NC = 0) from the time of changing. During SLOW mode, 3 machine cycles are required.

Note 8: In order to change of external interrupt input by rewriting the contents of INT2ES and INT3ES during NORMAL1/2 mode, clear interrupt latches of external interrupt inputs (INT2 and INT3) after 8 machine cycles from the time of rewriting. During SLOW mode, 3 machine cycles are required.

Note 9: In order to change an edge of timer counter input by rewriting the contents of INT2ES and INT3ES during NORMAL1/2 mode, rewrite the contents after timer counter is stopped (TC*s = 0), that is, interrupt disable state. Then, clear interrupt latches of external interrupt inputs (INT2 and INT3) after 8 machine cycles from the time of rewriting to change to interrupt enable state. Finally, start timer counter. During SLOW mode, 3 machine cycles are required.

Example : When changing TC1 pin inputs edge in external trigger timer mode from rising edge to falling edge.

	LD (TC1CR), 01001000B	; TC1S ← 00 (stop TC1)
	DI	; IMF ← 0 (disable interrupt service)
	LD (EINTCR), 00000100B	; INT2ES ← 1 (change edge selection)
↑	NOP	
8-machine	to	
cycles	NOP	
↓	LD (ILL), 01111111B	; IL7 ← 0 (clear interrupt latch)
	EI	; IMF ← 1 (enable interrupt service)
	LD (TC1CR), 01111000B	; TC1S ← 11 (start TC1)

Note 10: When high-impedance is specified for port output in stop mode, port input is forcibly fixed to low level internally. Thus, interrupt latches of external interrupt inputs except INT5 (P20/STOP) which are also used as ports may be set to "1". To specify high-impedance for port output in stop mode, first disable interrupt service (IMF = 0), activate stop mode. After releasing stop mode, clear interrupt latches using load instruction, then, enable interrupt service.

Example : Activating stop mode

```
LD (SYSCR1), 01000000B ; OUTEN ← 0 (specifies high-impedance)
DI                      ; IMF ← 0 (disables interrupt service)
SET (SYSCR1). STOP     ; STOP ← 1 (activates stop mode)
LDW (IL), 11110111010111B ; IL11, 7, 5, 3 ← 0 (clears interrupt latches)
EI                      ; IMF ← 1 (enables interrupt service)
```

Table 1-3. (a) External Interrupts

SOURCE	Pin	Secondary function	Enable Condition	Edge			Digital noise reject
				rising	falling	both	
INT0	INT0	P10	IMF = 1, INT0EN = 1	—	○	—	— (hysteresis input)
INT1	INT1	P11	IMF · EF ₅ = 1	INT1ES = 0	INT1ES = 1	—	Note 1)
INT2	INT2	P12/TC1	IMF · EF ₇ = 1	INT2ES = 0	INT2ES = 1	—	Note 2)
INT3	INT3	P40/TC3	IMF · EF ₁₁ = 1, INT3W = 0	INT3ES = 0	INT3ES = 1	—	Note 3)
			IMF · EF ₁₁ = 1, INT3W = 1	—	—	INT3W = 1 Note5)	Note 4)
INT5	INT5	P20/STOP	IMF · EF ₁₅ = 1	—	○	—	— (hysteresis input)

Note 1: Pulses less than 15/fc [s] or 63/fc [s] are cancelled as noise. Pulses equal to or more than 48/fc [s] or 192/fc [s] are regarded as signals.

Note 2: Pulses less than 7/fc [s] are cancelled as noise. Pulses equal to or more than 24/fc [s] are regarded as signals.

Note 3: For falling or rising edge, pulses less than 7/fc [s] are cancelled as noise. Pulses equal to or more than 24/fc [s] are regarded as signals. Same applies to pin TC3 (at one edge).

Note 4: Noise cancellation conditions are as listed in Table 1-3 (b). They are applied to the INT3 pin when it is used for both-edge interrupts. To detect remote control signals using timer 3 in capture mode, the INT3 pin is used for both-edge interrupts.

Note 5: To detect the edge at which an interrupt is generated, read bit 7 (INTEDT) in EINT3CR (#001F_H), that is, at the beginning of the interrupt processing routine.

INTEDT is valid only for both-edge interrupts (INT3W = 1). INTEDT is set to 1 by an interrupt as the non-selected edge; cleared to 0 after read automatically.

For both-edge interrupts, rising or falling edge is selected by setting/modifying bit 3 (INT3ES) in EINTCR (#0037_H). When rising edge is selected (INT3ES = 0), bit 7 in INTEDT (#001F_H) is set to 1 when a falling edge is detected at the INT3 pin. (That is, remains 0 if rising edge is detected.)

When falling edge is selected (INT3ES = 1), bit 7 in INTEDT: #001F_H is set to 1 when a rising edge is detected at the INT3 pin. (That is, remains 0 at falling edge.)

Table 1-3. (b) Noise reject condition for INT3 (both-edge interrupt)

EINT3CR			max pulse width for noise reject	min pulse width for immediate signal
NCS2	NCS1	NCS0		
0	0	0	– (hysteresis input)	
0	0	1	$(2^6/f_c) \times 7 - 6/f_c$	$(2^6/f_c) \times 8 + 5/f_c$
0	1	0	$(2^7/f_c) \times 7 - 6/f_c$	$(2^7/f_c) \times 8 + 5/f_c$
0	1	1	$(2^8/f_c) \times 7 - 6/f_c$	$(2^8/f_c) \times 8 + 5/f_c$
1	0	0	$(2^9/f_c) \times 7 - 6/f_c$	$(2^9/f_c) \times 8 + 5/f_c$
1	0	1	$(2^{10}/f_c) \times 7 - 6/f_c$	$(2^{10}/f_c) \times 8 + 5/f_c$
1	1	0	$(2^{11}/f_c) \times 7 - 6/f_c$	$(2^{11}/f_c) \times 8 + 5/f_c$
1	1	1	$(2^{12}/f_c) \times 7 - 6/f_c$	$(2^{12}/f_c) \times 8 + 5/f_c$

Note: In SLOW mode, set (NCS) = (0, 0, 0).
In SLOW mode, the digital noise filter in the above table is disabled.

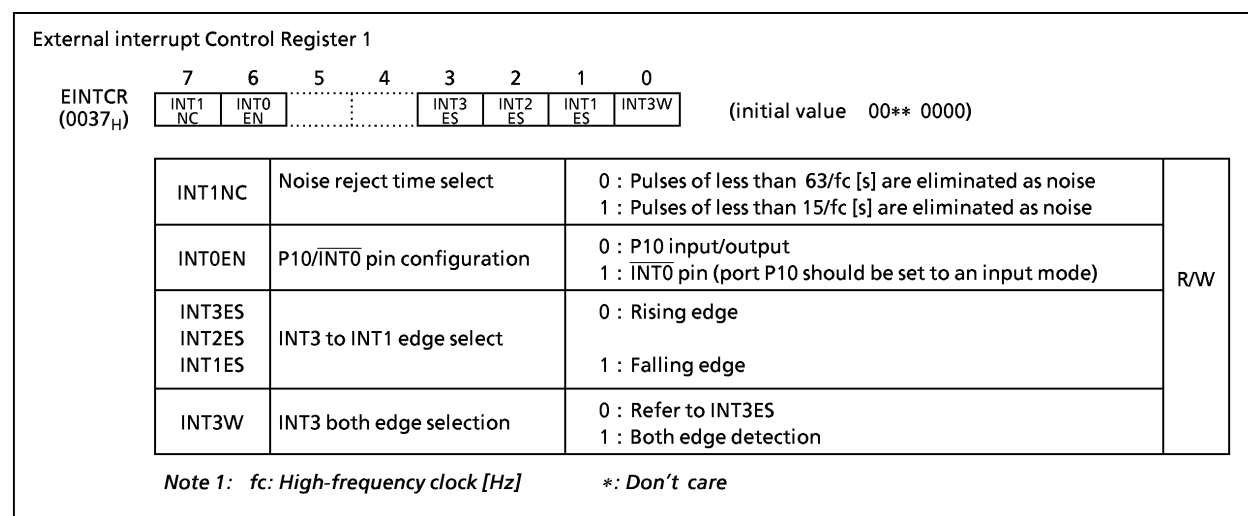


Figure 1-26. (a) External Interrupt Control Register

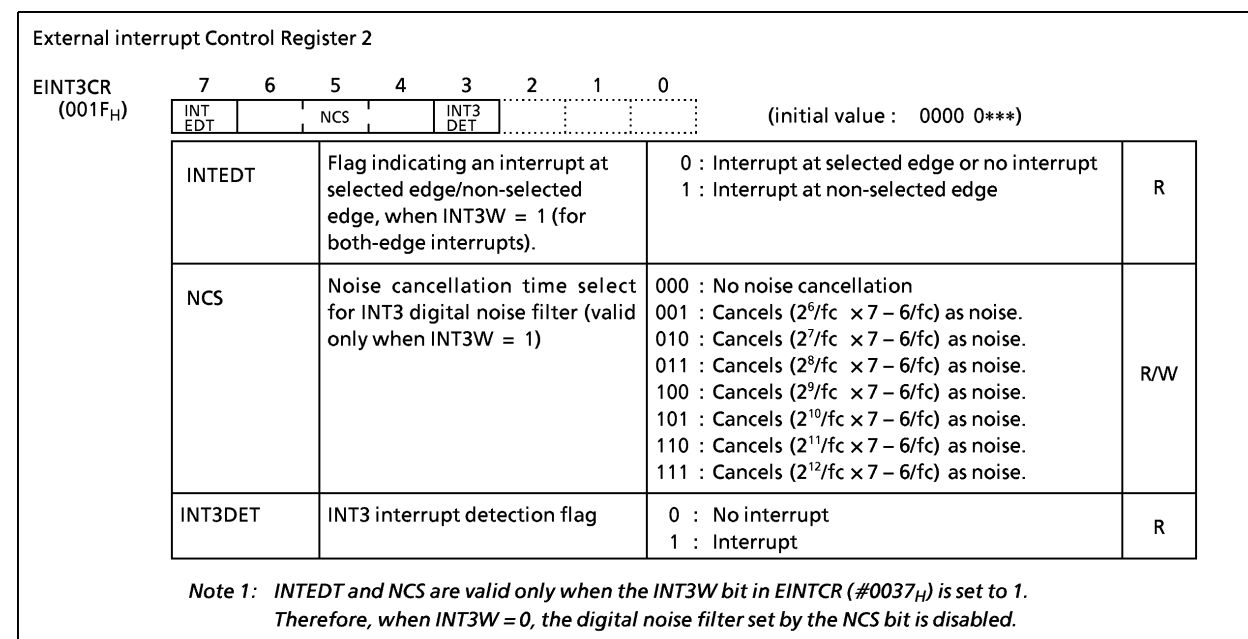


Figure 1-26. (b) External Interrupt Control Register 2

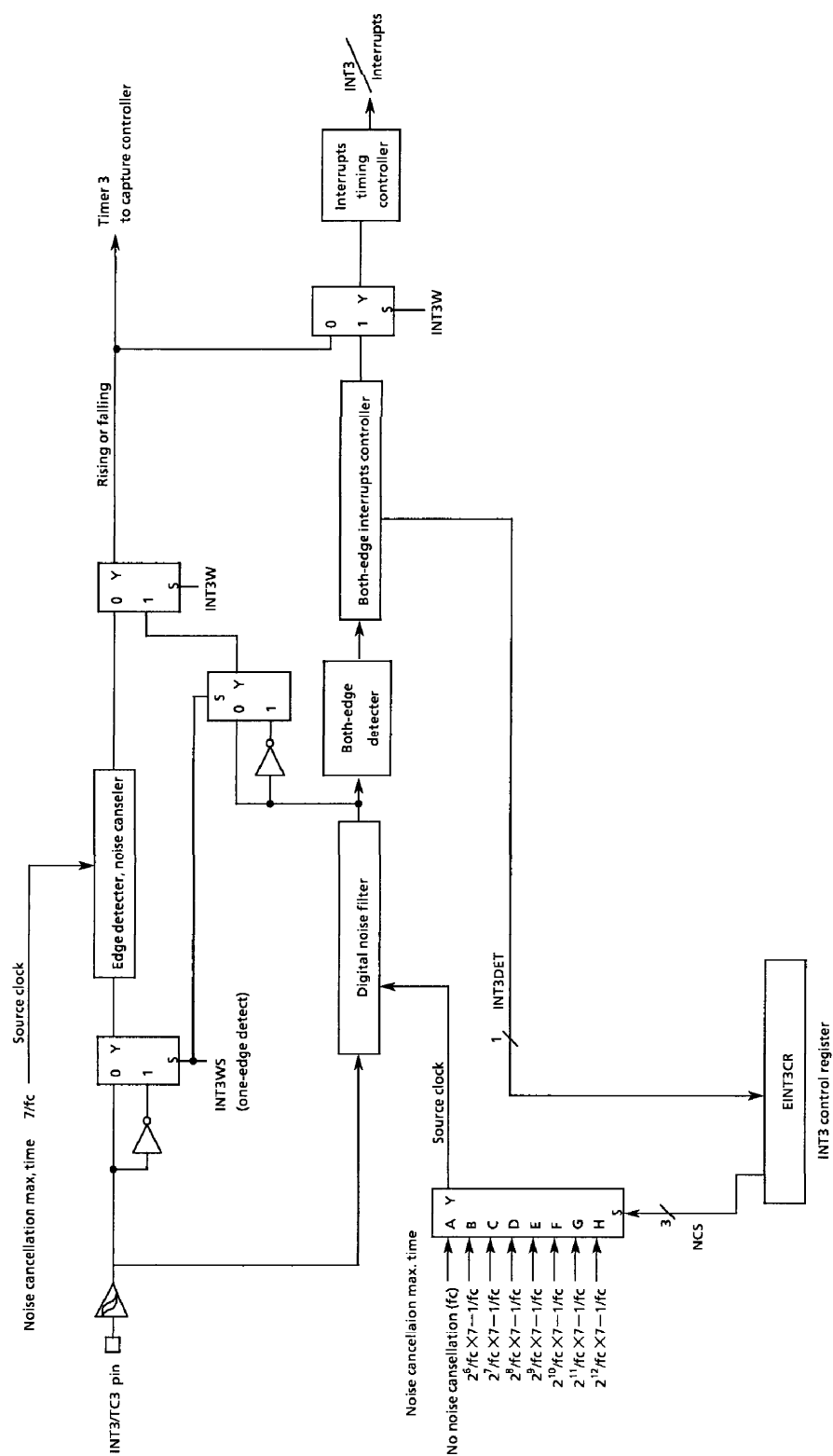


Figure1-26. (C) Bother One Edge Detector of INT3/TC3 Pin

Notes on the usage of INT3 pin (external interrupt)

1. In the case of using the INT3 pin for one edge (either rising or falling).

Note: In order to set/rewrite external interrupt control register(EINTCR), set/rewrite external interrupt register in the interrupt disable state (IMF=0). Then, enable interrupt acceptance after interrupt latch cleared.

2. In the case of using the INT3 pin for both edge (rising and falling).

Note 1: When using the INT3 pin for both edges (rising and falling), set bit 0 (INT3W) in EINTCR (#0037_H) to 1.

Note 2: To detect the edge at which an interrupt is generated, read bit 7 (INTEDT) in EINT3CR (#001F_H), that is, at the beginning of the interrupt processing routine.

Note 3: INTEDT is valid only for both-edge interrupts (INT3W=1). INTEDT is set to 1 by an interrupt as the non-selected edge; cleared to 0 after read automatically.

When rising edge is selected (INT3ES=0), bit 7 in INTEDT (#001F_H) is set to 1 when a falling edge is detected at the INT3 pin. (That is, remains 0 if rising edge is detected.)

When falling edge is selected (INT3ES=1), bit 7 in INTEDT: #001F_H is set to 1 when a rising edge is detected at the INT3 pin. (That is, remains 0 at falling edge.)

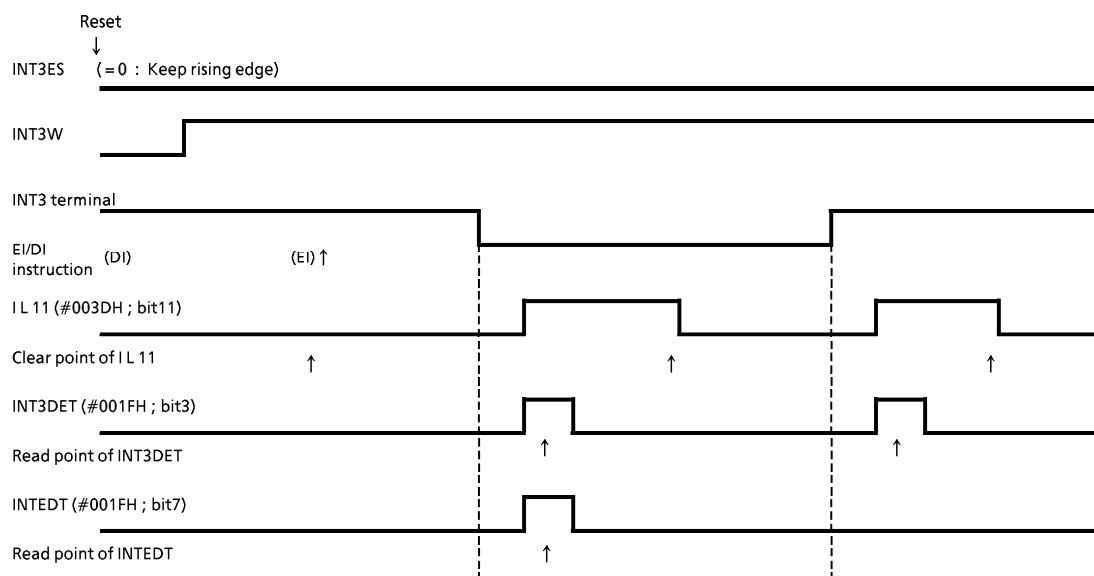
Note 4: In order to set/rewrite external interrupt control register(EINTCR), set/rewrite external interrupt register in the interrupt disable state (IMF=0). Then, enable interrupt acceptance after interrupt latch cleared.

Operation description for INT3 (both-edge interrupt) in use:

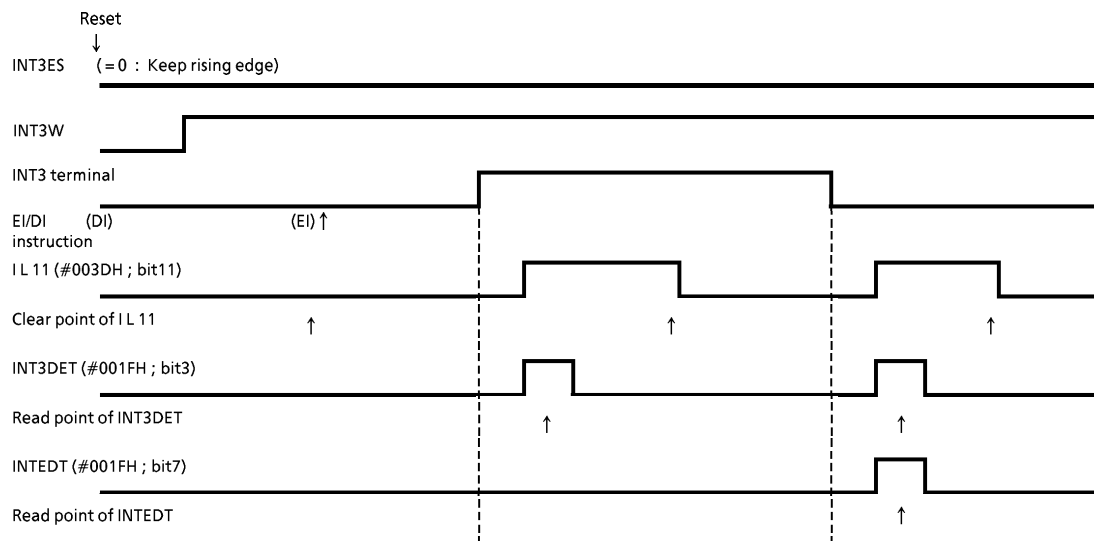
1. Operation without setting/modifying external interrupt control register (EINTCR) after reset:

For both-edge interrupts, rising edge is selected (INT3ES = 0) and fixed.

1) Case1: When the initial state of the INT3 pin is high after reset:

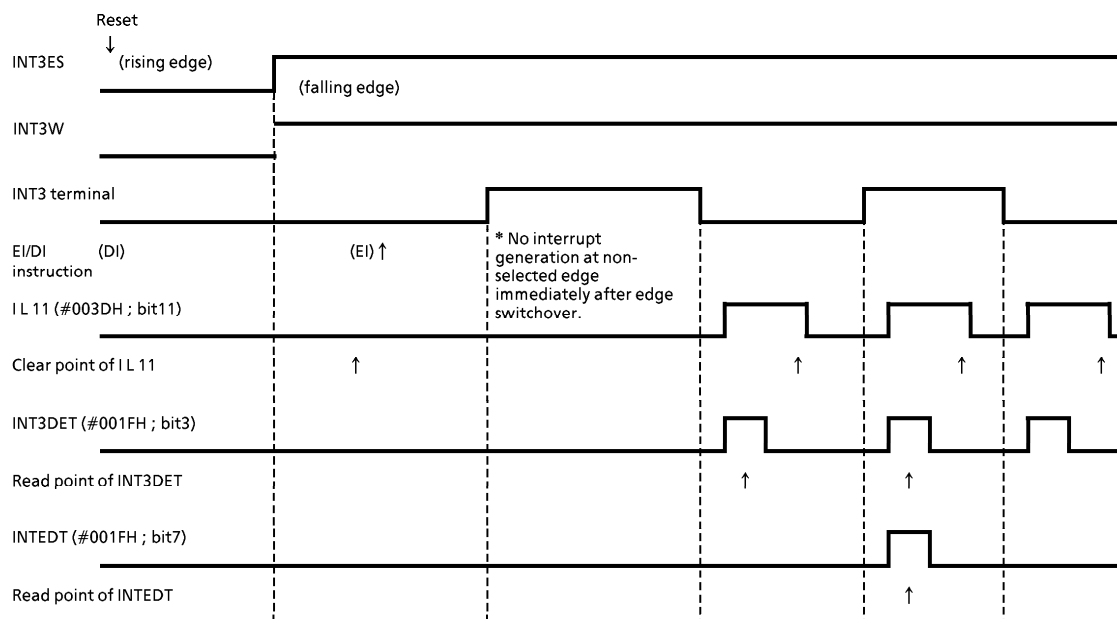


2) Case2: When the initial state of the INT3 pin is low after reset:

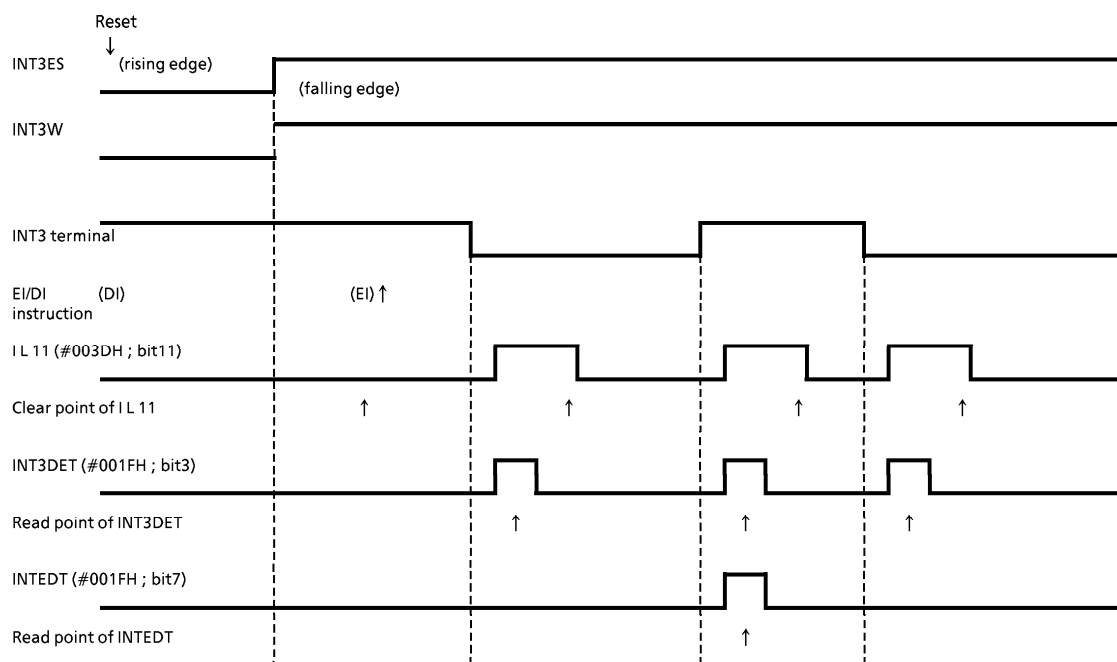


2. Operation with setting/modifying external interrupt control register (EINTCR) after reset:

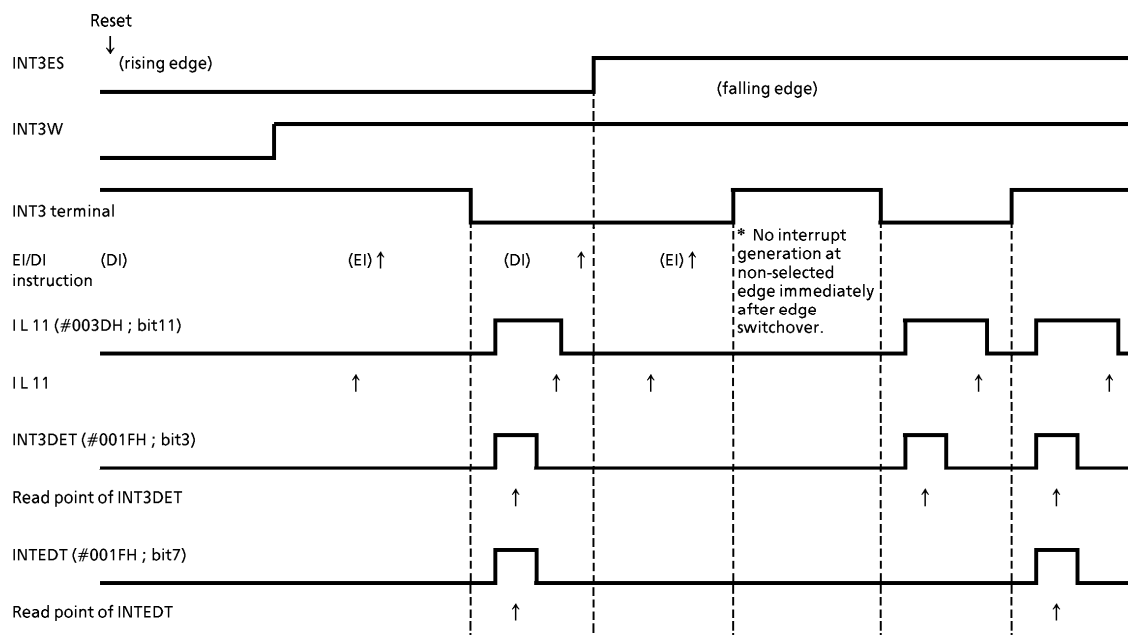
1) Case3: When the initial state of the INT3 pin is low after reset/low at edge switchover from rising to falling:



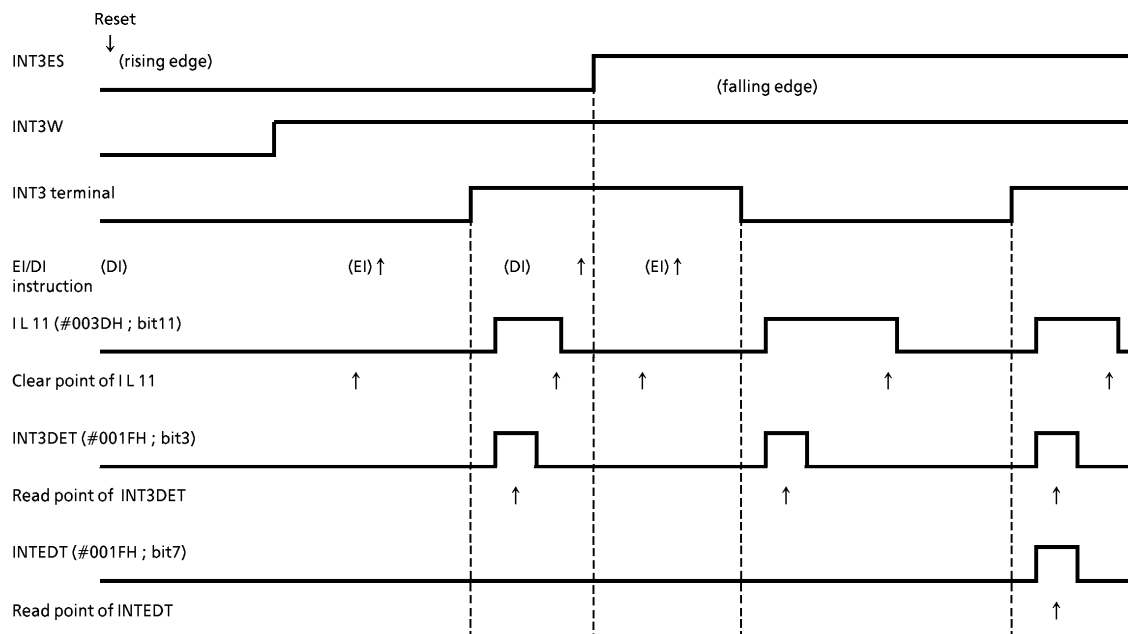
2) Case4: When the initial state of the INT3 pin is high after reset/high at edge switchover from rising to falling:



3) Case5: When the initial state of the INT3 pin is high after reset/low at edge switchover from rising to falling:



4) Case6: When the initial state of the INT3 pin is low after reset/high at edge switchover from rising to falling:



1.10 Watchdog Timer (WDT)

The watchdog timer rapidly detects the CPU malfunction such as endless looping caused by noise or the like, and resumes the CPU to the normal state.

The watchdog timer signal for detecting malfunction can be selected either a reset output or a non-maskable interrupt request. However, selection is possible only once after reset. At first the reset output is selected.

When the watchdog timer is not being used for malfunction detection, it can be used as a timer to generate an interrupt at fixed intervals.

Note: Care must be given in system design so as to protect the Watchdog Timer from disturbing noise. Otherwise the Watchdog Timer may not fully exhibit its functionality.

1.10.1 Watchdog Timer Configuration

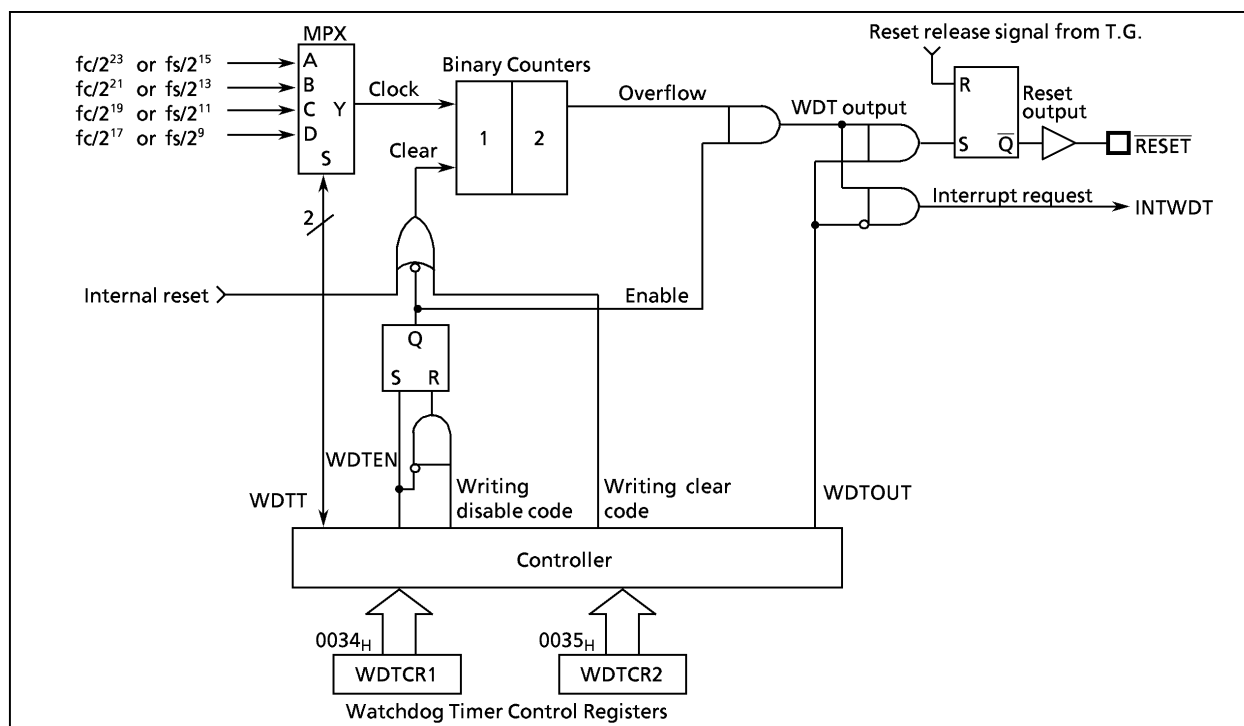


Figure 1-27. Watchdog Timer Configuration

1.10.2 Watchdog Timer Control

Figure 1-28 shows the watchdog timer control registers (WDTCR1, WDTCR2). The watchdog timer is automatically enabled after reset.

(1) Malfunction detection methods using the watchdog timer

The CPU malfunction is detected as follows.

- ① Setting the detection time, selecting output, and clearing the binary counter.
- ② Repeatedly clearing the binary counter within the setting detection time.

If the CPU malfunction occurs for any cause, the watchdog timer output will become active at the rising of an overflow from the binary counters unless the binary counters are cleared. At this time, when $WDTOUT = 1$ a reset is generated, which drives the \overline{RESET} pin low to reset the internal hardware and the external circuits. When $WDTOUT = 0$, a watchdog timer interrupt (INTWDT) is generated.

The watchdog timer temporarily stops counting in the STOP mode including warm-up or IDLE mode, and automatically restarts (continues counting) when the STOP/IDLE mode is released.

Note: The watchdog timer consists of an internal divider and a two-stage binary counter. When clear code $4E_H$ is written, only the binary counter is cleared, not the internal divider. Depending on the timing at which clear code $4E_H$ is written on the WDTCR2 register, the overflow time of the binary counter may be at minimum $3/4$ of the time set in WDTCR1 <WDTT>. Thus, write the clear code using a shorter cycle than $3/4$ of the time set in WDTCR1 <WDTT>.

Example : Sets the watchdog timer detection time to $2^{21}/f_c$ [s] and resets the CPU malfunction.

	LD	(WDTCR1), 00001101B	; WDTT ← 10, WDTOUT ← 1
Within 3/4 of WDT detection time	LD	(WDTCR2), $4E_H$; Clears the binary counters (always clear immediately after changing WDTT)
	LD	(WDTCR2), $4E_H$; Clears the binary counters
Within 3/4 of WDT detection time	LD	(WDTCR2), $4E_H$; Clears the binary counters

Watchdog Timer Control Register 1

WDTCR1 (0034_H)

7	6	5	4	3	2	1	0
				WDT EN	WDTT	WDT OUT	

(Initial value : **** 1001)

WDTEN	Watchdog timer enable/disable	0 : Disable (It is necessary to write the disable code to WDTCR2) 1 : Enable	Write only
WDTT	Watchdog timer detection time	00 : $2^{25}/f_c$ or $2^{17}/f_s$ [s] 01 : $2^{23}/f_c$ or $2^{15}/f_s$ 10 : $2^{21}/f_c$ or $2^{13}/f_s$ 11 : $2^{19}/f_c$ or $2^{11}/f_s$	
WDTOUT	Watchdog timer output select	0 : Interrupt request 1 : Reset output	

Note 1: WDTOUT cannot be set to "1" by program after clearing WDTOUT to "0".

Note 2: f_c : High-frequency clock [Hz] f_s : Low-frequency clock [Hz] *: Don't care

Note 3: WDTCR1 is a write-only register and must not be used with any of read-modify-write instructions.

Note 4: The watchdog timer must be disabled or the counter must be cleared immediately before entering to the STOP mode. When the counter is cleared, the counter must be cleared again immediately after releasing the STOP mode.

Watchdog Timer Control Register 2

WDTCR2 (0035_H)

7	6	5	4	3	2	1	0

(Initial value : **** *)

WDTCR2	Watchdog timer control code write register	$4E_H$: Watchdog timer binary counter clear (clear code) $B1_H$: Watchdog timer disable (disable code) others : Invalid	Write only
--------	--	---	------------

Note 1: The disable code is invalid unless written when WDTEN = 0.

Note 2: *: Don't care

Note 3: Since WDTCR2 is a write-only register, read-modify-write instructions (e.g., bit manipulating instructions such as SET or CLR and arithmetic instructions such as AND or OR) cannot be used for read/write to this register.

Note 4: Write clear code $4E_H$ within $3/4$ of the time set in WDTCR1 <WDTT>.

Figure 1-28. Watchdog Timer Control Registers

Table 1-4. Watchdog Timer Detection Time

Operating mode			Detection time	
NORMAL1	NORMAL2	SLOW	At $f_c = 8\text{ MHz}$	At $f_s = 32.768\text{ kHz}$
$2^{25}/f_c$ [s]	$2^{25}/f_c, 2^{17}/f_s$	$2^{17}/f_s$	4.194 s	4 s
$2^{23}/f_c$	$2^{23}/f_c, 2^{15}/f_s$	$2^{15}/f_s$	1.048 ms	1 s
$2^{21}/f_c$	$2^{21}/f_c, 2^{13}/f_s$	—	262.1 ms	250 ms
$2^{19}/f_c$	$2^{19}/f_c, 2^{11}/f_s$	—	65.5 ms	62.5 ms

(2) Watchdog Timer Enable

The watchdog timer is enabled by setting WDTEN (bit 3 in WDTCR1) to "1". WDTEN is initialized to "1" during reset, so the watchdog timer operates immediately after reset is released.

Example : Enables watchdog timer

```
LD      (WDTCR1), 00001000B      ; WDTEN←1
```

(3) Watchdog Timer Disable

The watchdog timer is disabled by writing the disable code (B1_H) to WDTCR2 after clearing WDTEN (bit 3 in WDTCR1) to "0". The watchdog timer is not disabled if this procedure is reversed and the disable code is written to WDTCR2 before WDTEN is cleared to "0".

During disabling the watchdog timer, the binary counters are cleared to "0".

Example : Disables watchdog timer

```
LDW     (WDTCR1), 0B101H        ; WDTEN←0, WDTCR1←disable code
```

1.10.3 Watchdog Timer Interrupt (INTWDT)

This is a pseudo non-maskable interrupt which can be accepted regardless of the contents of the EIR. If a watchdog timer interrupt or a software interrupt is already accepted, however, the new watchdog timer interrupt waits until the previous interrupt processing is completed (the end of the [RETN] instruction execution).

The stack pointer (SP) should be initialized before using the watchdog timer output as an interrupt source with WDTOUT.

Example : Watchdog timer interrupt setting up.

```
LD      SP, 083FH                ; Sets the stack pointer
LD      (WDTCR1), 00001000B      ; WDTOUT←0
```

1.10.4 Watchdog Timer Reset

If the watchdog timer output becomes active, a reset is generated, which drives the $\overline{\text{RESET}}$ pin low to reset the internal hardware. The reset output time is $2^{20}/f_c$ [s] (131 ms at $f_c = 8$ MHz). The $\overline{\text{RESET}}$ pin is sink open drain input/output with pull-up resistor.

Note: The high-frequency clock oscillator also turns on when a watchdog timer reset is generated in SLOW mode. Thus, the reset output time is $2^{20}/f_c$.

The reset output time include a certain amount of error if there is any fluctuation of the oscillation frequency when the high-frequency clock oscillator turns on. Thus, the reset output time must be considered approximate value.

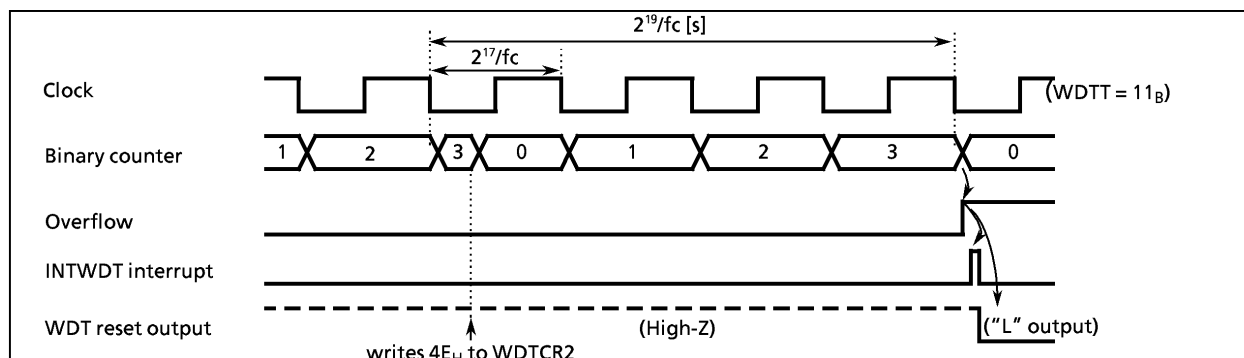


Figure 1-29. Watchdog Timer Interrupt/Reset

1.11 Reset Circuit

The TMP87CM24A/P24A each have four types of reset generation procedures: an external reset input, an address trap reset, a watchdog timer reset and a system clock reset. Table 1-5 shows on-chip hardware initialization by reset action. The internal source reset circuit (watchdog timer reset, address trap reset, and system clock reset) is not initialized when power is turned on. Thus, output from the $\overline{\text{RESET}}$ pin may go low ($2^{20}/f_c$ [s] (131 ms at 8 MHz) when power is turned on.

Table 1-5. Initializing Internal Status by Reset Action

On-chip Hardware	Initial Value	On-chip Hardware	Initial Value
Program counter (PC)	(FFFF _H) · (FFFE _H)	Divider of Timing generator	0
Register bank selector (RBS)	0	Watchdog timer	Enable
Jump status flag (JF)	1	Output latches of I/O ports	Refer to I/O port circuitry
Interrupt master enable flag (IMF)	0	Control registers	Refer to each of control register
Interrupt individual enable flags (EF)	0		
Interrupt latches (IL)	0		

1.11.1 External Reset Input

When the $\overline{\text{RESET}}$ pin is held at low for at least 3 machine cycles ($12/f_c$ [s]) with the power supply voltage within the operating voltage range and oscillation stable, a reset is applied and the internal state is initialized.

When the $\overline{\text{RESET}}$ pin input goes high, the reset operation is released and the program execution starts at the vector address stored at addresses FFFE_H to FFFF_H .

The $\overline{\text{RESET}}$ pin contains a Schmitt trigger (hysteresis) with an internal pull-up resistor. A simple power-on-reset can be applied by connecting an external capacitor and a diode.

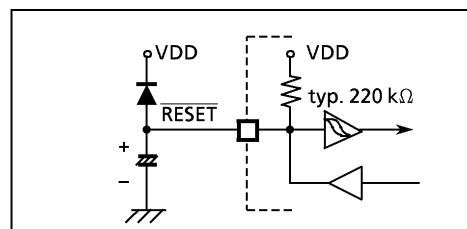


Figure 1-30. Simple Power-on-Reset Circuitry

1.11.2 Address-Trap-Reset

An address-trap-reset is one of fail-safe function that detects CPU malfunction such as endless looping caused by noise or the like, and returns the CPU to the normal state. If the CPU attempts to fetch an instruction from a part of RAM or SFRs (address 0000_H to $083F_H$ for TMP87CM24A/P24A), an address-trap-reset will be generated. Then, the $\overline{\text{RESET}}$ pin output will go low. The reset time is $2^{20}/f_c$ [s] (131 ms at 8 MHz).

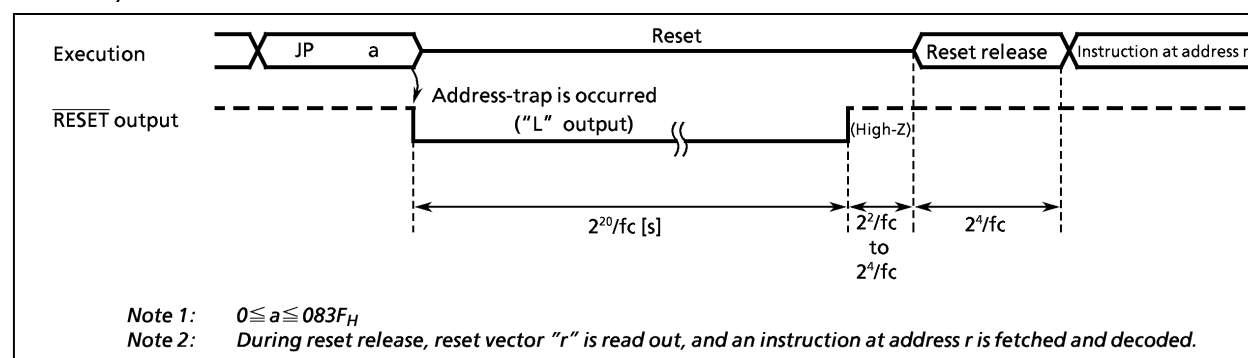


Figure 1-31. Address-Trap-Reset

1.11.3 Watchdog Timer Reset

Refer to Section "1.10 Watchdog Timer".

1.11.4 System-Clock-Reset

Clearing both XEN and XTEN (bits 7 and 6 in SYSCR2) to "0" stops both high-frequency and low-frequency oscillation, and causes the MCU to deadlock. This can be prevented by automatically generating a reset signal whenever $\text{XEN} = \text{XTEN} = 0$ is detected to continue the oscillation. Then, the $\overline{\text{RESET}}$ pin output goes low from high-impedance. The reset time is $2^{20}/f_c$ [s] (131 ms at 8 MHz).

2. Peripheral Hardware Functions

2.1 Special Function Registers (SFR) and Data Buffer Registers (DBR)

The TLCS-870 Series uses the memory mapped I/O system, and all peripherals control and data transfers are performed through the special function registers (SFR) and data buffer registers (DBR).

The SFR are mapped to addresses 0000_H to 003F_H and the DBR to addresses 0F80_H to 0FFF_H.

Figure 2-1 shows the TMP87CM24A/P24A SFRs and DBRs.

Address	Read	Write	Address	Read	Write
0000 _H		P0 Port	0020 _H	SIO1SR (SIO1 status)	SIO1CR1 (SIO1 control)
01		P1 Port	21	—	SIO1CR2
02		P2 Port	22	SIO2SR (SIO2 status)	SIO2CR1 (SIO2 control)
03		P3 Port	23	—	SIO2CR2
04		P4 Port	24		Reserved
05		P5 Port	25		Reserved
06		P6 Port	26		Reserved
07		P7 Port	27		Reserved
08		P8 Port	28	—	LDCR (LCD control)
09		P9 Port	29	—	P6CR (P6 segment output control)
0A	—	P0CR (P0 I/O control)	2A	—	P7CR (P7 segment output control)
0B	—	P1CR (P1 I/O control)	2B	—	P8CR (P8 segment output control)
0C		P4CR1 (P4 I/O control)	2C	—	P9CR (P9 segment output control)
0D		P5CR (P5 I/O control)	2D	—	P4CR2 (P4 output control)
0E		ADCCR (AD converter control)	2E		Reserved
0F	ADCCR (AD conv. result)	—	2F		Reserved
10	—	TREG1A _L (Timer register 1A)	30		Reserved
11	—	TREG1A _H	31		Reserved
12	TREG1B _L	(Timer register 1B)	32		Reserved
13	TREG1B _H		33		Reserved
14	—	TC1CR (TC1 control)	34	—	WDTTCR1 (WDT control)
15	—	TC2CR (TC2 control)	35	—	WDTTCR2
16	—	TREG2 _L (Timer register 2)	36	TBTCR	(TBT/TG/DVO control)
17	—	TREG2 _H	37	EINTCR	(External interrupt control 1)
18	TREG3A (Timer register 3A)	—	38	SYSR1	(System control)
19	TREG3B (Timer register 3B)	—	39	SYSR2	
1A	—	TC3CR (TC 3 control)	3A	EIR _L	(Interrupt enable register)
1B	reserved	reserved	3B	EIR _H	
1C	reserved	reserved	3C	IL _L	(Interrupt latch)
1D	—	TREG5 (Timer register 5)	3D	IL _H	
1E	—	TC5CR (TC 5 control)	3E		Reserved
1F	EINT3CR (External interrupt control 2)		3F	PSW (program status word)	RBS (register bank selector)

(a) Special Function Registers

Address	Read	Write
0F80 _H		LCD display data buffer
0F93		
0F94		Reserved
0FEF		
0FF0		SIO1 transmit and receive data buffer
0FF7		
0FF8		SIO2 transmit and receive data buffer
0FFF		

(b) Data Buffer Registers

Note 1: Do not access reserved areas by the program.

Note 2: When defining address 003F_H with assembler symbols, use GPSW and GRBS.

Note 3: —: Do not access.

Note 4: Operations specified to writing registers and interrupt latches by read modifying write instructions (bit operation instructions such as SET, CLR, etc., or operation instructions such as AND, OR, etc.) are not effective.

Figure 2-1. SFR & DBR

2.2 I/O Ports

The TMP87CM24A/P24A have 10 parallel input/output ports (69 pins) each as follows:

	Primary Function	Secondary Functions
Port P0	8-bit I/O port	—
Port P1	8-bit I/O port	External interrupt input, timer/counter input/output, and divider output
Port P2	3-bit I/O port	Low-frequency resonator connections, external interrupt input, and STOP mode release signal input
Port P3	6-bit I/O port	—
Port P4	8-bit I/O port	Serial interface, external interrupt input, timer/counter input/output
Port P5	8-bit I/O port	Analog input
Port P6	8-bit I/O port	Segment Output
Port P7	8-bit I/O port	Segment Output
Port P8	8-bit I/O port	Segment Output
Port P9	4-bit I/O port	Segment Output

Each output port contains a latch, which holds the output data. All input ports do not have latches, so the external input data should either be held externally until read or reading should be performed several times before processing. Figure 2-2 shows input/output timing examples.

External data is read from an I/O port in the S1 state of the read cycle during execution of the read instruction. This timing can not be recognized from outside, so that transient input such as chattering must be processed by the program.

Output data output changes in the S2 state of the write cycle during execution of the instruction which writes to an I/O port.

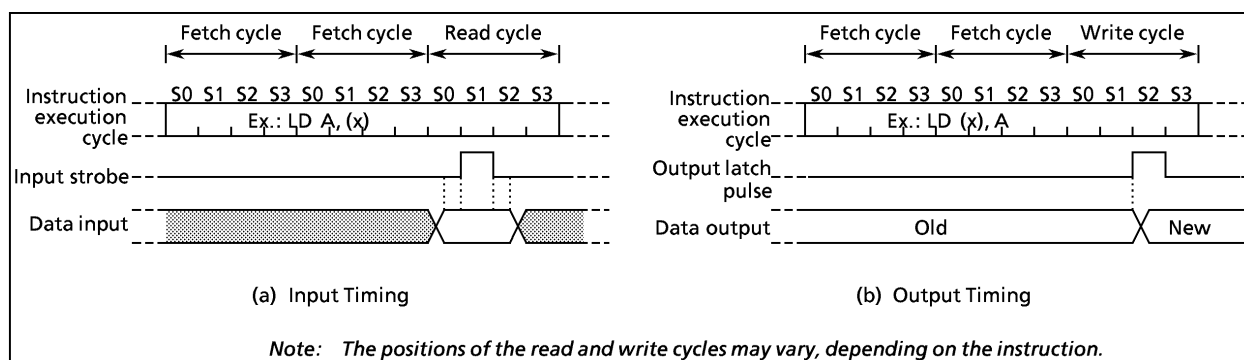


Figure 2-2. Input/Output Timing (Example)

When reading an I/O port except programmable I/O ports, whether the pin input data or the output latch contents are read depends on the instructions, as shown below:

(1) Instructions that read the output latch contents

- | | |
|-------------------------|--|
| ① XCH r, (src) | ⑤ LD (pp) . b, CF |
| ② CLR/SET/CPL (src).b | ⑥ ADD/ADDC/SUB/SUBB/AND/OR/XOR (src), n |
| ③ CLR/SET/CPL (pp).g | ⑦ (src) side of ADD/ADDC/SUB/SUBB/AND/OR/XOR (src), (HL) |
| ④ LD (src).b, CF | |

(2) Instructions that read the pin input data

- ① Instructions other than the above (1)
- ② (HL) side of ADD/ADDC/SUB/SUBB/AND/OR/XOR (src), (HL)

2.2.1 Port P0 (P07 to P00)

Port P0 is an 8-bit general-purpose input/output port which can be configured as either an input or an output in one-bit unit under software control. Input/output mode is specified by the corresponding bit in the port P0 input/output control register (P0CR). Port P0 is configured as an input if its corresponding P0CR bit is cleared to "0", and as an output if its corresponding P0CR bit is set to "1".

During reset, P0CR is initialized to "0", which configures port P0 as input. The P0 output latches are also initialized to "0".

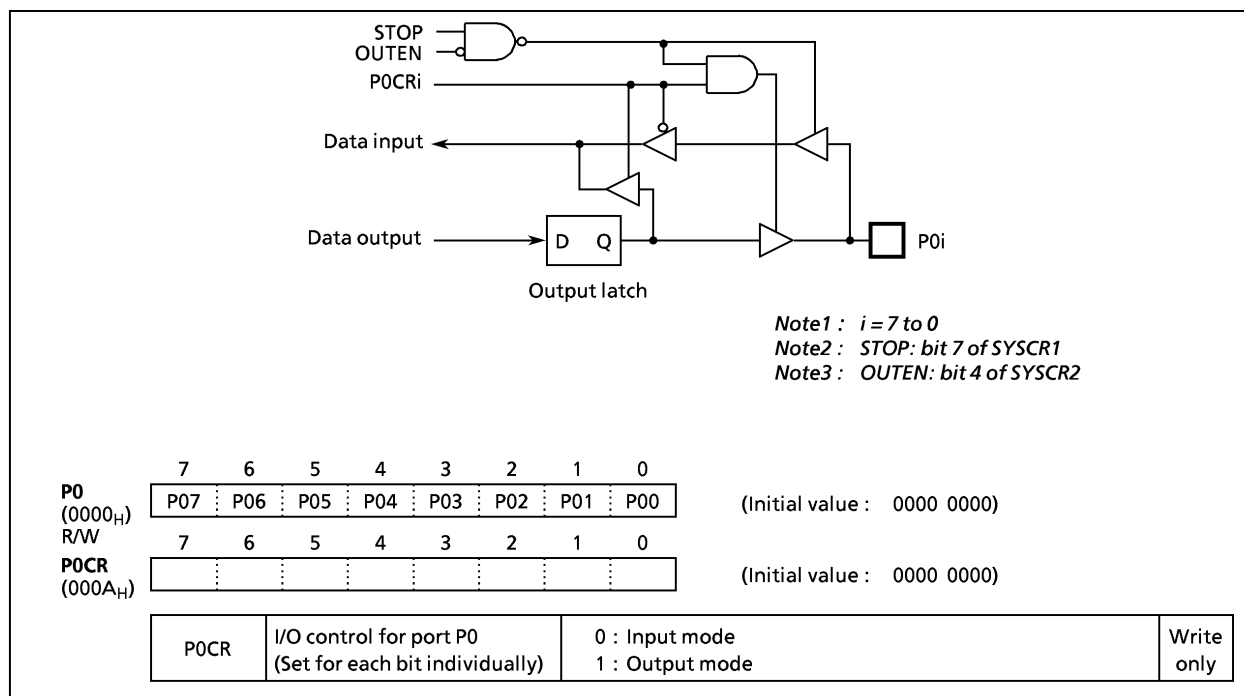


Figure 2-3. Port P0 and P0CR

Example : Setting the upper 4 bits of port P0 as an input port and the lower 4 bits as an output port (Initial output data are 1010_B).

```
LD      (P0), 00001010B    ; Sets initial data to P0 output latches
LD      (P0CR), 00001111B  ; Sets the port P0 input/output mode
```

Note 1 : Ports set to the input mode read the pin states. When input pin and output pin exist in port P0 together, the contents of the output latch of ports set to the input mode may be rewritten by executing the bit manipulation instructions. Pins set to the output mode read a value of the output latch.

Note 2 : The P0CR is a write-only register. It can not be operated by the read-modify-write instruction (Bit manipulation instructions of SET, CLR, etc. and Arithmetic instructions of AND, OR, etc.)

2.2.2 Port P1 (P17 to P10)

Port P1 is an 8-bit input/output port which can be configured as an input or an output in one-bit unit under software control. Input/output mode is specified by the corresponding bit in the port P1 input/output control register (P1CR). Port P1 is configured as an input if its corresponding P1CR bit is cleared to "0", and as an output if its corresponding P1CR bit is set to "1". During reset, the P1CR is initialized to "0", which configures port P1 as an input. The P1 output latches are also initialized to "0". Port P1 is also used as an external interrupt input, a timer/counter input/output, and a divider output. When used as secondary function pin, the input pins should be set to the input mode, and the output pins should be set to the output mode and beforehand the output latch should be set to "1".

It is recommended that pins P11 and P12 should be used as external interrupt inputs, timer/counter input, or input ports. The interrupt latch is set at the rising or falling edge of the output when used as output ports.

Pin P10 ($\overline{\text{INT0}}$) can be configured as either an I/O port or an external interrupt input with INT0EN (bit 6 in EINTCR). During reset, pin P10 ($\overline{\text{INT0}}$) is configured as an input port P10.

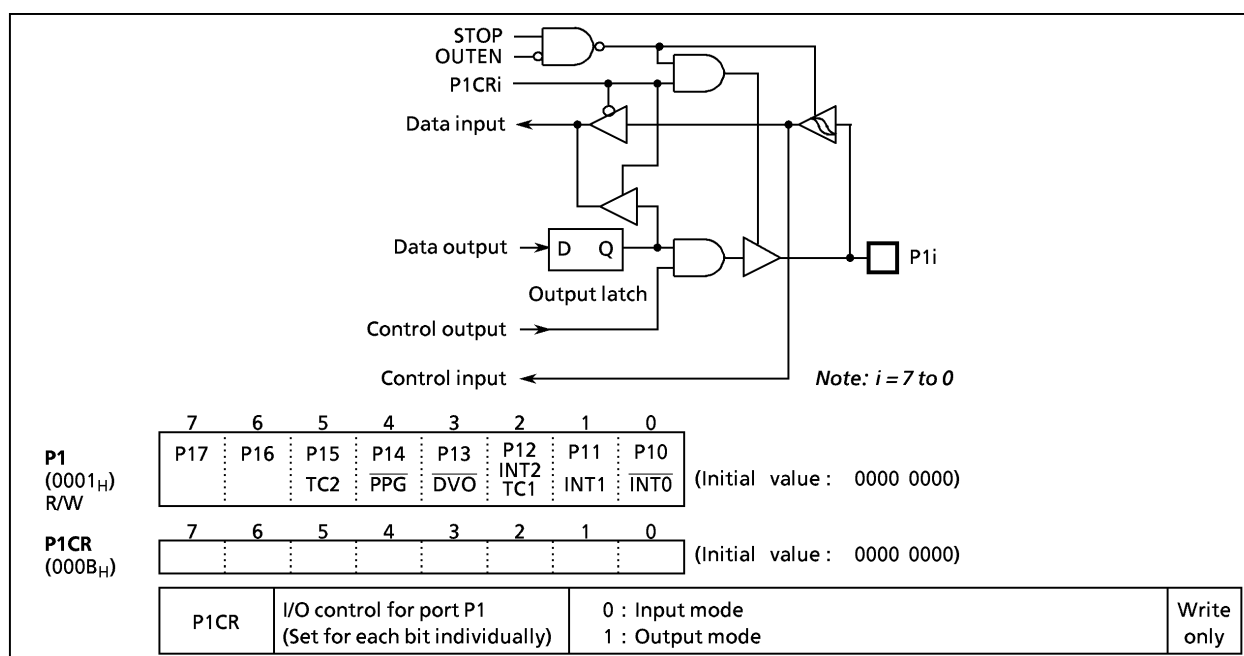


Figure 2-4. Port P1 and P1CR

Example : Sets P17, P16 and P14 as output ports, P13 and P11 as input ports, and the others as function pins. Internal output data is "1" for the P17 and P14 pins, and "0" for the P16 pin.

```
LD (EINTCR), 01000000B ; INT0EN←1
LD (P1), 10111111B ; P17←1, P14←1, P16←0
LD (P1CR), 11010000B
```

Note 1 : Ports set to the input mode read the pin states. When input pin and output in exist in port P1 together, the contents of the output latch of ports set to the input mode may be rewritten by executing the bit manipulation instructions. Pins set to the output mode read a value of the output latch.

Note 2 : The P1CR is a write-only register. It can not be operated by the read-modify-write instruction (Bit manipulation instructions of SET, CLR, etc. and Arithmetic instructions of AND, OR, etc.)

2.2.3 Port P2 (P22 to P20)

Port P2 is a 3-bit input/output port. It is also used as an external interrupt input, a STOP mode release signal input, and low-frequency crystal connection pins. When used as an input port, or a secondary function pin, the output latch should be set to "1". During reset, the output latches are initialized to "1".

A low-frequency crystal (32.768 kHz) is connected to pins P21 (XTIN) and P22 (XTOUT) in the dual-clock mode. In the single-clock mode, pins P21 and P22 can be used as normal input/output ports.

It is recommended that pin P20 should be used as an external interrupt input, a STOP mode release signal input, or an input port. If used as an output port, the interrupt latch is set on the falling edge of the output pulse.

When a read instruction is executed for port P2, bits 7 to 3 read in as indefinite.

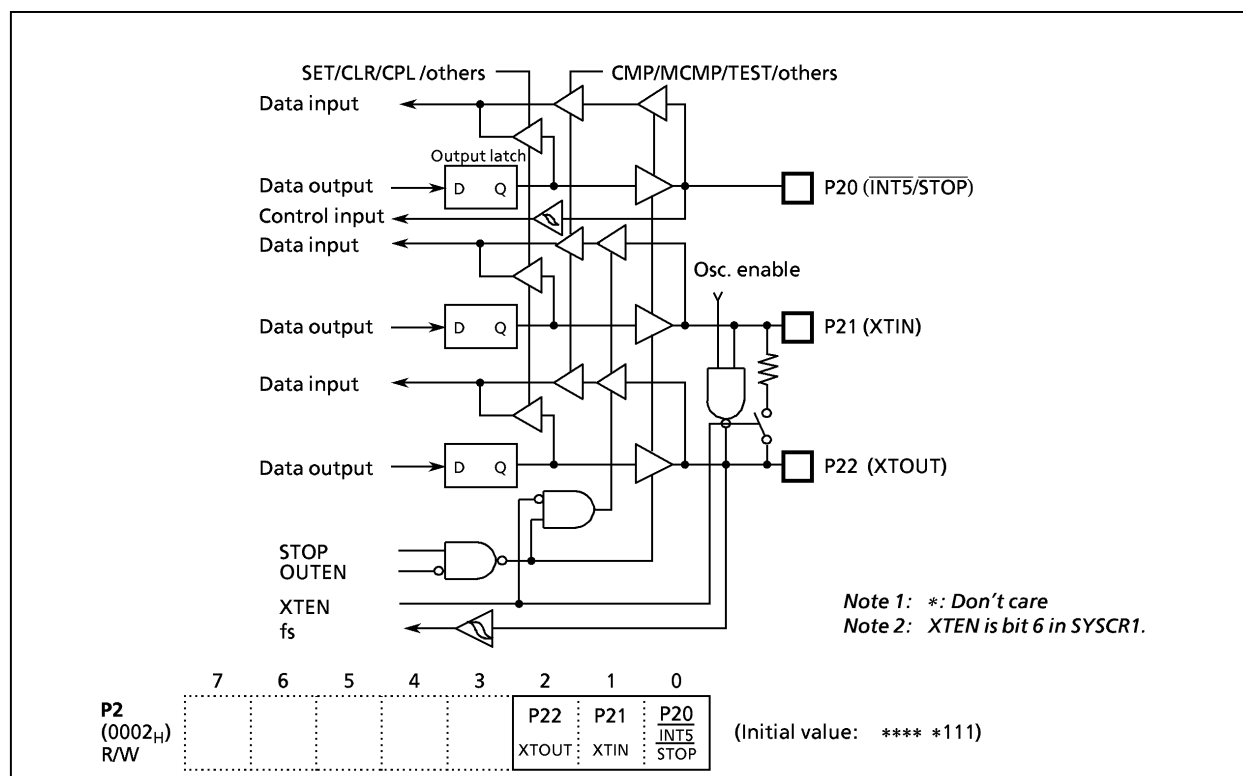


Figure 2-5. Port P2

2.2.4 Port P3 (P35 to P30)

Port P3 is an 6-bit input/output port. When used as an input port, the output latch should be set to "1". The output latches are initialized to "1" during reset.

When a read instruction is executed for port P3, bit 7 and bit 6 read in as indefinite.

Example 1: Output the immediate data 2A_H to the P3 port.

LD (P3), 2AH ; P3←2AH

Example 2: Inverts the output of the upper 3bits (P35 to P34) of the P3 port.

```
XOR    (P3),**110000B
                                ; P35 to P34← $\overline{P35}$  to  $\overline{P34}$ 
```

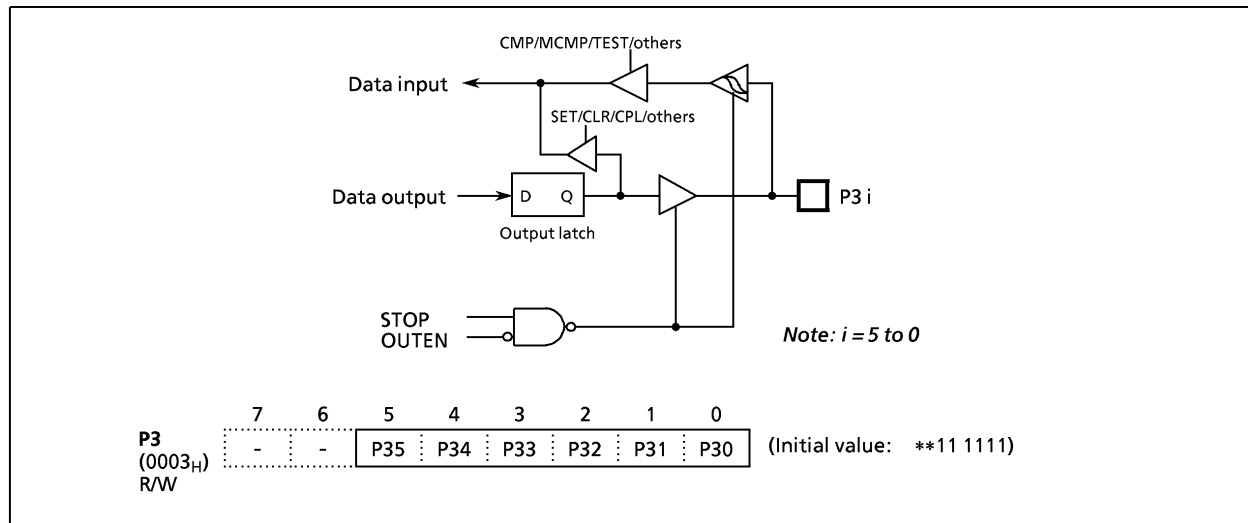


Figure 2-6. Port P3

2.2.5 Port P4 (P47 to P40)

Port P4 is an 8-bit input/output port, and is also used as an external interrupt input, a timer/counter input/output and a serial interface input/output. Input/output mode is specified by the corresponding bit in the port P4 input/output control register (P4CR1). It can be selected whether output circuit of P4 port is Push-pull port or Sink open drain individually, by setting P4CR2.

When used as a timer/counter output and serial interface output, respective P4CR1 should be set to "1" after P4 output latch is set to "1".

When used as an input port, external interrupt input, timer/counter input and serial interface input, respective P4CR1 should be set to "0" after P4CR2 is set to "0".

During reset, the P4CR1 is initialized to "1", and configures port P4 as an output mode. Also, port P4 output latch is initialized to "1".

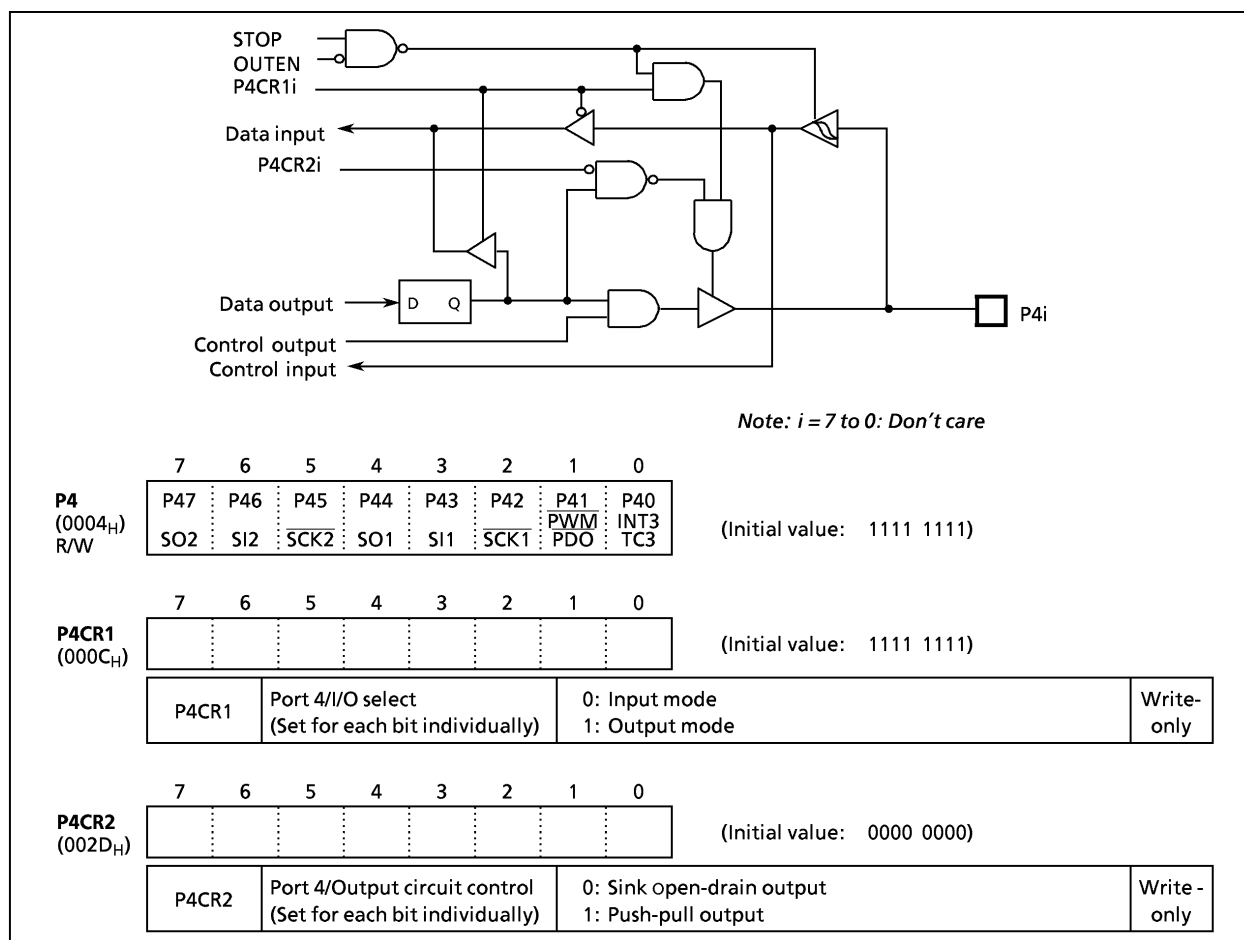


Figure 2-7. Port P4

Note 1: Ports set to the input mode read the pin states. When input pin and output pin exist in port P4 together, the contents of the output latch of ports set to the input mode may be rewritten by executing the bit manipulation instructions. Pins set to the output mode read a value of the output latch.

Note 2: The P4CR1 and P4CR2 are a write-only register. It can not be operated by the read-modify-write instruction (Bit manipulation instructions of SET, CLR, etc. and Arithmetic instructions of AND, OR, etc.)

2.2.6 Port P5 (P57 to P50)

Port P5 is a general-purpose 8-bit I/O port that can be specified bitwise. It is also used for analog input. Specify input or output using the P5 I/O control register (P5CR) and AINDS (bit 4 of ADCCR). During reset, because P5CR and AINDS are initialized to "0", P50 port is specified for analog input and P51 to P57 ports are specified for port input. At reset, the output latch of port P5 is initialized to "0". The P5CR is write-only register. The pins of port P5 not specified for analog input can be used as an I/O port; to maintain accuracy, do not use them for output instructions during AD conversion. While the AD converter is operating, if a read instruction is executed for port P5, read data of port selected to analog input is "1".

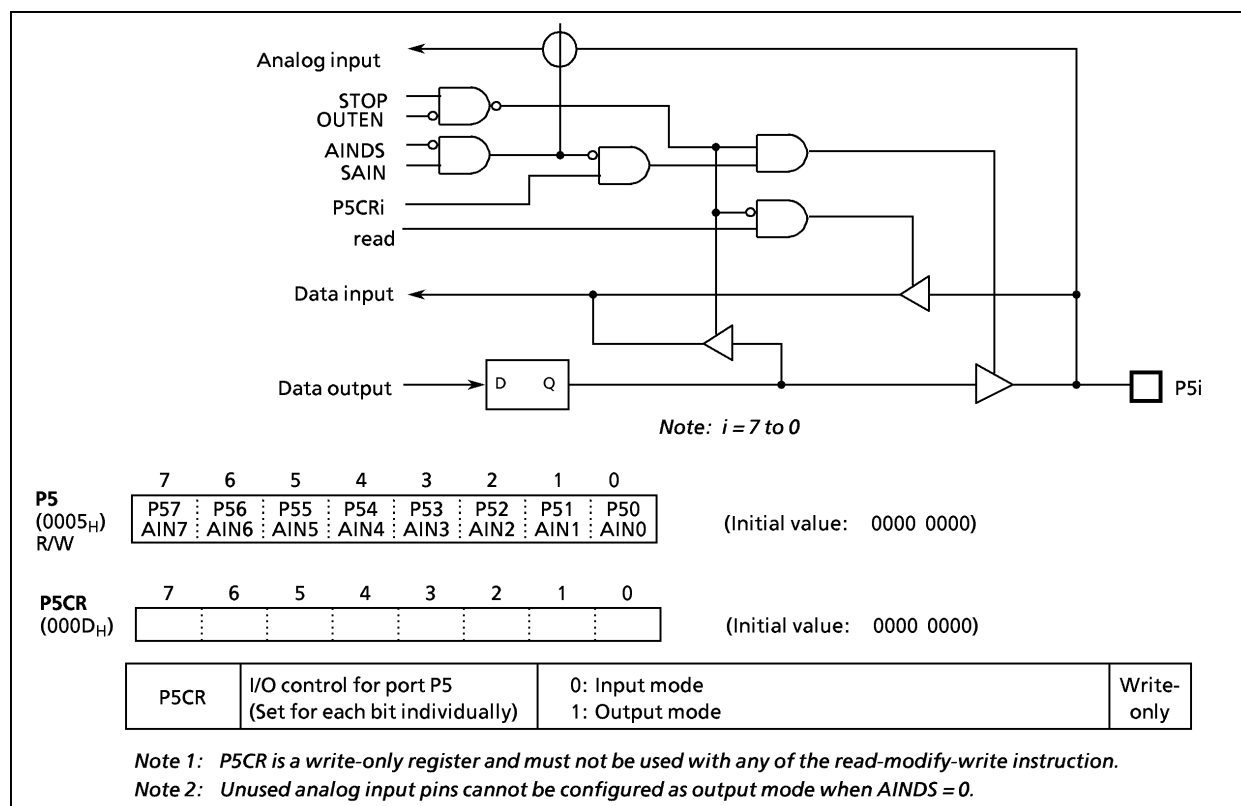


Figure 2-8. Port P5

Note 1: Ports set to the input mode read the pin states. When input pin and output pin exist in port P5 together, the contents of the output latch of ports set to the input mode may be rewritten by executing the bit manipulation instructions. Pins set to the output mode read a value of the output latch.

Note 2: The P5CR is a write-only register. It can not be operated by the read-modify-write instruction (Bit manipulation instructions of SET, CLR, etc. and Arithmetic instructions of AND, OR, etc.)

2.2.7 Ports P6 (P67 to P60) Port P7 (P77 to P70) Port P8 (P87 to P80) Port P9 (P93 to P90)

Port P6, P7, P8 and P9 are an 8-bit input/output ports and are also used as the segment output port.

Input/output mode or segment output mode is specified by the corresponding bit in the PxCR port control register (PxCR). During reset, PxCR is initialized to "0", which configure port Px as input/output. Port Px output latches are also initialized to "1". PxCR can only be written.

When a read instruction is executed for port P9, bits 7 to 4 read in as indefinite.

Note: x = 6,7,8,9

Example: Setting the upper 2 bits of port P6 as a segment output port, and the others as input/output port.

LD (P6CR), 11000000B

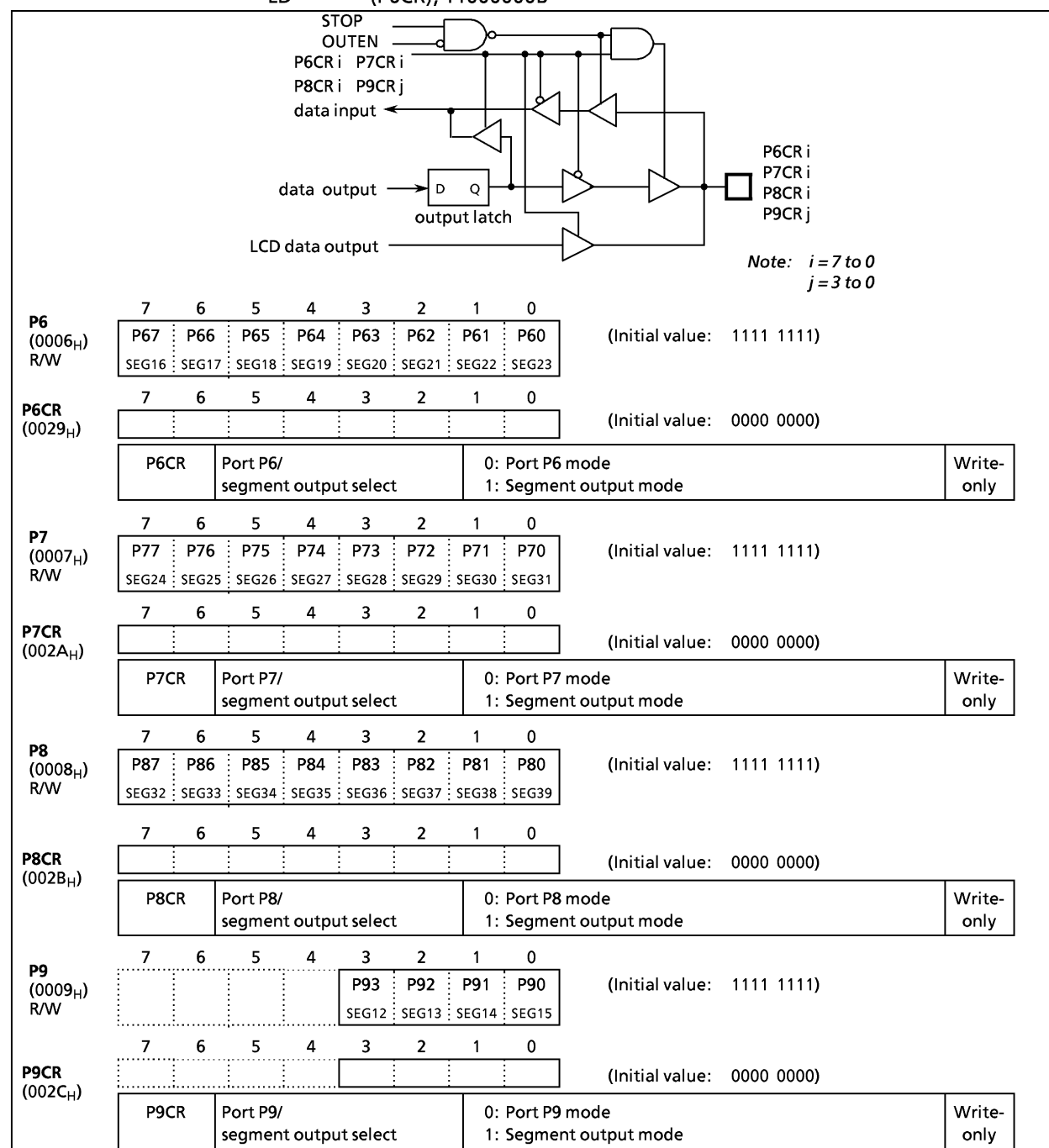


Figure 2-9. Port P6, P7, P8, P9

Note: The P6CR, P7CR, P8CR and P9CR are write-only register. It can not be operated by the read-modify instruction (Bit manipulation instructions of SET, CLR, etc. and Arithmetic instructions of AND, OR, etc.)

2.3 Time Base Timer (TBT)

The time-base timer is used to generate the base time for key scan and dynamic display processing. For this purpose, it generates a time-base timer interrupt (INTTBT) at predetermined intervals.

This interrupt is generated beginning with the first rising edge of the source clock (the timing generator's divider output selected by TBTCK) after the time-base timer is enabled. Note that since the divider cannot be cleared by a program, the first interrupt only may occur earlier than the set interrupt period. (See Figure 2-10. (b).)

When selecting the interrupt frequency, make sure the time-base timer is disabled. (Do not change the selected interrupt frequency when disabling the active timer either.) However, you can select the interrupt frequency simultaneously when enabling the timer.

Example : Sets the time base timer frequency to $fc/2^{16}$ [Hz] and enables an INTTBT interrupt.

LD (TBTCT), 00001010B
SET (EIRL). 6

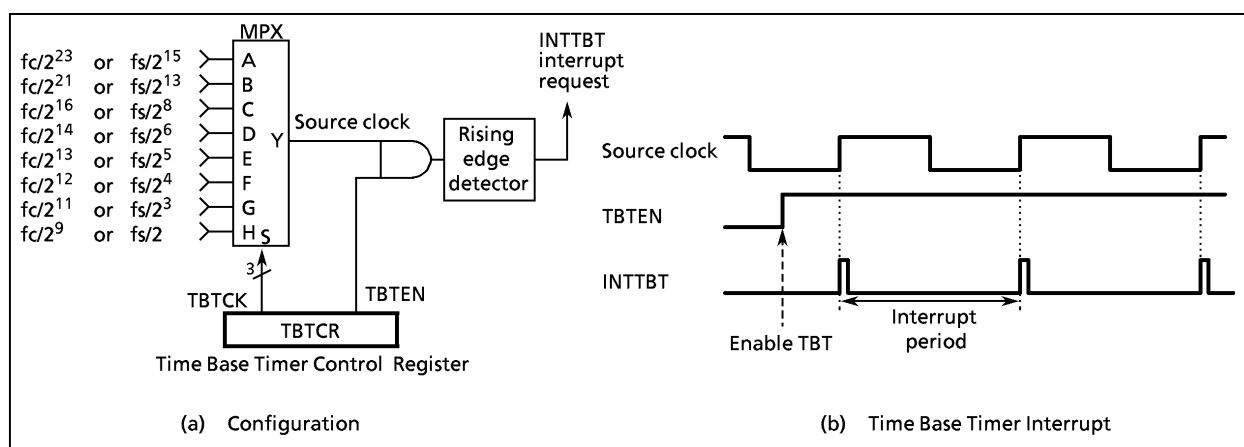


Figure 2-10. Time Base Timer

TBTCT (0036 _H)								(Initial value : 0**0 0**)	
7	6	5	4	3	2	1	0		
(DVOEN)	(DVQCK)	(DV7CK)	TBTEN	TBTCK					
TBTEN	Time base timer enable/disable			0 : Disable 1 : Enable				R/W	
TBTCK	Time base timer interrupt frequency select			000 : $fc/2^{23}$ or $fs/2^{15}$ [Hz] 001 : $fc/2^{21}$ or $fs/2^{13}$ 010 : $fc/2^{16}$ or $fs/2^8$ 011 : $fc/2^{14}$ or $fs/2^6$ 100 : $fc/2^{13}$ or $fs/2^5$ 101 : $fc/2^{12}$ or $fs/2^4$ 110 : $fc/2^{11}$ or $fs/2^3$ 111 : $fc/2^9$ or $fs/2$					
Note : <i>fc</i> : High-frequency clock [Hz], <i>fs</i> : Low-frequency clock [Hz], * : Don't care									

Figure 2-11. Time Base Timer Control Register

Table 2-1. Time Base Timer Interrupt Frequency

TBTCK	NORMAL1/2, IDLE1/2 mode		SLOW, SLEEP mode	Interrupt Frequency	
	DV7CK = 0	DV7CK = 1		At $f_c = 8$ MHz	At $f_s = 32.768$ kHz
000	$f_c/2^{23}$	$f_s/2^{15}$	$f_s/2^{15}$	0.95 Hz	1 Hz
001	$f_c/2^{21}$	$f_s/2^{13}$	$f_s/2^{13}$	3.81	4
010	$f_c/2^{16}$	$f_s/2^8$	—	122.07	128
011	$f_c/2^{14}$	$f_s/2^6$	—	488.28	512
100	$f_c/2^{13}$	$f_s/2^5$	—	976.56	1024
101	$f_c/2^{12}$	$f_s/2^4$	—	1953.12	2048
110	$f_c/2^{11}$	$f_s/2^3$	—	3906.25	4096
111	$f_c/2^9$	$f_s/2$	—	15625	16384

2.4 Divider Output (\overline{DVO})

A 50% duty pulse can be output using the divider output circuit, which is useful for piezo-electric buzzer drive. Divider output is from pin P13 (\overline{DVO}). The P13 output latch should be set to "1" and then the P13 should be configured as an output mode.

Divider output circuit is controlled by the control register (TBTCCR) shown in Figure 2-12.

TBTCCR (0036 _H)	7	6	5	4	3	2	1	0	(Initial value : 0**0 0***)
	DVOEN	DVOCK	(DV7CK)	(TBTEN)	(TBTCK)				
DVOEN		Divider output enable/disable		0 : Disable 1 : Enable					R/W
DVOCK		Divider output (\overline{DVO}) frequency selection		00 : $fc/2^{13}$ or $fs/2^5$ [Hz] 01 : $fc/2^{12}$ or $fs/2^4$ 10 : $fc/2^{11}$ or $fs/2^3$ 11 : $fc/2^{10}$ or $fs/2^2$					
Note : fc : High-frequency clock [Hz], fs : Low-frequency clock [Hz], *: Don't care									

Figure 2-12. Divider Output Control Register

Example : 1 kHz pulse output (at $f_c = 8$ MHz)

```
SET      (P1).3          ; P13 output latch ← 1
LD       (P1CR), 00001000B ; Configures P13 as an output mode
LD       (TBTCCR), 10000000B ; DVOEN ← 1, DVOCK ← 00
```

Table 2-2. Frequency of Divider Output

DVOCK	Frequency of Divider Output	At $f_c = 4.194304$ MHz	At $f_c = 8$ MHz	At $f_s = 32.768$ kHz
00	$f_c/2^{13}$ or $f_s/2^5$	0.512 [kHz]	0.976 [kHz]	1.024 [kHz]
01	$f_c/2^{12}$ or $f_s/2^4$	1.024	1.953	2.048
10	$f_c/2^{11}$ or $f_s/2^3$	2.048	3.906	4.096
11	$f_c/2^{10}$ or $f_s/2^2$	4.096	7.812	8.192

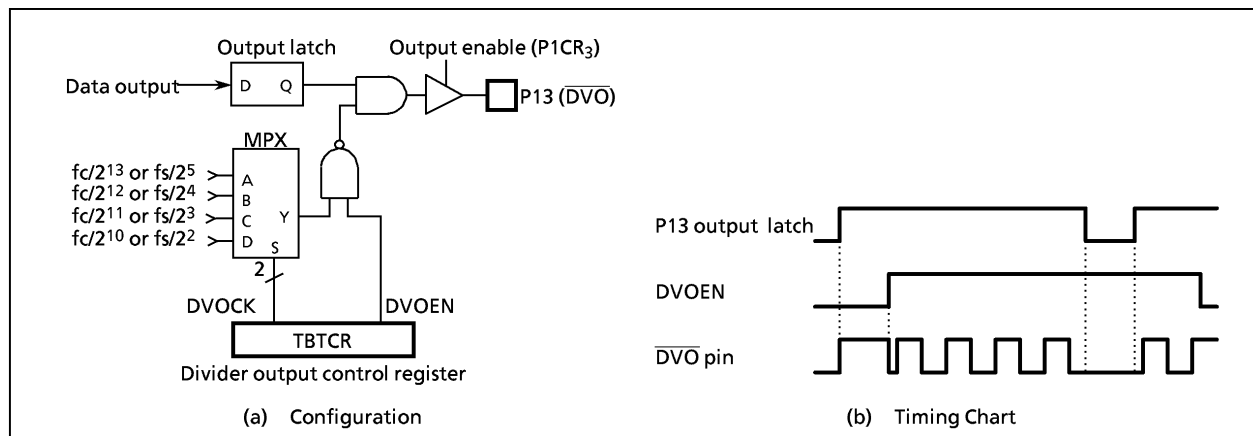


Figure 2-13. Divider Output

2.5 16-Bit Timer/Counter 1 (TC1)

2.5.1 Configuration

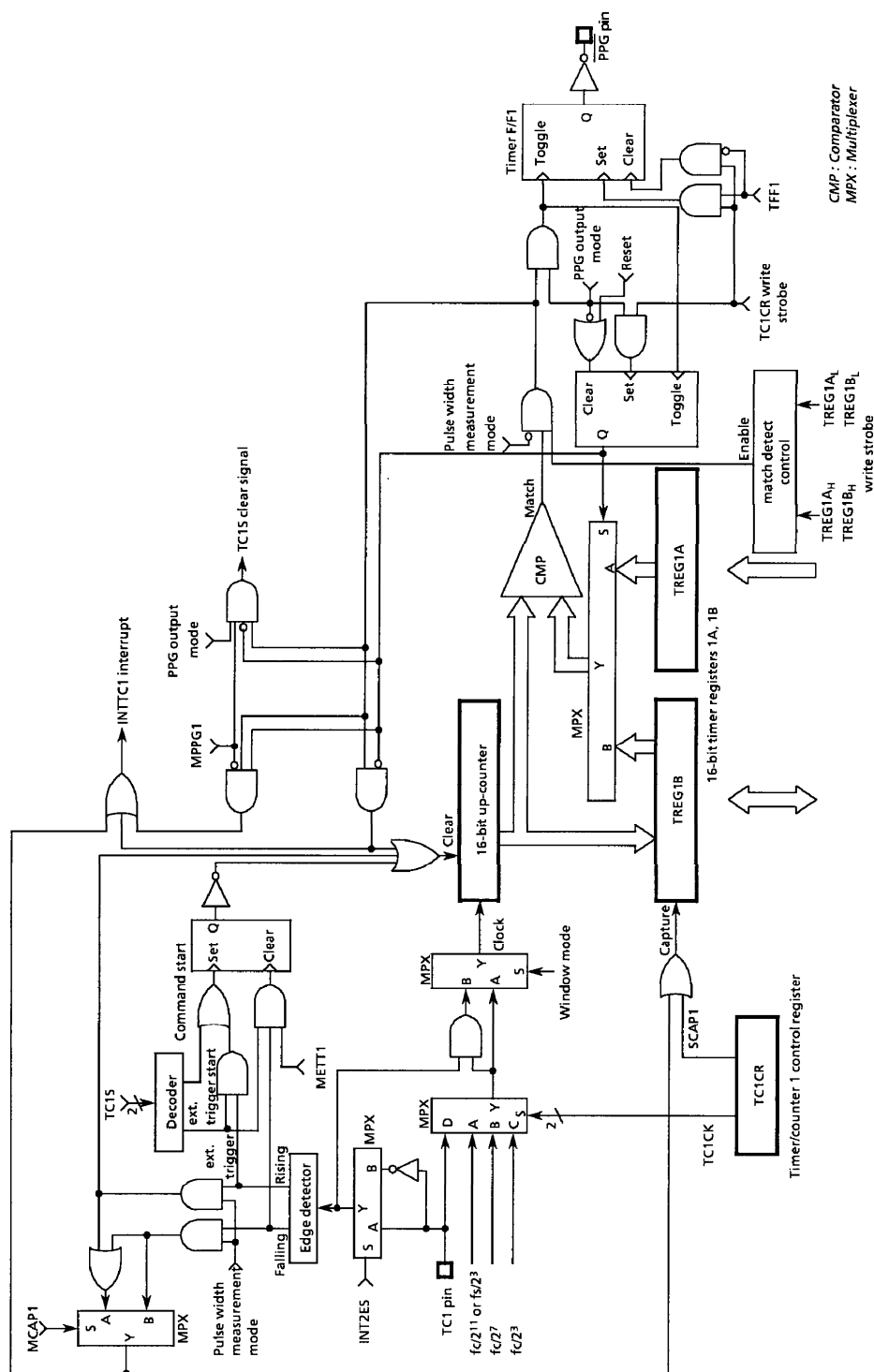


Figure 2-14. Timer/Counter 1

2.5.2 Control

The timer/counter 1 is controlled by a timer/counter 1 control register (TC1CR) and two 16-bit timer registers (TREG1A and TREG1B). Reset does not affect TREG1A and TREG1B.

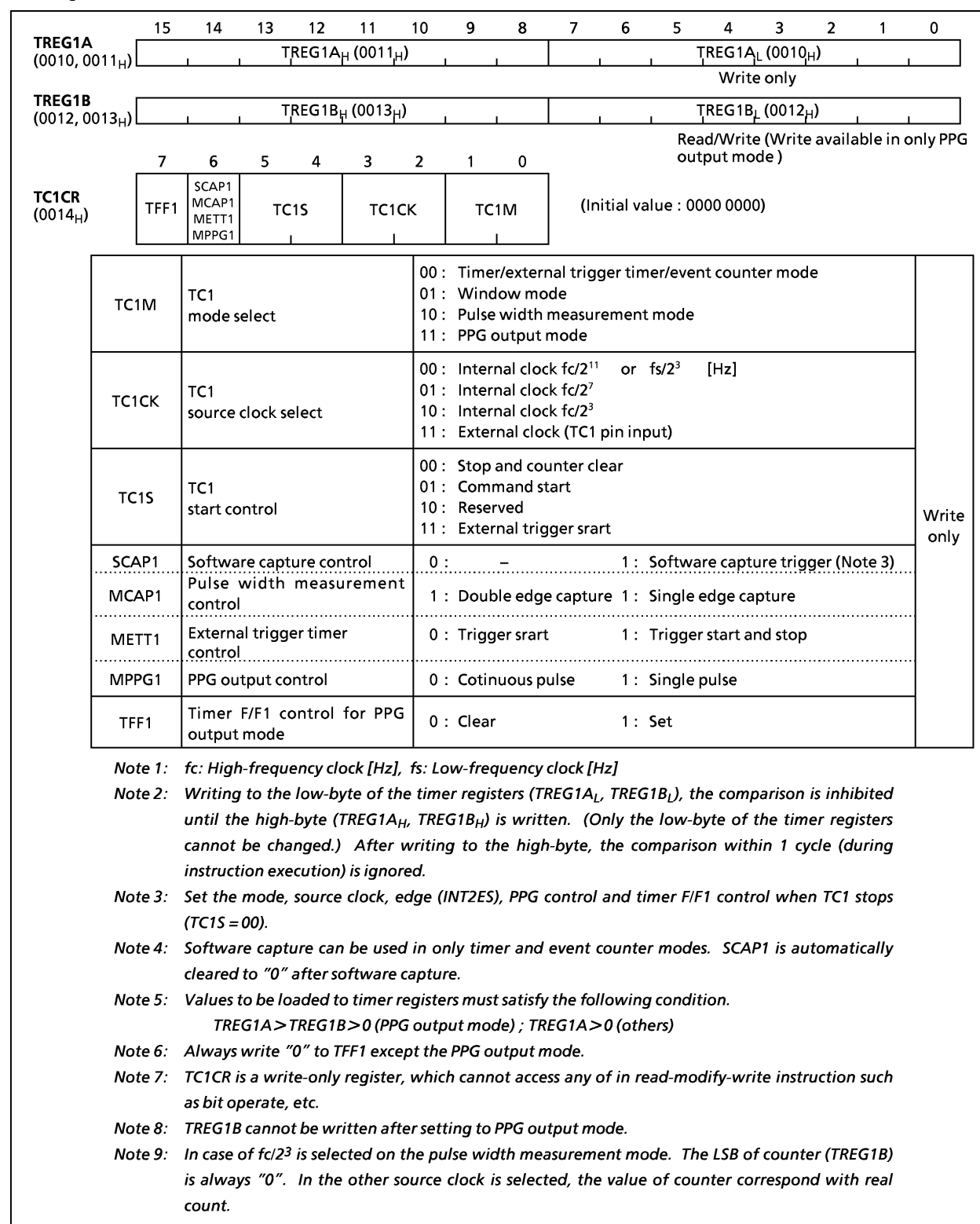


Figure 2-15. Timer Registers and TC1 Control Register

2.5.3 Function

Timer/counter 1 has six operating modes: timer, external trigger timer, event counter, window, pulse width measurement, programmable pulse generator output mode.

(1) Timer Mode

In this mode, counting up is performed using the internal clock. The contents of TREG1A are compared with the contents of up-counter. If a match is found, an INTTC1 interrupt is generated, and the counter is cleared to "0". Counting up resumes after the counter is cleared. The current contents of up-counter can be transferred to TREG1B by setting SCAP1 (bit 6 in TC1CR) to "1" (software capture function). SCAP1 is automatically cleared to "0" after capturing.

Table 2-3. Timer/Counter 1 Source Clock (Internal Clock)

Source clock			Resolution		Maximum time setting	
NORMAL 1/2, IDLE 1/2 modes		SLOW, SLEEP modes				
DV7CK = 0	DV7CK = 1		At $f_c = 8 \text{ MHz}$	At $f_s = 32.768 \text{ kHz}$	At $f_c = 8 \text{ MHz}$	At $f_s = 32.768 \text{ kHz}$
$f_c/2^{11} [\text{Hz}]$	$f_s/2^3 [\text{Hz}]$	$f_s/2^3 [\text{Hz}]$	$256 \mu\text{s}$	$244.14 \mu\text{s}$	16.8 s	16.0 s
$f_c/2^7$	$f_c/2^7$	—	$16 \mu\text{s}$	—	1.0 s	—
$f_c/2^3$	$f_c/2^3$	—	$1 \mu\text{s}$	—	65.5 ms	—

Example 1 : Sets the timer mode with source clock $f_s/2^3[\text{Hz}]$ and generates an interrupt 1 s. later (at $f_s = 32.768 \text{ kHz}$).

```
LD      (TC1CR), 00000000B      ; Sets the TC1 mode and source clock
LDW     (TREG1A), 1000H         ; Sets the timer register ( $1 \text{ s} \div 2^3/f_s = 1000_{\text{H}}$ )
SET     (EIRL).EF4             ; enable INTTC1
EI
LD      (TC1CR), 00010000B      ; Starts TC1
```

Note : TC1CR is a write-only register, which cannot start by [SET(TC1CR).4] instruction.

Example 2 : Software capture

```
LD      (TC1CR), 01010000B      ; SCAP1 ← 1 (Captures)
LD      WA, (TREG1B)            ; Reads captured value
```

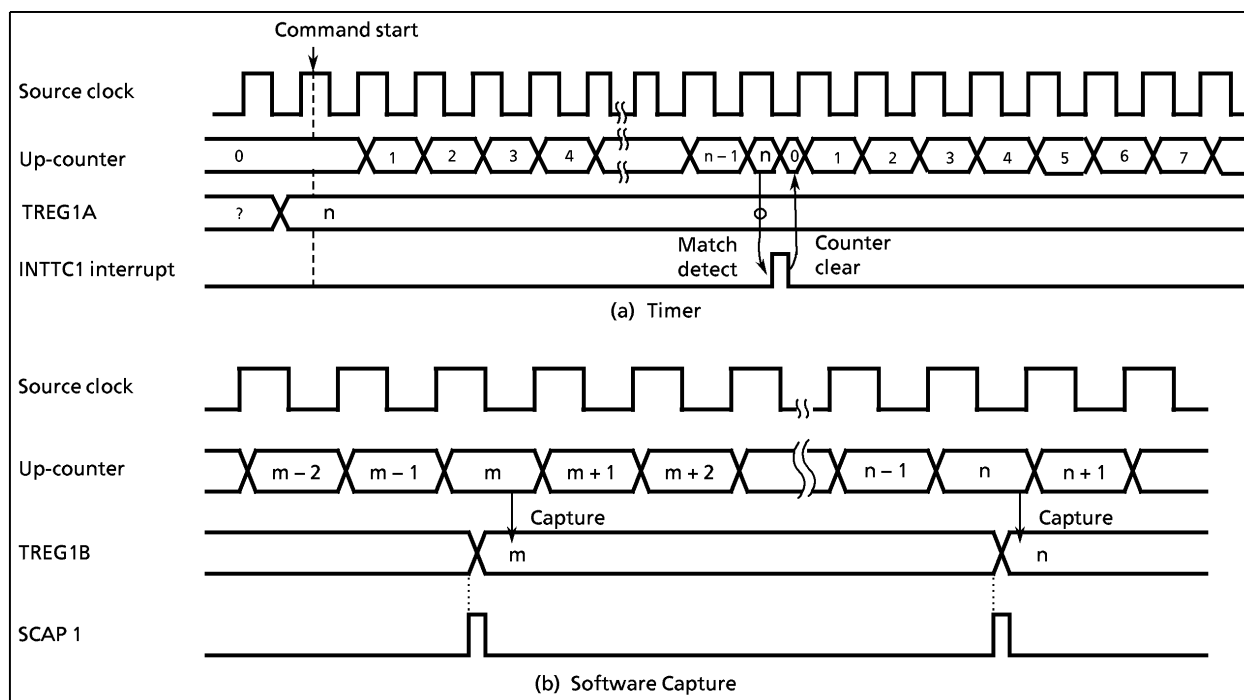


Figure 2-16. Timer Mode Timing Chart

(2) External Trigger Timer mode

In this mode, counting up is started by an external trigger. This trigger is the edge of the TC1 pin input. Either the rising or falling edge can be selected. Edge selection is the same as for the external interrupt input INT2 pin. Source clock is used an internal clock selected. The contents of TREG1A is compared with the contents of up-counter. If a match is found, an INTTC1 interrupt is generated, and the counter is cleared to "0" and halted. The counter is restarted by the selected edge of the TC1 pin input.

When the edge input is opposite to the edge input way of the count start trigger at METTI (bit 6 in TC1CR) = 1, the counter is cleared, and count stops. In this mode, pulse input with a constant pulse width generates interrupt. When METTI is "0", the opposite edge input is ignored. The edge of TC1 pin input before match detection is also ignored.

The TC1 pin input has the same noise rejection as the INT2 pin; therefore, pulses of $7/f_c$ [s] or less are rejected as noise. A pulse width of $24/f_c$ [s] or more is required for edge detection in NORMAL1/2 or IDLE1/2 mode. The noise rejection circuit is turned off in SLOW and SLEEP modes. But, a pulse width of $4/f_s$ [s] or more is required.

Example 1 : Generates interrupt after $100 \mu\text{s}$ from TC1 pin input rising edge (at $f_c = 8 \text{ MHz}$).

```
LD      (EINTCR), 00000000B      ; INT2ES←0 (rising edge)
LDW     (TREG1A), 0064H           ;  $100 \mu\text{s} \div 2^3/f_c = 64_H$ 
SET     (EIRL).EF4               ; Enables INTTC1 interrupt
EI
```

```
LD      (TC1CR), 00111000B       ; Starts TC1 external trigger, METT = 0
```

Example 2 : When "L" level pulses of 4ms or more is input to TC1 pin, generates interrupt.

(at $f_c = 8 \text{ MHz}$)

```
LD      (EINTCR), 00000100B      ; INT2ES←1 ("L" level)
LDW     (TREG1A), 00FAH           ;  $4 \text{ ms} \div 2^7/f_c = FA_H$ 
SET     (EIRL).EF4               ; Enables INTTC1 interrupt
EI
```

```
LD      (TC1CR), 01110100B       ; Starts TC1 external trigger, METT = 1
```

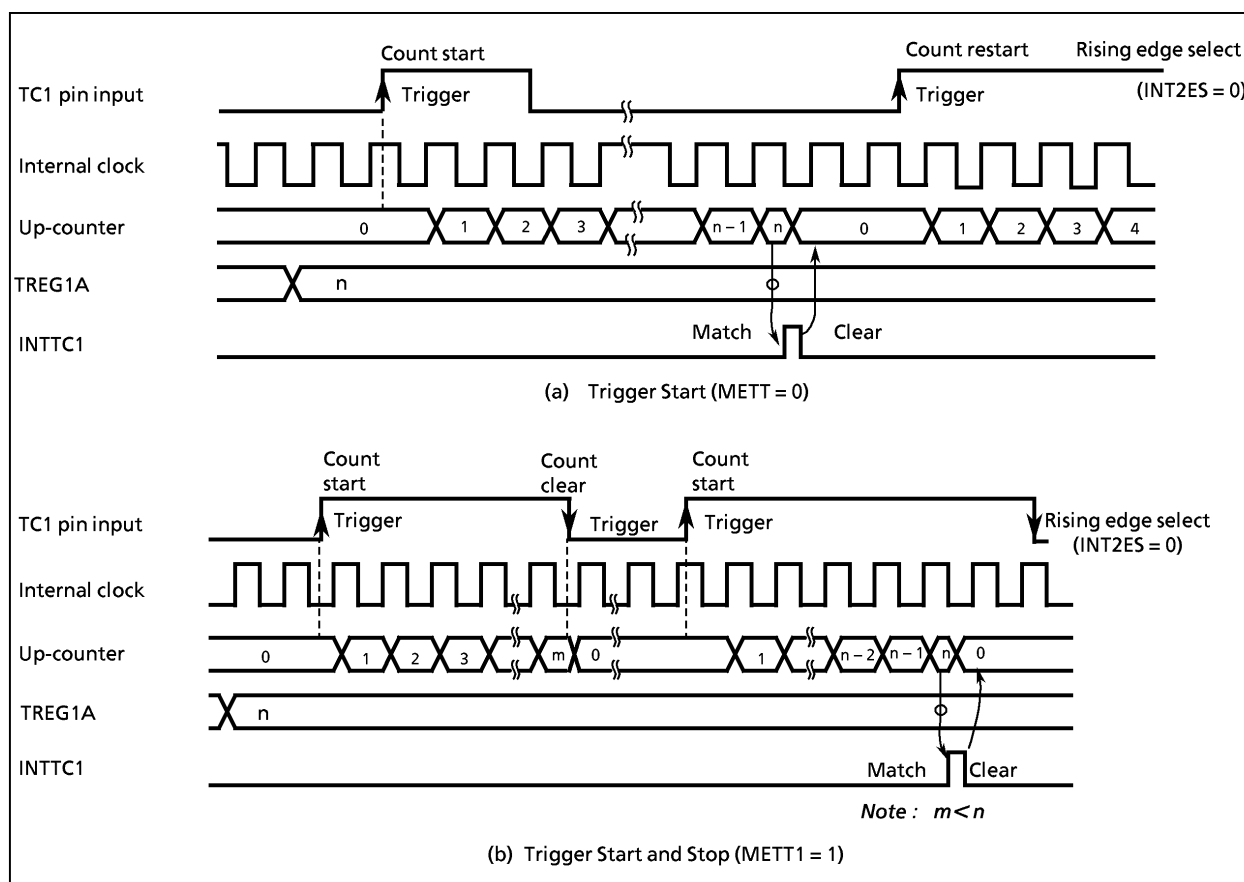


Figure 2-17. External Trigger Timer Mode Timing Chart

(3) Event Counter Mode

In this mode, events are counted on the edge of the TC1 pin input. Either the rising or falling edge can be selected with INT2ES in EINTCR. The contents of TREG1A are compared with the contents of up-counter. If a match is found, an INTTC1 interrupt is generated, and the counter is cleared. Counting up resumes after the counter is cleared. The maximum applied frequency is $f_c/24$ [Hz] in NORMAL1/2 or IDLE1/2 mode and $f_s/24$ [Hz] in SLOW or SLEEP mode.

Setting SCAP1 to "1" transfers the current contents of up-counter to TREG1B (software capture function). SCAP is automatically cleared after capturing.

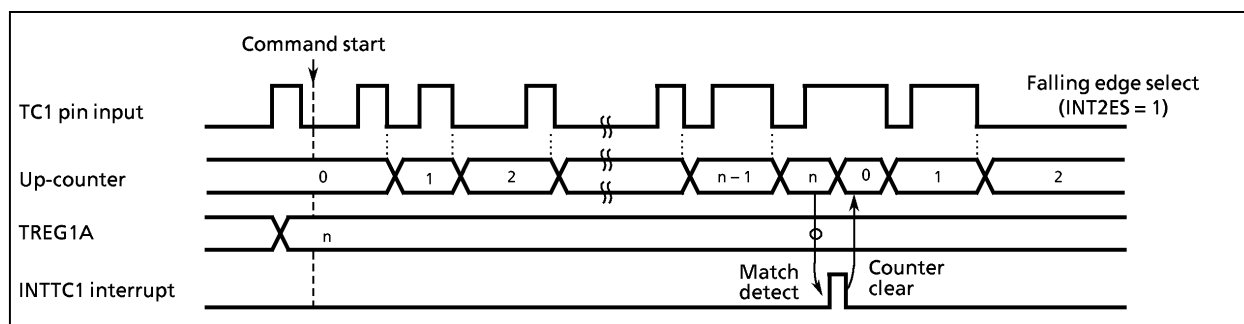


Figure 2-18. Event Counter Mode Timing Chart (INT2ES = 1)

(4) Window mode

Counting up is performed on the rising edge of the pulse that is the logical AND-ed product of the TC1 pin input (window pulse) and an internal clock. The contents of TREG1A are compared with the contents of up-counter. If a match is found, an INTTC1 interrupt is generated, and the counter is cleared. Positive or negative logic for the TC1 pin input can be selected with INT2ES. Setting SCAP1 to "1" transfers the current contents of up-counter to TREG1B. It is necessary that the maximum applied frequency (TC1 input) be such that the counter value can be analyzed by the program. That is, the frequency must be considerably slower than the selected internal clock.

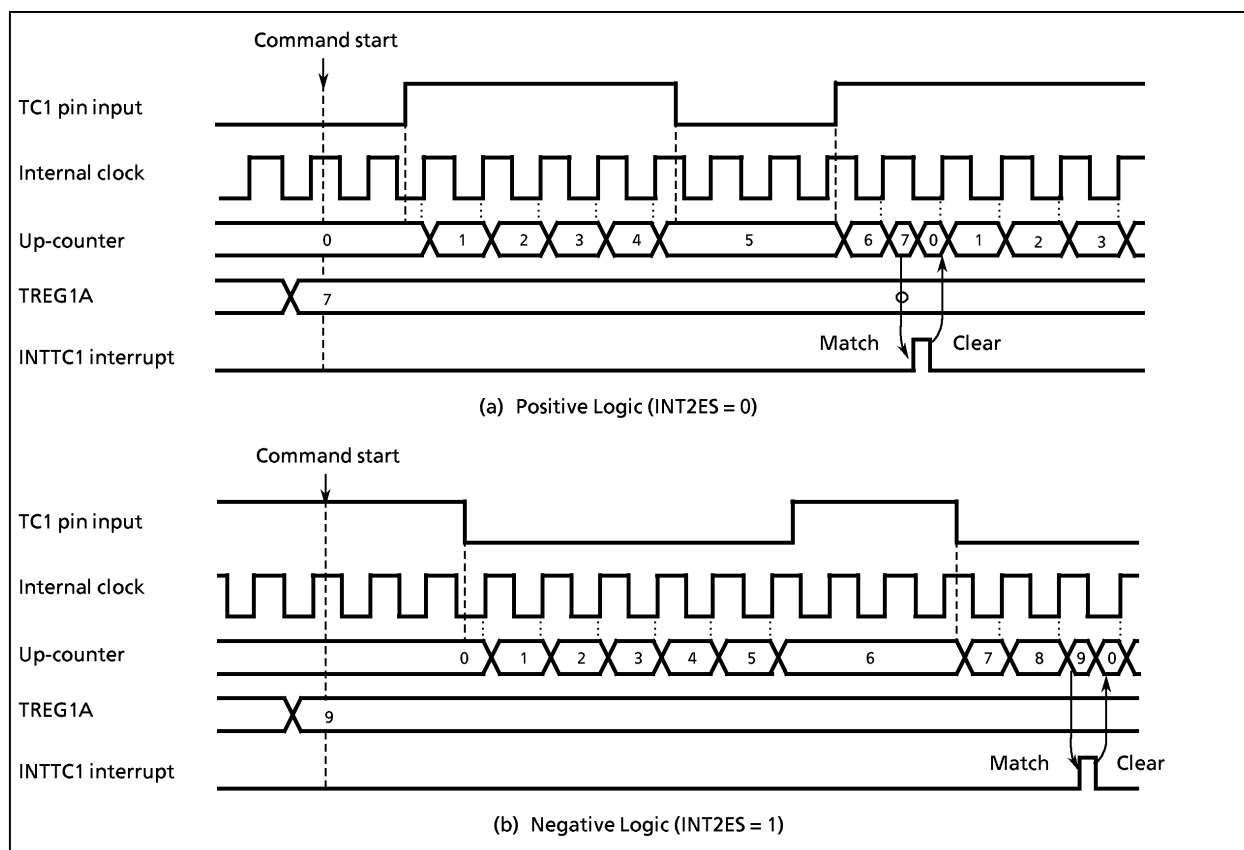


Figure 2-19. Window Mode Timing Chart

(5) Pulse width measurement mode

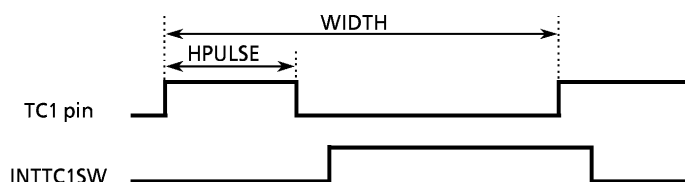
Counting is started by the external trigger (set to external trigger start by TC1S). The trigger can be selected either the rising or falling edge of the TC1 pin input. The source clock is used an internal clock. On the next falling (rising) edge, the counter contents are transferred to TREG1B and an INTTC1 interrupt is generated. The counter is cleared when the single edge capture mode is set. When double edge capture is set, the counter continues and, at the next rising (falling) edge, the counter contents are again transferred to TREG1B. If a falling (rising) edge capture value is required, it is necessary to read out TREG1B contents until a rising (falling) edge is detected. Falling or rising edge is selected with INT2ES, and single edge or double edge is selected with MCAP1 (bit 6 in TC1CR).

Example : Duty measurement (Resolution $f_c/2^7$ [Hz])

```

CLR    (INTTC1SW). 0           ; INTTC1 service switch initial setting
LD     (EINTCR), 00000000B     ; Sets the rise edge at the INT2 edge
LD     (TC1CR), 00000110B      ; Sets the TC1 mode and source clock
SET    (EIRL). 4               ; Enables INTTC1
EI
LD     (TC1CR), 00110110B      ; Starts TC1 with an external trigger
:
PINTTC1: CPL    (INTTC1SW). 0   ; Complements INTTC1 service switch
JRS    F, SINTTC1
LD     (HPULSE), (TREG1BL)      ; Reads TREG1B
LD     (HPULSE + 1), (TREG1BH)
RETI
SINTTC1: LD     (WIDTH), (TREG1BL) ; Reads TREG1B (Period)
LD     (WIDTH + 1), (TREG1BH)
:
RETI
:
VINTTC1: DW     PINTTC1

```



Note : In case of $f_c/2^3$ is selected on the pulse width measurement mode. The LSB of counter (TREG1B) is always "0". In the other source clock is selected, the value of counter correspond with real count.

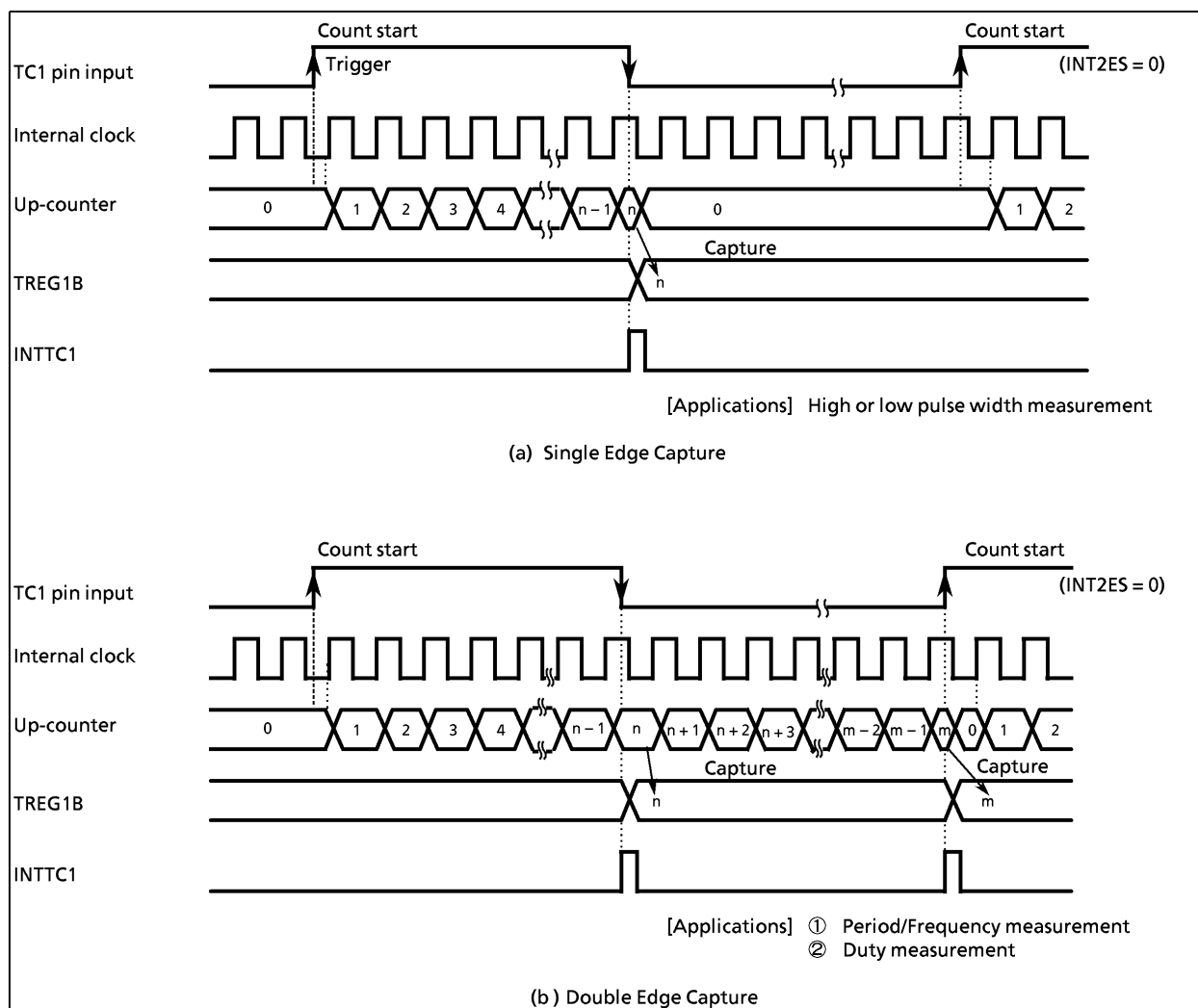


Figure 2-20. Pulse Width Measurement Mode Timing Chart

(6) Programmable Pulse Generate (PPG) output mode

Counting is started by an edge of the TC1 pin input (either the rising or falling edge can be selected) or by a command. The source clock is used an internal clock. First, the contents of TREG1B are compared with the contents of the up-counter. If a match is found, timer F/F1 output is toggled. Next, timer F/F1 is again toggled and the counter is cleared by matching with TREG1A. An INTTC1 interrupt is generated at this time. Timer F/F output is connected to the P14 (PPG) pin. In the case of $\overline{\text{PPG}}$ output, set the P14 output latch to "1" and configure as an output with P1CR₄. Timer F/F1 is cleared to "0" during reset. The timer F/F1 value can also be set by program and either a positive or negative logic pulse output is available. Also, writing to the TREG1B is not possible unless the timer/counter 1 is set to the PPG output mode.

Example : "H" level 800 μs , "L" level 200 μs pulse output at $f_c = 8 \text{ MHz}$

```

SET   (P1).4           ; P14 output latch←1
LD    (P1CR), 00010000B ; Sets P14 to an output mode
LD    (TC1CR), 10001011B ; Sets PPG output mode
LDW   (TREG1A), 03E8H    ; Sets a period ( $1 \text{ ms} \div 1 \mu\text{s} = 03\text{E}8_{\text{H}}$ )
LDW   (TREG1B), 00C8H    ; Sets "L" level pulse width ( $200 \mu\text{s} \div 1 \mu\text{s} = 00\text{C}8_{\text{H}}$ )
LD    (TC1CR), 10010011B ; Start

```

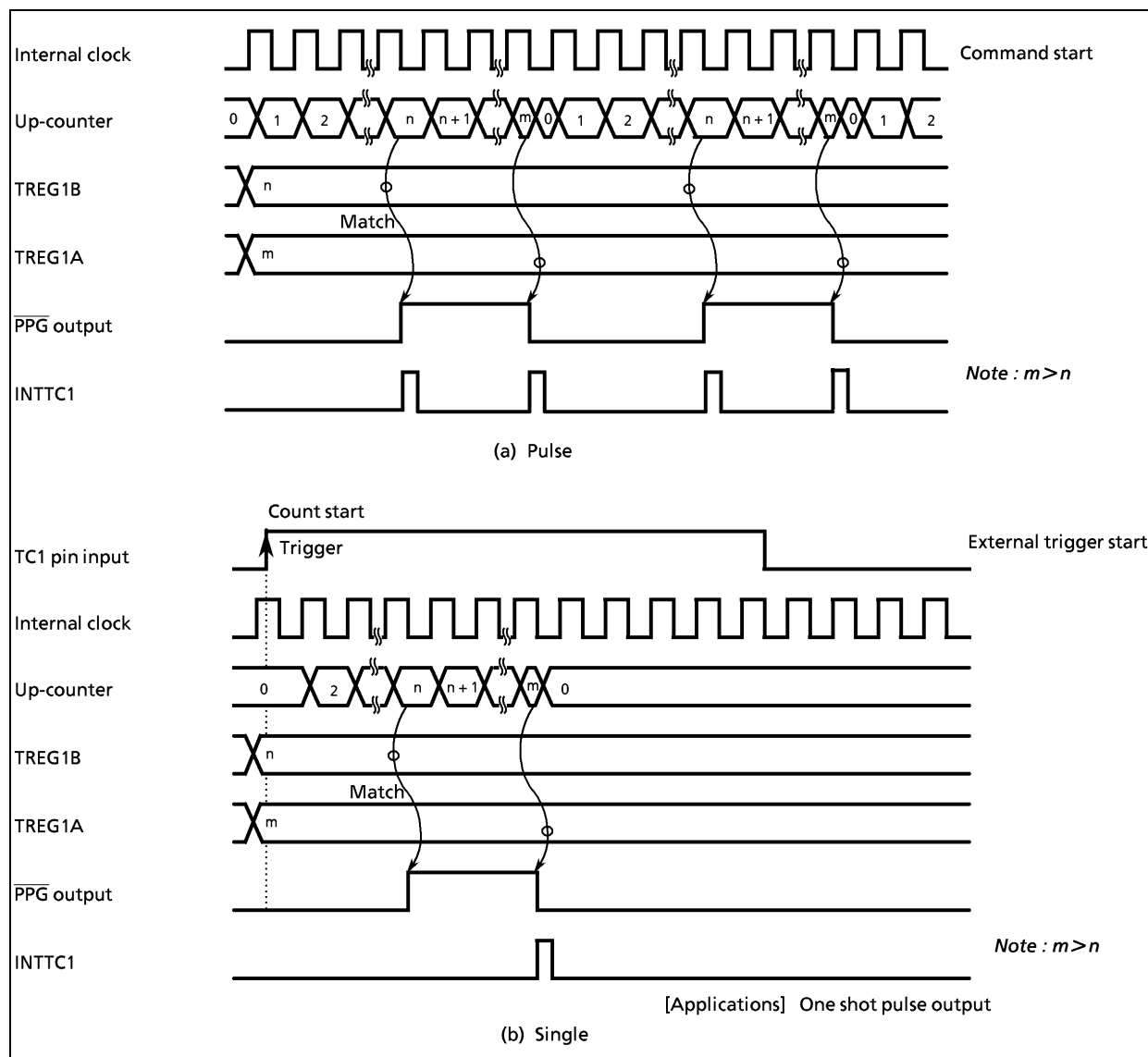



Figure 2-21. PPG Output Mode Timing Chart

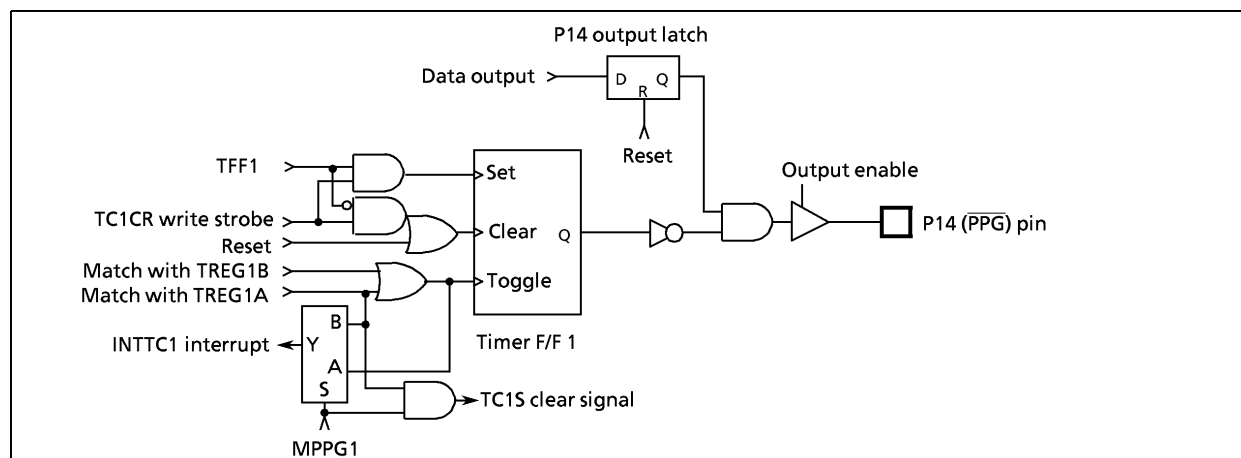


Figure 2-22. PPG Output

2.6 16-Bit Timer/Counter 2 (TC2)

2.6.1 Configuration

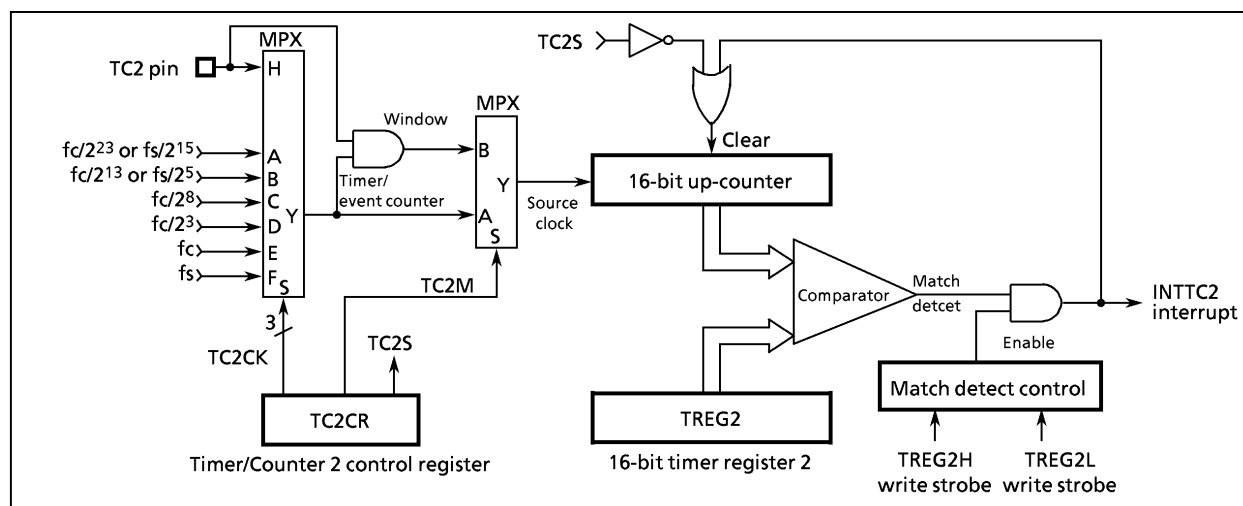


Figure 2-23. Timer/Counter 2 (TC2)

2.6.2 Control

The timer/counter 2 is controlled by a timer/counter 2 control register (TC2CR) and a 16-bit timer register 2 (TREG2). Reset does not affect TREG2.

TREG2
(0016, 0017_H)

15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0

TREG2_H (0017_H)

TREG2_L (0016_H)

write only

TC2CR
(0015_H)

7 6 5 4 3 2 1 0

TC2S

TC2CK

TC2M

(Initial value : **00 00*0)

TC2M	Timer/counter 2 operating mode select	0 : Timer/Event counter mode 1 : Window mode	Write only
TC2CK	Timer/counter 2 source clock select	000 : Internal clock $fc/2^{23}$ or $fs/2^{15}$ [Hz] 001 : Internal clock $fc/2^{13}$ or $fs/2^5$ 010 : Internal clock $fc/2^8$ 011 : Internal clock $fc/2^3$ 100 : Internal clock fc (Note 5) 101 : Internal clock fs 110 : Reserved 111 : External clock (TC2 pin input)	
TC2S	Timer/counter 2 start control	0 : Stop and counter clear 1 : Start	

Note 1: fc : High-frequency clock [Hz], fs : Low-frequency clock [Hz], *: Don't care

Note 2: When writing to the low-byte of timer register 2 (TREG2_L), the comparison is inhibited until the high-byte (TREG2_H) is written.

After writing to the high-byte, any match during 1 machine cycle (instruction execution cycle) is ignored.

Note 3: Set the mode and source clock when timer/counter stops (TC2S = 0).

Note 4: Values to be loaded to the timer register must satisfy the following condition.

$TREG2 > 0$ (TREG2₁₅ to TREG2₁₁ > 0 when warm-up).

Note 5: " fc " can be selected as the source clock only in the timer mode during the SLOW mode.

Note 6: TC2CR and TREG2 are write-only registers and must not be used with any of the read-modify-write instructions.

Figure 2-24. Timer Register 2 and TC2 Control Register

2.6.3 Function

The timer/counter 2 has three operating modes: timer, event counter and window modes. Also timer/counter 2 is used for warm-up when switching from SLOW mode to NORMAL2 mode.

(1) Timer Mode

In this mode, the internal clock is used for counting up. The contents of TREG2 are compared with the contents of up-counter. If a match is found, a timer/ counter 2 interrupt (INTTC2) is generated, and the counter is cleared. Counting up is resumed after the counter is cleared.

Also, when f_c is selected as the source clock during SLOW mode, the lower 11 bits of TREG2 are ignored and an INTTC2 interrupt is generated by matching the upper 5 bits. Thus, in this case, only the TREG2_H setting is necessary.

Table 2-4. Source Clock (Internal Clock) for Timer/Counter 2

Source clock				Resolution		Maximum time setting	
NORMAL1/2, IDLE1/2 mode		SLOW mode	SLEEP mode				
DV7CK = 0	DV7CK = 1			At $f_c = 8$ MHz	At $f_s = 32.768$ kHz	At $f_c = 8$ MHz	At $f_s = 32.768$ kHz
$f_c/2^{23}$ [Hz]	$f_s/2^{15}$ [Hz]	$f_s/2^{15}$ [Hz]	$f_s/2^{15}$ [Hz]	1.05 [s]	1 [s]	19.1 [h]	18.2 [h]
$f_c/2^{13}$	$f_s/2^5$	$f_s/2^5$	$f_s/2^5$	1.02 [ms]	1 [ms]	1.1 [m]	1 [m]
$f_c/2^8$	$f_c/2^8$	—	—	32 [μ s]	—	2.1 [s]	—
$f_c/2^3$	$f_c/2^3$	—	—	1 [μ s]	—	65.5 [ms]	—
—	—	f_c (Note)	—	125 [ns]	—	7.936 [ms]	—
f_s	f_s	—	—	—	30.5 [μ s]	—	2 [s]

Note : " f_c " can be used only in the timer mode. This is used for warm up when switching from SLOW mode to NORMAL2 mode.

Example : Sets the timer mode with source clock $f_c/2^3$ [Hz] and generates an interrupt every 25ms (at $f_c = 8$ MHz).

```
LD      (TC2CR), 00001100B      ; Sets the TC2 mode and source clock
LDW     (TREG2), 61A8H          ; Sets TREG2 (25 ms ÷ 23/fc = 61A8H)
SET     (EIRH).EF14             ; Enable INTTC2
EI
LD      (TC2CR), 00101100B      ; Starts TC2
```

(2) Event Counter Mode

In this mode, events are counted on the rising edge of the TC2 pin input. The contents of TREG2 are compared with the contents of the up-counter. If a match is found, an INTTC2 interrupt is generated, and the counter is cleared. The maximum frequency applied to the TC2 pin is $f_c/2^4$ [Hz] in NORMAL1/2 or IDLE1/2 mode, and $f_s/2^4$ [Hz] in SLOW or SLEEP mode. But, a pulse width of 2 machine cycles or more is required for both "H" and "L" level.

Example : Sets the event counter mode and generates an INTTC2 interrupt 640 counts later.

```
LD      (TC2CR), 00011100B      ; Sets the TC2 mode
LDW     (TREG2), 640             ; Sets TREG2
SET     (EIRH).EF14             ; Enable INTTC2
EI
LD      (TC2CR), 00111100B      ; Starts TC2
```

(3) Window Mode

In this mode, counting up is performed on the rising edge of the pulse that is the logical AND-ed product of the TC2 pin input (window pulse) and an internal clock. The internal clock is selected with TC2CK. The contents of TREG2 are compared with the contents of up-counter. If a match is found, an INTTC2 interrupt is generated, and the up-counter is cleared to "0". It is necessary that the maximum applied frequency (TC2 input) be such that the counter value can be analyzed by the program. That is, the frequency must be considerably slower than the selected internal clock.

Example : Inputs "H" level pulse of 120 ms or more and generates interrupt. (at $f_c = 8 \text{ MHz}$).

```
LD      (TC2CR), 00000101B      ; Sets TC2 mode and source clock.
LDW     (TREG2), 0078H          ; Sets TREG2 ( $120 \text{ ms} \div 2^{13}/f_c = 0078_H$ )
SET     (EIRH).EF14            ; Enables INTTC2 interrupt
EI
LD      (TC2CR), 00100101B      ; Starts TC2
```

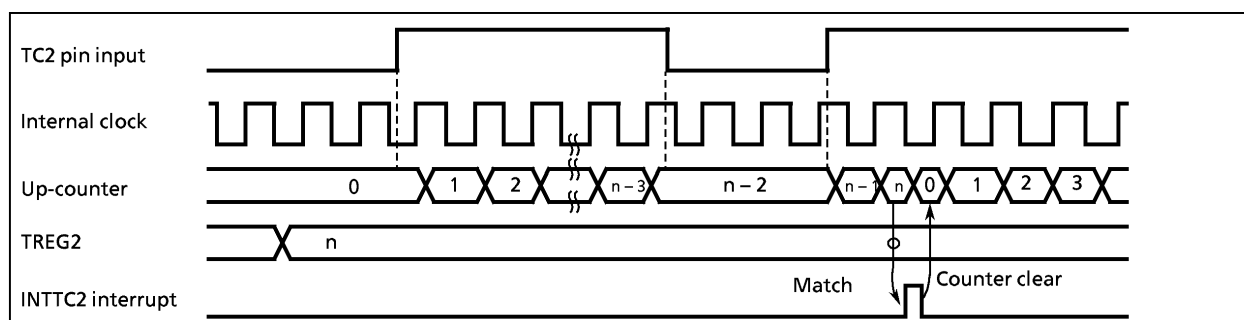


Figure 2-25. Window Mode Timing Chart

2.7 8-Bit Timer/Counter 3 (TC3)

2.7.1 Configuration

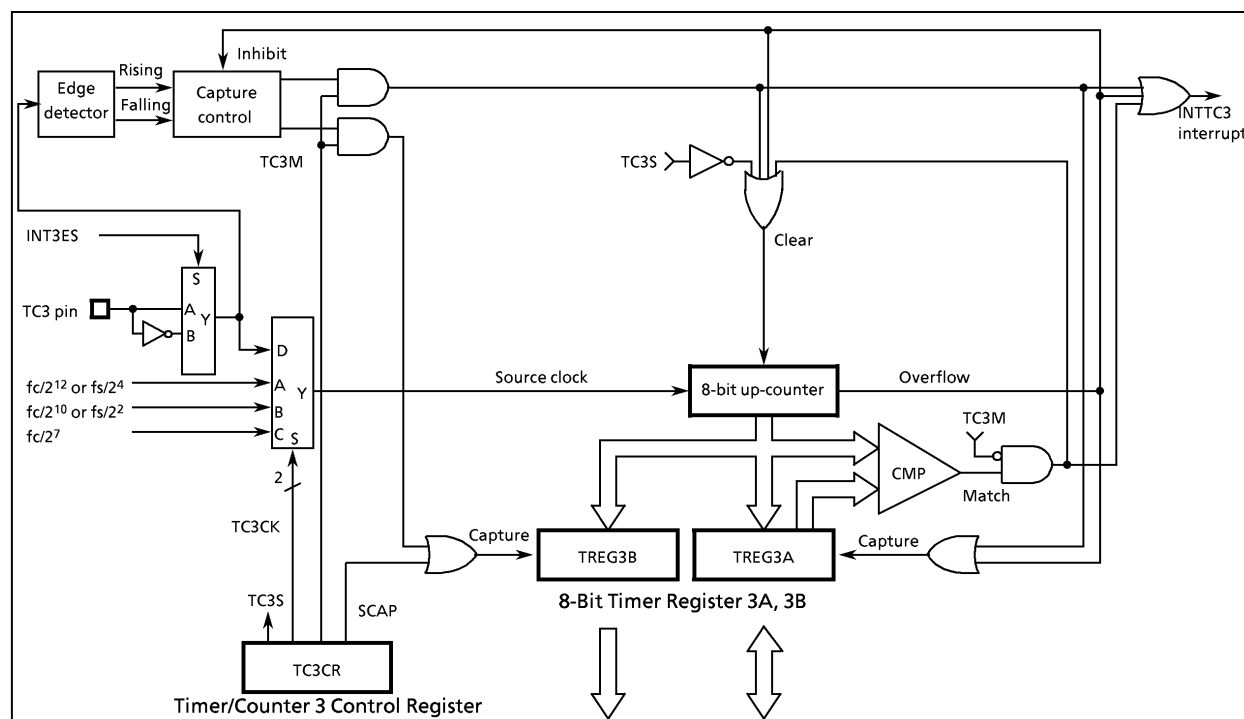


Figure 2-26. Timer/Counter 3

2.7.2 Control

The timer/counter 3 is controlled by a timer/counter 3 control register (TC3CR) and two 8-bit timer registers (TREG3A and TREG3B). Reset does not affect these timer registers.

TREG3A (0018 _H)	7	6	5	4	3	2	1	0	Read/Write
TREG3B (0019 _H)									Read only
TC3CR (001A _H)	7	6	5	4	3	2	1	0	(Initial value : *0*0 00*0)
	SCAP		TC3S		TC3CK		TC3M		

TC3M	Timer/counter 3 operation mode set	0 : Timer/event counter 1 : Capture	Write only
TC3CK	Timer/counter 3 source clock select	00 : Internal clock $fc/2^{12}$ or $fs/2^4$ [Hz] 01 : Internal clock $fc/2^{10}$ or $fs/2^2$ 10 : Internal clock $fc/2^7$ 11 : External clock (TC3 pin input)	
TC3S	Timer/counter 3 start select	0 : Stop and clear 1 : Start	
SCAP	Software capture control	0 : – 1 : Software capture	

Note 1: fc : High-frequency clock [Hz] fs : Low-frequency clock [Hz] *: Don't care
 Note 2: Set the mode, the source clock and the edge selection (INT3ES) when the TC3 stops (TC3S = 0).
 Note 3: Values to be loaded into timer register 3A must satisfy the following condition.
 $TREG3A > 0$ (in the timer/event counter mode)
 Note 4: Software capture can be used in only timer and event counter mode.
 Note 5: TC3CR is a write-only register, which cannot access any of in read-modify-write instruction such as bit operate, etc.

Figure 2-27. Timer Register 3A/3B and TC3 Control Register

2.7.3 Function

The timer/counter 3 has three operating modes : timer, event counter, and capture mode.

(1) Timer Mode

In this mode, the internal clock is used for counting up. The contents of TREG3A are compared with the contents of up-counter. If a match is found, a timer/counter 3 interrupt (INTTC3) is generated, and the up-counter is cleared. Counting up resumes after the up-counter is cleared. The current contents of up-counter are loaded into TREG3B by setting SCAP (bit 6 in TC3CR) to "1". SCAP is automatically cleared after capturing.

Table 2-5. Source Clock (Internal Clock) for Timer Counter 3

Source clock			Resolution		Maximum time setting	
NORMAL1/2, IDLE1/2 mode		SLOW, SLEEP mode				
DV7CK = 0	DV7CK = 1		At $fc = 8$ MHz	At $fs = 32.768$ kHz	At $fc = 8$ MHz	At $fs = 32.768$ kHz
$fc/2^{12}$	$fs/2^4$ [Hz]	$fs/2^4$ [Hz]	512 μs	488.28 μs	130.6 ms	124.5 ms
$fc/2^{10}$	$fs/2^2$	–	128 μs	122.07 μs	32.6 ms	31.1 ms
$fc/2^7$	$fc/2^7$	–	16 μs	–	4.1 ms	–

(2) Event Counter Mode

In this mode, the TC3 pin input pulses are used for counting up. Either the rising or falling edge can be selected with INT3ES (bit 3 in EINTCR). The contents of TREG3A are compared with the contents of the up-counter. If a match is found, an INTTC3 interrupt is generated and the counter is cleared. The maximum applied frequency is $f_c/2^4$ [Hz] in the NORMAL1/2 or IDLE1/2 mode, and $f_s/2^4$ [Hz] in SLOW or SLEEP mode. Two or more machine cycles are required for both the "H" and "L" levels of the pulse width.

The current contents of up-counter are loaded into TREG3B by setting SCAP (bit 6 in TC3CR) to "1". SCAP is automatically cleared after capturing.

Example : Generates an interrupt every 0.5 s, inputting 50Hz pulses to the TC3 pin.

```
LD (TC3CR), 00001100B ; Sets TC3 mode and source clock
LD (TREG3A), 19H      ;  $0.5\text{ s} \div 1/50 = 25 = 19_{\text{H}}$ 
LD (TC3CR), 00011100B ; Start TC3
```

(3) Capture Mode

The pulse width, period and duty of the TC3 pin input are measured in this mode, which can be used in decoding the remote control signals, etc. The counter is free running by the internal clock. On the rising (falling) edge of the TC3 pin input, the current contents of counter is loaded into TREG3A, then the up-counter is cleared and an INTTC3 interrupt is generated. On the falling (rising) edge of the TC3 pin input, the current contents of the counter is loaded into the TREG3B. In this case, counting continues. At the next rising (falling) edge of the TC3 pin input, the current contents of counter are loaded into TREG3A, then the counter is cleared again and an interrupt is generated. If the counter overflows before the edge is detected, FF_H is set to the TREG3A and an overflow interrupt (INTTC3) is generated. During interrupt processing, it can be determined whether or not there is an overflow by checking whether or not the TREG3A value is FF_H. Also, after an interrupt (capture to TREG3A, or overflow detection) is generated, capture and overflow detection are halted until TREG3A has been read out; however, the counter continues.

After TREG3A has been read out, capture and overflow detection are resumed, usually, TREG3B is read out first.

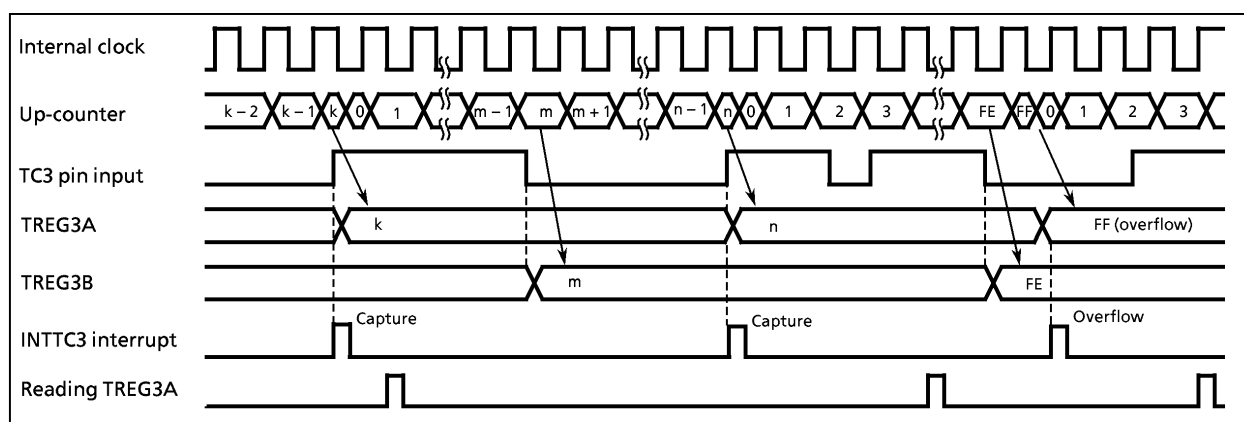


Figure 2-28. Timing Chart for Capture Mode (INT3ES = 0)

2.8 8-Bit Timer/Counter 5 (TC5)

2.8.1 Configuration

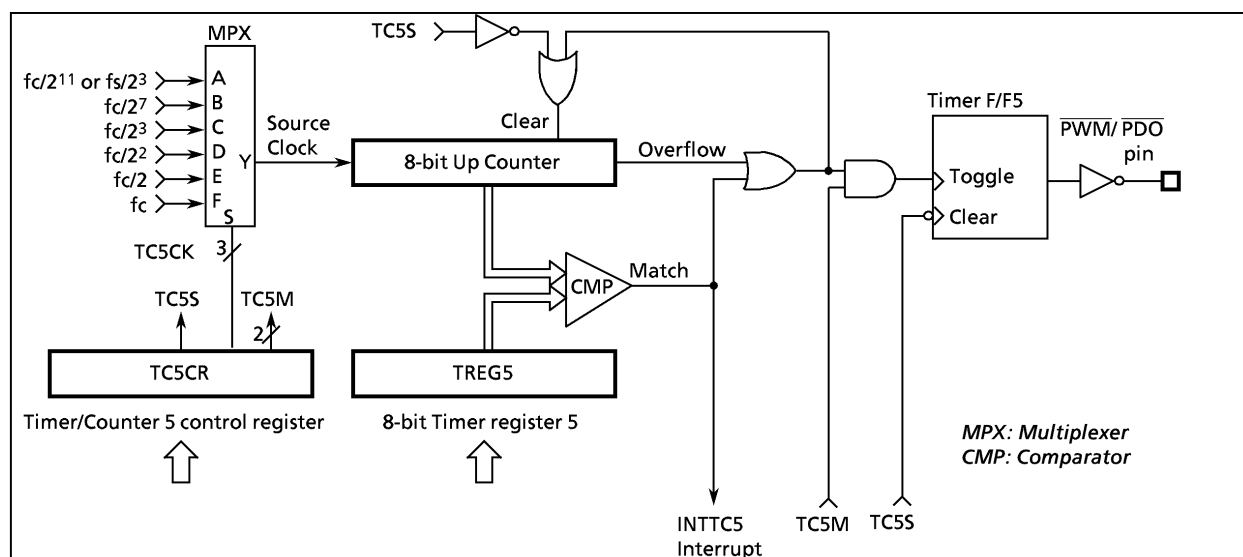


Figure 2-29. Timer/Counter 5 (TC5)

2.8.2 Control

The TC5 is controlled by a timer/counter 5 control register (TC5CR) and an 8-bit timer register 5 (TREG5).

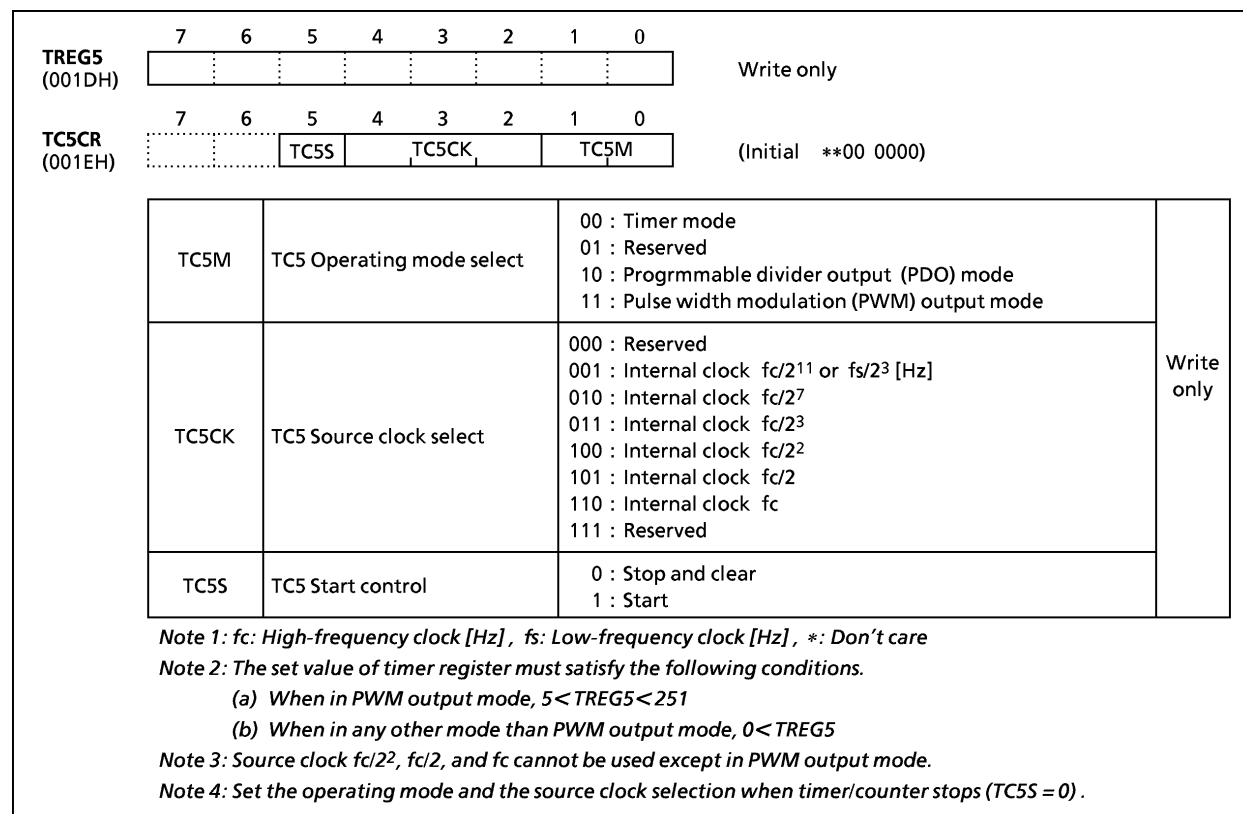


Figure 2-30. Timer/Counter 5 Timer register, Control register

2.8.3 Function

TC5 has 3 operating modes : timer, programmable divider output, and pulse width modulation output mode.

(1) Timer mode

In this mode, the internal clock is used for counting up. The contents of the timer register 5 (TREG5) is compared with the contents of the up-counter. Matching with TREG5 generates a timer/counter 5 interrupt (INTTC5) and clears the counter. Counting up resumes after the counter is cleared.

Table 2-6. Source Clock (Internal clock) for TC5

Source clock		SLOW, SLEEP mode	resolution		maximum setting time	
NORMAL1/2, IDLE1/2 mode			fc = 8 MHz	fs = 32.768 kHz	fc = 8 MHz	fs = 32.768 kHz
DV7CK = 0	DV7CK = 1					
fc/2 ¹¹ [Hz]	fs/2 ³ [Hz]	fs/2 ³ [Hz]	256 [μs]	244.14 [μs]	65.3 [ms]	62.3 [ms]
fc/2 ⁷	fc/2 ⁷	—	16 [μs]	—	4.1 [ms]	—
fc/2 ³	fc/2 ³	—	1 [μs]	—	255 [μs]	—

(2) Programmable divider output (PDO) mode

The internal clock is used for counting up. The contents of the TREG5 are compared with the contents of the up-counter. The timer F/F5 output is toggled and the counter is cleared each time a match is found. The timer F/F5 output is inverted and output to the \overline{PDO} (P41) pin. In the case of \overline{PDO} output, set the P41 output latch to "1" and configure as an output with P4CR1. This mode can be used for 50% duty pulse output. INTTC5 interrupt is generated each time the \overline{PDO} output is toggled.

Example : 1024 Hz pulse output (at $fc = 4.194304$ MHz)

```

SET  (P4).1          ; P41 output latch ← 1
LD   (TC5CR), 00001010B ; Sets to TC5 modes and source clock
LD   (TREG5), 10H      ;  $1/1024 \div 2^7 / fc \div 2 = 10_H$ 
LD   (TC5CR), 00101010B ; Starts TC5

```

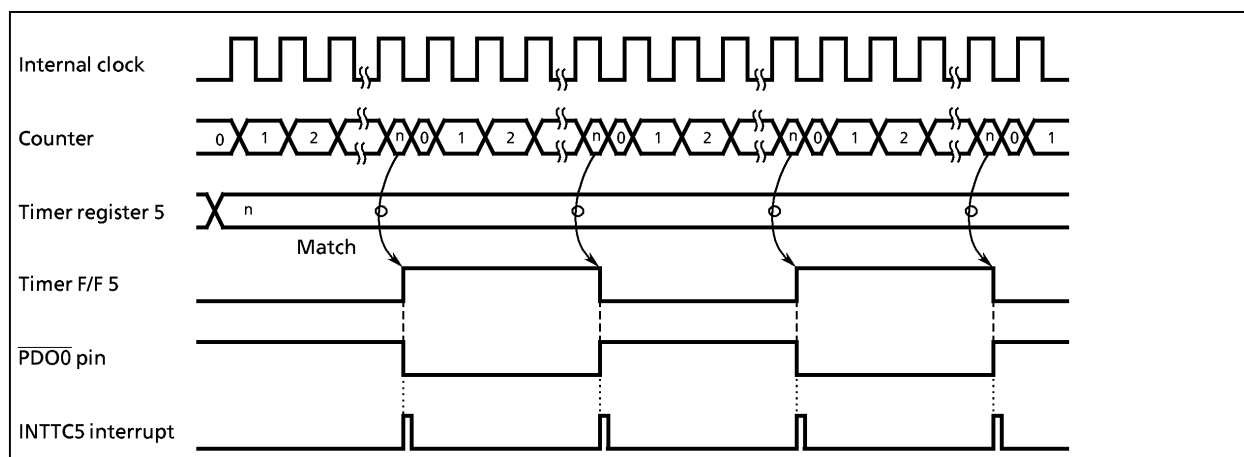


Figure 2-31. PDO Mode Timing Chart

(3) Pulse width modulation (PWM) output mode

PWM output with a resolution of 8-bits is possible. The internal clock is used for counting up. The contents of the TREG5 is compared with the contents of the up-counter. If a match is found, the timer F/F5 output is toggled. The counter continues counting and, when an overflow occurs, the timer F/F5 is again toggled and the counter is cleared. The timer F/F5 output is inverted and output to the $\overline{\text{PWM}}$ (P41) pin. In the case of $\overline{\text{PWM}}$ output, set the P41 output latch to "1" and configure as an output with P4CR1. An INTTC5 interrupt is generated when an overflow occurs.

TREG5 is configured a 2-stage shift register and, during output, will not switch until one output cycle is completed even if TREG5 is overwritten; therefore, output can be altered continuously. Also, the first time, TREG5 is shifted by setting TC5S (bit 5 in TC5CR) to "1" after data are loaded to TREG5.

Note : PWM output mode can be used in only NORMAL1/2 or IDLE1/2 mode.

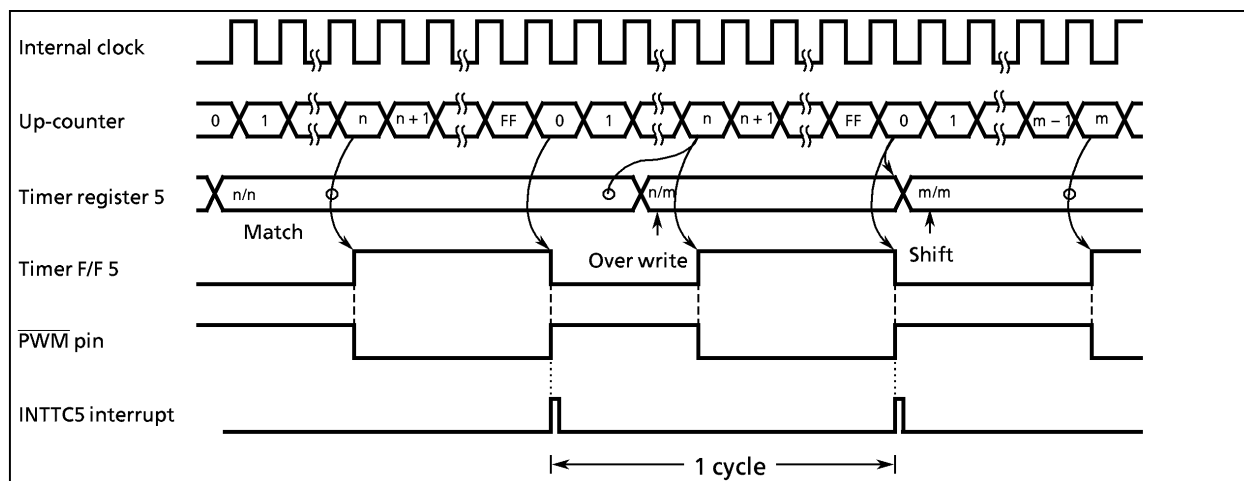


Figure 2-32. PWM Output Mode Timing Chart

Table 2-7. PWM Output Mode

Source clock		Resolution		Repeat cycle	
NORMAL1/2, IDLE1/2 mode		At $f_c = 8 \text{ MHz}$	At $f_c = 4.194304 \text{ MHz}$	At $f_c = 8 \text{ MHz}$	At $f_c = 4.194304 \text{ MHz}$
DV7CK = 0	DV7CK = 1				
$f_c/2^2 \text{ [Hz]}$		500 [ns]	953.7 [ns]	128 [μs]	244 [μs]
$f_c/2$		250 [ns]	476.8 [ns]	64 [μs]	122 [μs]
f_c		125 [ns]	238.4 [ns]	32 [μs]	61 [μs]

2.9 Serial Interface (SIO1, SIO2)

The TMP87CM24A/P24A each have two clocked-synchronous 8-bit serial interfaces (SIO1 and SIO2). Each serial interface has an 8-byte transmit and receive data buffer that can automatically and continuously transfer up to 64 bits of data.

The serial interfaces are connected to external devices via pins P44 (SO1), P43 (SI1), P42 ($\overline{\text{SCK1}}$) for SIO1 and P47 (SO2), P46 (SI2), P45 ($\overline{\text{SCK2}}$) for SIO2. The serial interface pins are also used as port P4. When used as serial interface pins, the output latches of these pins should be set to "1". In the transmit mode, pins P43 and P46 can be used as normal I/O ports, and in the receive mode, the pins P44 and P47 can be used as normal I/O ports.

2.9.1 Configuration

The SIO1 and SIO2 have the same configuration, except for the addresses/bit positions of the control/status registers and buffer registers.

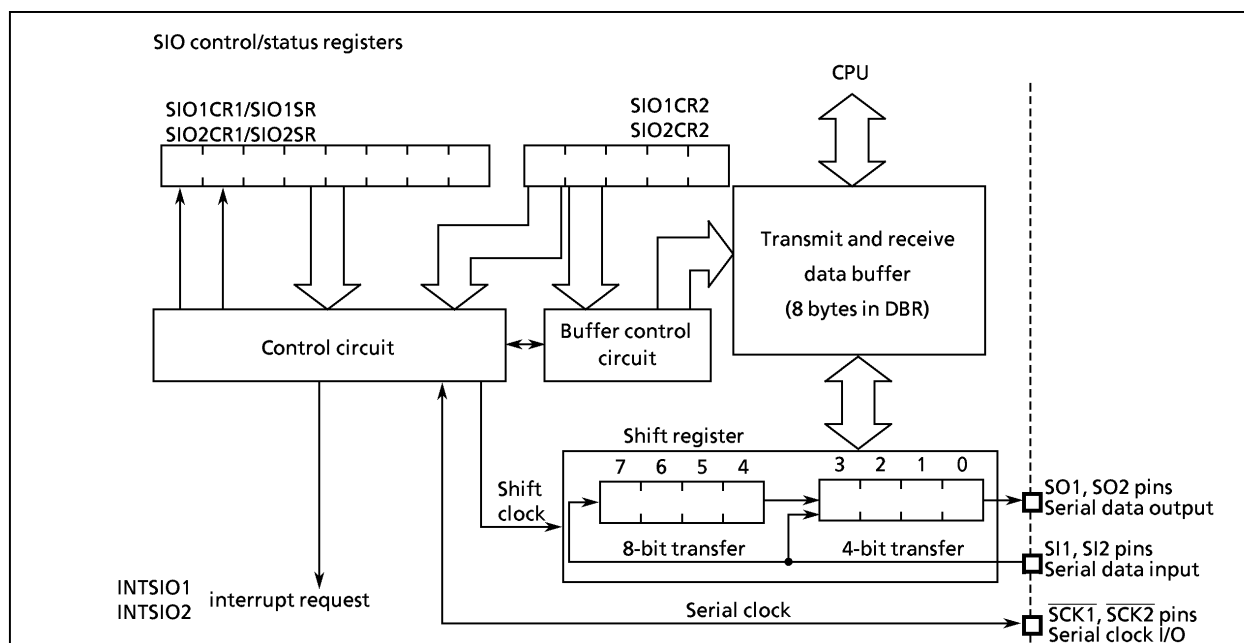


Figure 2-33. Serial Interfaces

2.9.2 Control

The serial interfaces are controlled by SIO control registers (SIO1CR1/SIO1CR2 or SIO2CR1/SIO2CR2). The serial interface status can be determined by reading SIO status registers (SIO1SR or SIO2SR).

The transmit and receive data buffer is controlled by the BUF (bits 2 to 0 in SIO1CR2/SIO2CR2). The data buffer is assigned to addresses 0FF0_H to 0FF7_H for SIO1 or 0FF8_H to 0FFB_H for SIO2 in the DBR area, and can continuously transfer up to 8 words (bytes or nibbles) at one time. When the specified number of words has been transferred, a buffer empty (in the transmit mode) or a buffer full (in the receive mode or transmit/receive mode) interrupt (INTSIO1 or INTSIO2) is generated.

When the internal clock is used as the serial clock in the 8-bit receive mode and the 8-bit transmit/receive mode, a fixed interval wait can be applied to the serial clock for each word transferred. Four different wait times can be selected with WAIT (bits 4 and 3 in SIO1CR2/SIO2CR2).

SIO1, SIO2 Control Registers 1

	7	6	5	4	3	2	1	0		
SIO1CR1 (0020 _H)	SIOS	SIOINH	SIOM			SCK			(Initial value : 0000 0000)	
SIO2CR1 (0022 _H)	SIOS	Indicate transfer start/stop				0 : Stop 1 : Start				Write only
	SIOINH	Continue/abort transfer				0 : Continue transfer 1 : Abort transfer (automatically cleared after abort)				
	SIOM	Transfer mode select				000 : 8-bit transmit mode 010 : 4-bit transmit mode 100 : 8-bit transmit/receive mode 101 : 8-bit receive mode 110 : 4-bit receive mode				
	SCK	Serial clock select				000 : Internal clock $fc/2^{13}$ or $fs/2^5$ [Hz] 001 : Internal clock $fc/2^8$ 010 : Internal clock $fc/2^6$ 011 : Internal clock $fc/2^5$ 111 : External clock (input from \overline{SCK} pin)				

Note 1: fc : High-frequency clock [Hz], fs : Low-frequency clock [Hz]

Note 2: Set $SIOS$ to "0" and $SIOINH$ to "1" when setting the transfer mode or serial clock.

Note 3: $SIO1CR1/SIO2CR1$ are write-only registers and must not be used with any of read-modify-write instructions such as bit operate, etc.

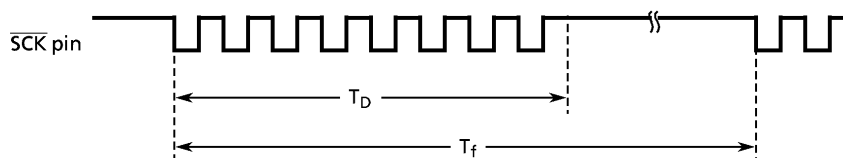
SIO1, SIO2 Status Registers

	7	6	5	4	3	2	1	0	
SIO1SR (0020 _H)	SIOF	SEF	"1"	"1"	"1"	"1"	"1"	"1"	
SIO2SR (0022 _H)									
	SIOF	Serial transfer operating status monitor	0 : Transfer terminated 1 : Transfer in process						Read only
	SEF	Shift operating status monitor	0 : Shift operation terminated 1 : Shift operation in process						

SIO1, SIO2 Control Registers 2

	7	6	5	4	3	2	1	0																											
SIO1CR2 (0021 _H)				WAIT			BUF		(Initial value: ***0 0000)																										
SIO2CR2 (0023 _H)																																			
WAIT	Wait control			Always sets "00" except 8-bit transmit/receive mode. 00 : T _f = T _D (non-wait) 01 : T _f = 2T _D 10 : T _f = 4T _D 11 : T _f = 8T _D } (wait)					Write only																										
BUF	Number of transfer words			<table><thead><tr><th></th><th>Buffer address used SIO1</th><th>SIO2</th></tr></thead><tbody><tr><td>000 : 1 word transfer</td><td>0FF0_H</td><td>0FF8_H</td></tr><tr><td>001 : 2 words transfer</td><td>0FF0 to 0FF1_H</td><td>0FF8 to 0FF9_H</td></tr><tr><td>010 : 3 words transfer</td><td>0FF0 to 0FF2_H</td><td>0FF8 to 0FFA_H</td></tr><tr><td>011 : 4 words transfer</td><td>0FF0 to 0FF3_H</td><td>0FF8 to 0FFB_H</td></tr><tr><td>100 : 5 words transfer</td><td>0FF0 to 0FF4_H</td><td>0FF8 to 0FFC_H</td></tr><tr><td>101 : 6 words transfer</td><td>0FF0 to 0FF5_H</td><td>0FF8 to 0FFD_H</td></tr><tr><td>110 : 7 words transfer</td><td>0FF0 to 0FF6_H</td><td>0FF8 to 0FFE_H</td></tr><tr><td>111 : 8 words transfer</td><td>0FF0 to 0FF7_H</td><td>0FF8 to 0FFF_H</td></tr></tbody></table>							Buffer address used SIO1	SIO2	000 : 1 word transfer	0FF0 _H	0FF8 _H	001 : 2 words transfer	0FF0 to 0FF1 _H	0FF8 to 0FF9 _H	010 : 3 words transfer	0FF0 to 0FF2 _H	0FF8 to 0FFA _H	011 : 4 words transfer	0FF0 to 0FF3 _H	0FF8 to 0FFB _H	100 : 5 words transfer	0FF0 to 0FF4 _H	0FF8 to 0FFC _H	101 : 6 words transfer	0FF0 to 0FF5 _H	0FF8 to 0FFD _H	110 : 7 words transfer	0FF0 to 0FF6 _H	0FF8 to 0FFE _H	111 : 8 words transfer	0FF0 to 0FF7 _H
	Buffer address used SIO1	SIO2																																	
000 : 1 word transfer	0FF0 _H	0FF8 _H																																	
001 : 2 words transfer	0FF0 to 0FF1 _H	0FF8 to 0FF9 _H																																	
010 : 3 words transfer	0FF0 to 0FF2 _H	0FF8 to 0FFA _H																																	
011 : 4 words transfer	0FF0 to 0FF3 _H	0FF8 to 0FFB _H																																	
100 : 5 words transfer	0FF0 to 0FF4 _H	0FF8 to 0FFC _H																																	
101 : 6 words transfer	0FF0 to 0FF5 _H	0FF8 to 0FFD _H																																	
110 : 7 words transfer	0FF0 to 0FF6 _H	0FF8 to 0FFE _H																																	
111 : 8 words transfer	0FF0 to 0FF7 _H	0FF8 to 0FFF _H																																	

Note 1: T_f : frame time, T_D : data transfer time



Note 2: The lower 4 bits of each buffer are used during 4-bit transfers. Zeros (0) are stored to the upper 4bits when receiving.

Note 3: Transmitting starts at the lowest address. Received data are also stored starting from the lowest address to the highest address. For example, in the case of SIO1, the first buffer address transmitted is 0FF0_H.

Note 4: The value to be loaded to BUF is held after transfer is completed.

Note 5: SIO1CR2/SIO2CR2 must be set when the serial interface is stopped (SIOF = 0).

Note 6: SIO1CR2/SIO2CR2 are write-only registers, which cannot access any of read-modify-write instructions such as bit operate, etc.

Note 7: *: Don't care

Figure 2-34. SIO Control Registers and Status Registers

(1) Serial Clock

a. Clock Source

SCK (bits 2 to 0 in SIO1CR1/SIO2CR1) is able to select the following:

① Internal Clock

Any of four frequencies can be selected. The serial clock is output to the outside on the $\overline{\text{SCK1}}/\overline{\text{SCK2}}$ pin. The $\overline{\text{SCK}}$ pin goes high when transfer starts.

When data writing (in the transmit mode) or reading (in the receive mode or the transmit/receive mode) cannot keep up with the serial clock rate, there is a wait function that automatically stops the serial clock and holds the next shift operation until the read/write processing is completed.

Table 2-8. Serial Clock Rate

Serial clock			Maximum transfer rate	
NORMAL1/2, IDLE1/2 mode		SLOW, SLEEP mode		
DV7CK = 0	DV7CK = 1		At $f_c = 8 \text{ MHz}$	At $f_s = 32.768 \text{ kHz}$
$f_c/2^{13}$ [Hz]	$f_s/2^5$ [Hz]	$f_s/2^5$ [Hz]	0.954 kbit/s	1 kbit/s
$f_c/2^8$	$f_c/2^8$	—	30.5	—
$f_c/2^6$	$f_c/2^6$	—	122	—
$f_c/2^5$	$f_c/2^5$	—	244	—

Note: 1 Kbit = 1024 bit

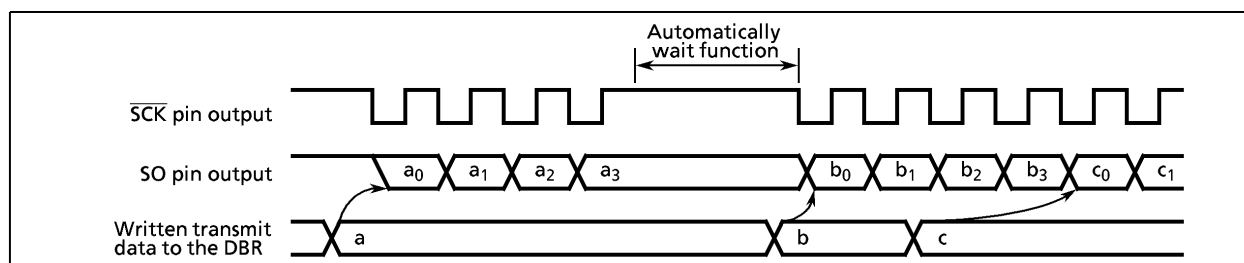
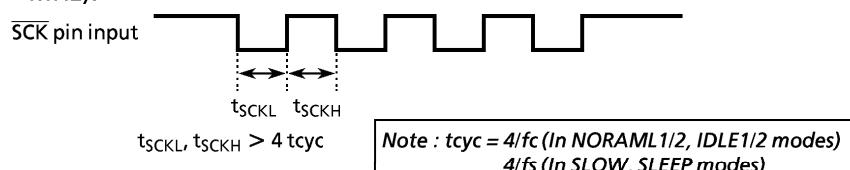


Figure 2-35. Clock Source (Internal Clock)

② External Clock

An external clock connected to the $\overline{\text{SCK1}}/\overline{\text{SCK2}}$ pin is used as the serial clock. In this case, the P42 ($\overline{\text{SCK1}}$)/P45 ($\overline{\text{SCK2}}$) output latch must be set to "1". To ensure shifting, a pulse width of at least 4 machine cycles is required. Thus, the maximum transfer speed is 244K-bit/s. (at $f_c = 8$ MHz).

**b. Shift edge**

The leading edge is used to transmit, and the trailing edge is used to receive.

① Leading Edge

Transmitted data are shifted on the leading edge of the serial clock (falling edge of the $\overline{\text{SCK}}$ pin input/output).

② Trailing Edge

Received data are shifted on the trailing edge of the serial clock (rising edge of the $\overline{\text{SCK}}$ pin input/output).

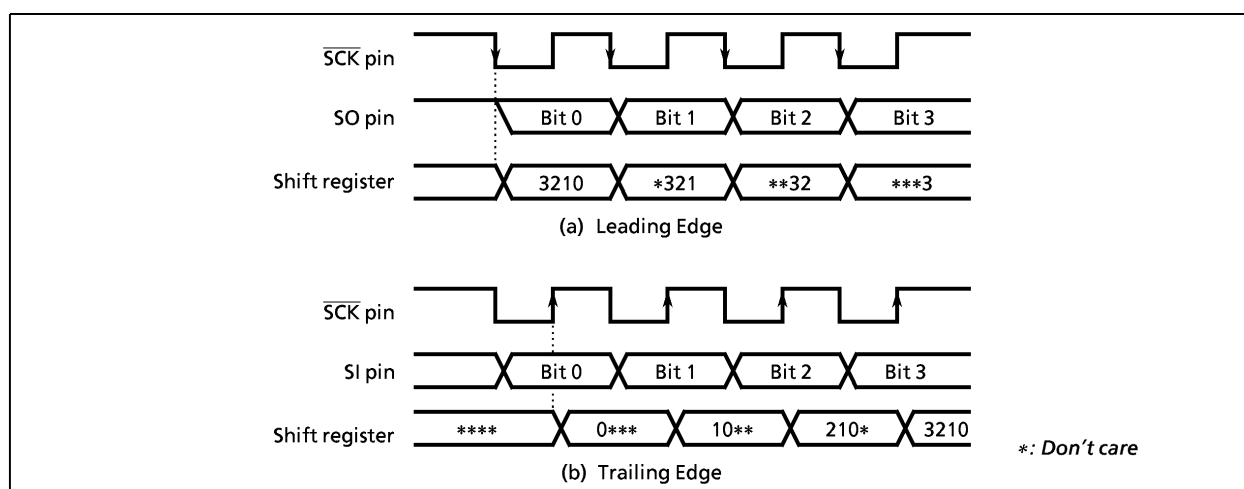


Figure 2-36. Shift Edge

(2) Number of Bits to Transfer

Either 4-bit or 8-bit serial transfer can be selected. When 4-bit serial transfer is selected, only the lower 4 bits of the transmit/receive data buffer register are used. The upper 4 bits are cleared to "0" when receiving.

The data is transferred in sequence starting at the least significant bit (LSB).

(3) Number of Words to Transfer

Up to 8 words consisting of 4 bits of data (4-bit serial transfer) or 8 bits (8-bit serial transfer) of data can be transferred continuously. The number of words to be transferred is loaded to BUF.

An INTSIO interrupt is generated when the specified number of words has been transferred. If the number of words is to be changed during transfer, the serial interface must be stopped before making the change. The number of words can be changed during automatic-wait operation of an internal clock. In this case, the serial interface is not required to be stopped.

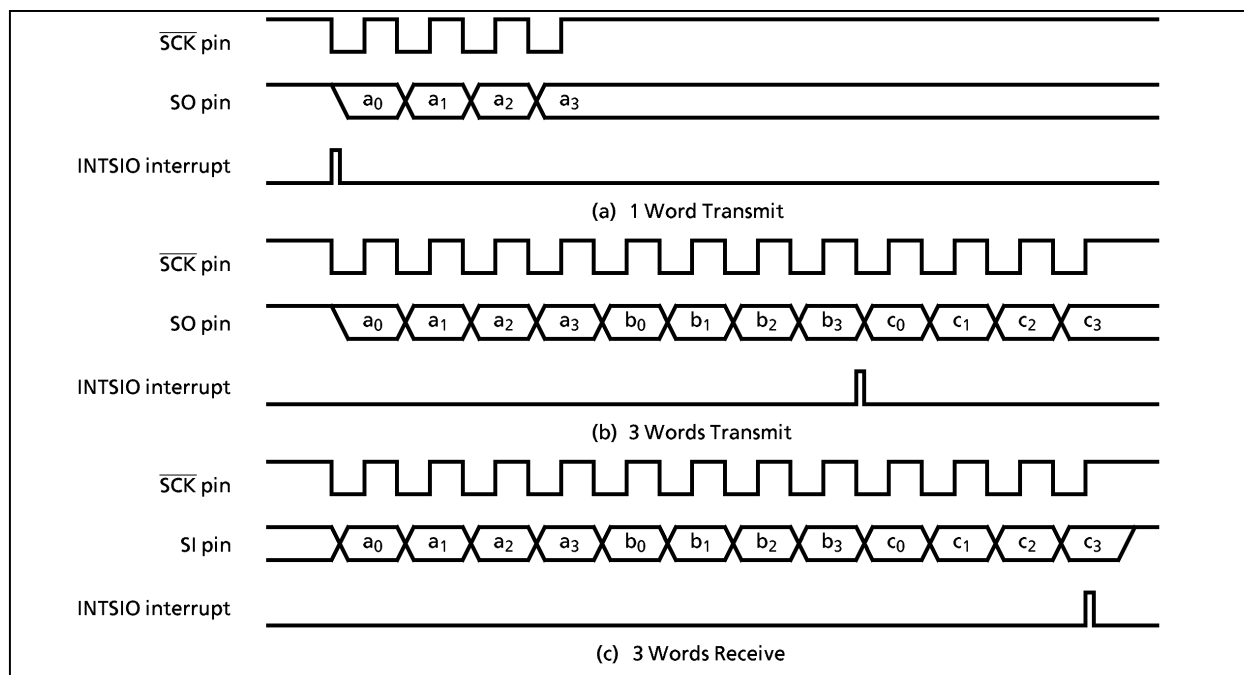


Figure 2-37. Number of Bits to Transfer (Example : 4-bit serial transfer)

2.9.3 Transfer Mode

SIOM (bits 5 to 3 in SIO1CR1/SIO2CR1) is used to select the transmit, receive, or transmit/receive mode.

(1) 4-Bit and 8-Bit Transmit Modes

In these modes, the SIO1CR1/SIO2CR1 is set to the transmit mode and then the data to be transmitted first are written to the data buffer registers (DBR). After the data are written, the transmission is started by setting SIOS to "1". The data are then output sequentially to the SO pin in synchronous with the serial clock, starting with the least significant bit (LSB). As soon as the LSB has been output, the data are transferred from the data buffer register to the shift register. When the final data bit has been transferred and the data buffer register is empty, an INTSIO (buffer empty) interrupt is generated to request the next transmitted data.

When the internal clock is used, the serial clock will stop and an automatic-wait will be initiated if the next transmitted data are not loaded to the data buffer register by the time the number of data words specified with the BUF has been transmitted. Writing even one word of data cancels the automatic-wait; therefore, when transmitting two or more words, always write the next word before transmission of the previous word is completed.

Note: Automatic-waits are also canceled by writing to a DBR not being used as a transmit data buffer register; therefore, during SIO do not use such DBR for other applications. For example, when 3 words are transmitted, do not use the DBR of the remained 5 words.

When an external clock is used, the data must be written to the data buffer register before shifting next data. Thus, the transfer speed is determined by the maximum delay time from the generation of the interrupt request to writing of the data to the data buffer register by the interrupt service program.

When the transmit is started, after the SIOF goes "high" output from the SO pin holds final bit of the last data until falling edge of the SCK.

If it is necessary to change the number of words, SIOS should be cleared to "0", then BUF must be rewritten after confirming that SIOF has been cleared to "0". That the transmission has ended can be determined from the status of SIOF (bit 7 in SIO1SR/SIO2SR) because SIOF is cleared to "0" when a transfer is completed. When SIOINH is set, the transmission is immediately ended and SIOF is cleared to "0".

The transmission is ended by clearing SIOS to "0" or setting SIOINH to "1" in buffer empty interrupt service program.

When an external clock is used, it is also necessary to clear SIOS to "0" before shifting the next data; otherwise, dummy data will be transmitted and the operation will end.

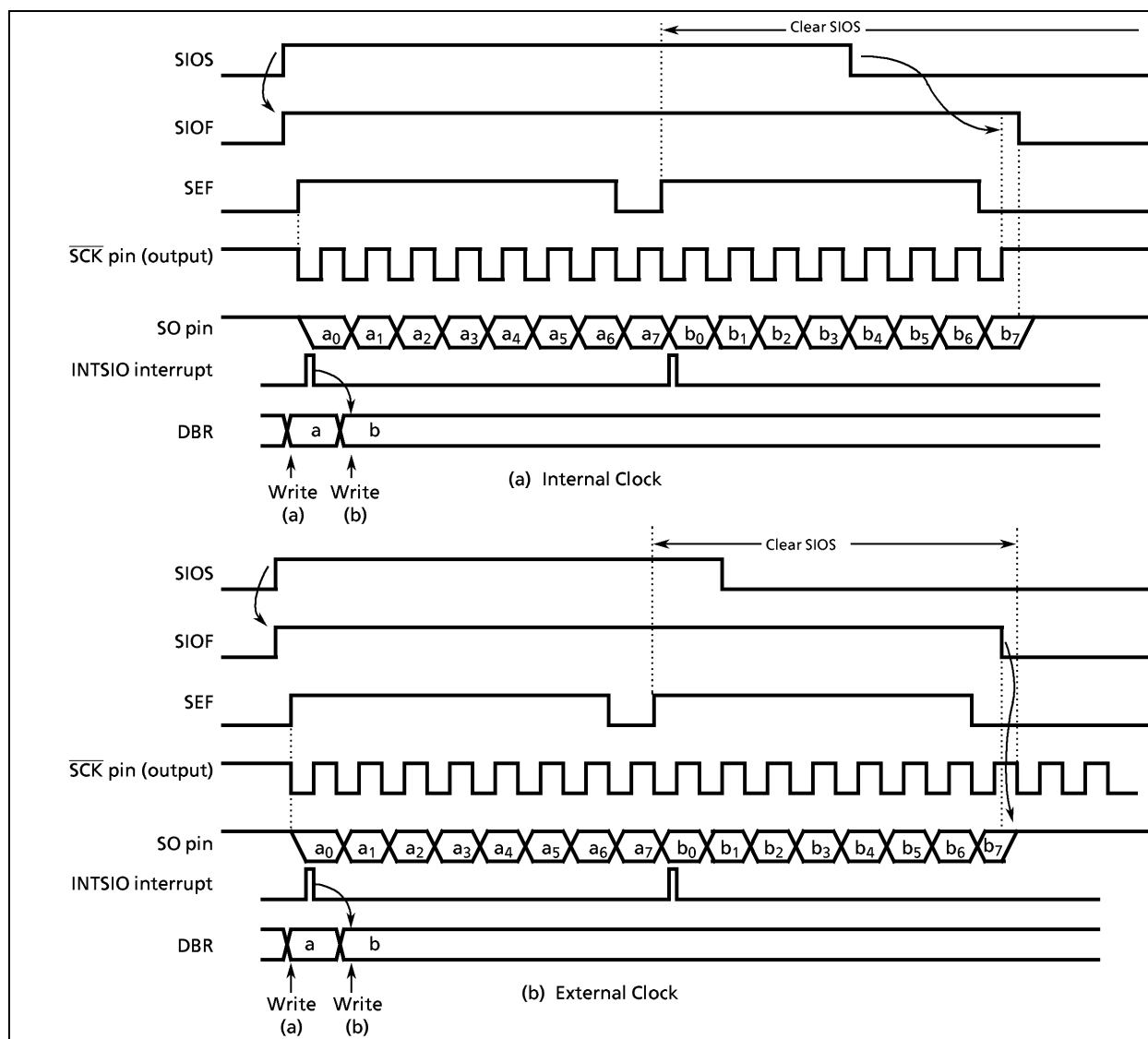


Figure 2-38. Transfer Mode (Example: 8-Bit, 1 Word Transfer)

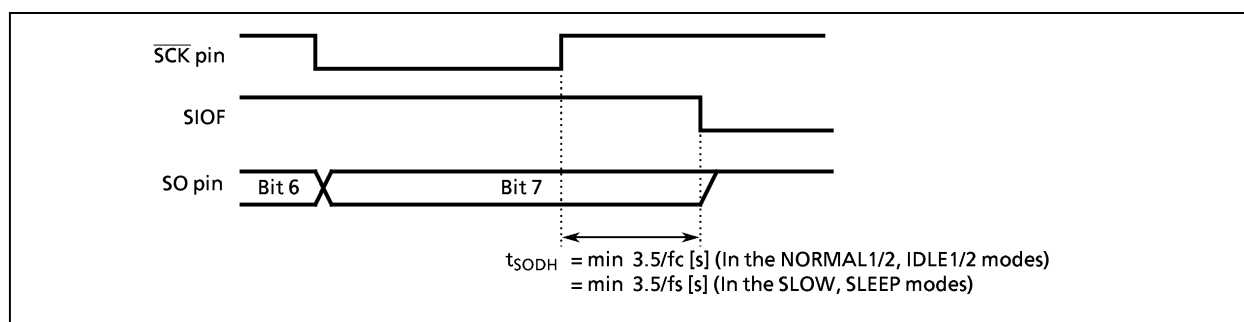


Figure 2-39. Transmitted Data Hold Time at End of Transmit

(2) 4-Bit and 8-Bit Receive Modes

After setting the control registers to the receive mode, set SIOS to "1" to enable receiving. The data are then transferred to the shift register via the SI pin in synchronous with the serial clock. When one word of data has been received, it is transferred from the shift register to the data buffer register (DBR). When the number of words specified with the BUF has been received, an INTSIO (buffer full) interrupt is generated to request that these data be read out. The data are then read from the data buffer registers by the interrupt service program.

When the internal clock is used, and the previous data are not read from the data buffer register before the next data are received, the serial clock will stop and an automatic-wait will be initiated until the data are read. A wait will not be initiated if even one data word has been read.

Note: Waits are also canceled by reading a DBR not being used as a received data buffer register is read; therefore, during SIO do not use such DBR for other applications.

When an external clock is used, the shift operation is synchronized with the external clock; therefore, the previous data are read before the next data are transferred to the data buffer register. If the previous data have not been read, the next data will not be transferred to the data buffer register and the receiving of any more data will be canceled. When an external clock is used, the maximum transfer speed is determined by the delay between the time when the interrupt request is generated and when the data received have been read.

The receiving is ended by clearing SIOS to "0" or setting SIOINH to "1" in buffer full interrupt service program. When SIOINH is set, the receiving is immediately ended and SIOF is cleared to "0".

When SIOS is cleared, the current data are transferred to the buffer in 4-bit or 8-bit blocks. The receiving mode ends when the transfer is completed. SIOF is cleared to "0" when receiving is ended and thus can be sensed by program to confirm that receiving has ended.

If it is necessary to change the number of words in external clock operation, SIOS should be cleared to "0" then BUF must be rewritten after confirming that SIOF has been cleared to "0".

If it is necessary to change the number of words in internal clock, during automatic-wait operation which occurs after completion of data receive, BUF must be rewritten before the received data is read out.

Note: The buffer contents are lost when the transfer mode is switched. If it should become necessary to switch the transfer mode, end receiving by clearing SIOS to "0", read the last data and then switch the transfer mode.

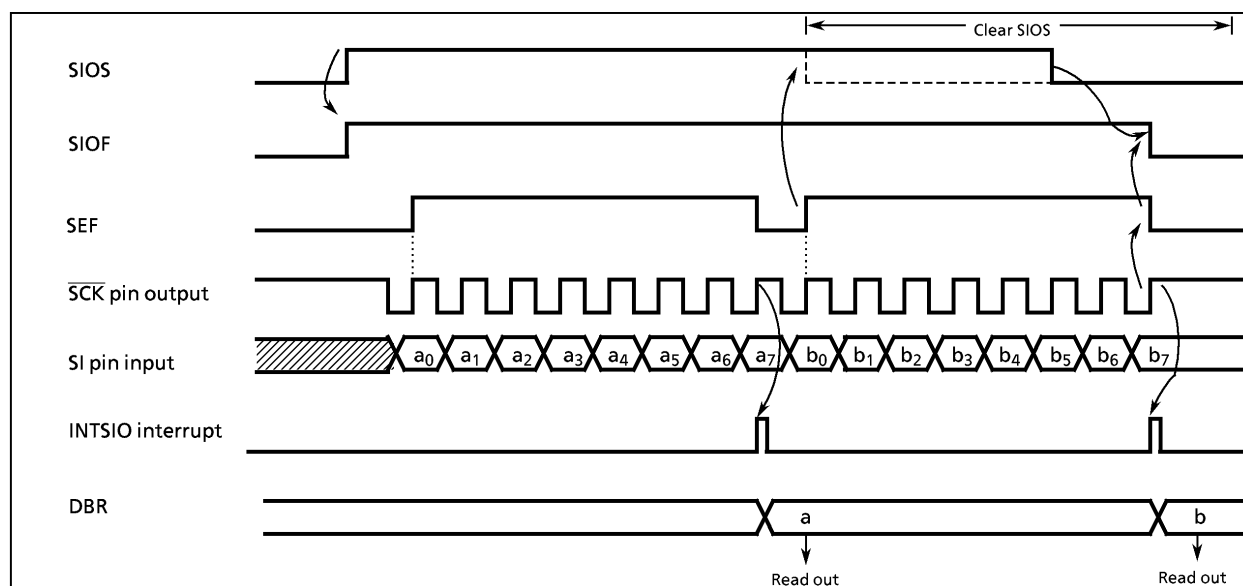


Figure 2-40. Receive Mode (Example : 8-bit, 1 word, internal clock)

(3) 8-bit Transmit/Receive Mode

After setting the control registers to the 8-bit transmit/receive mode, write the data to be transmitted first to the data buffer registers (DBR). After that, enable transceiving by setting SIOS to "1". When transmitting, the data are output from the SO pin at leading edges of the serial clock. When receiving, the data are input to the SI pin at the trailing edges of the serial clock. 8-bit data are transferred from the shift register to the data buffer register. An INTSIO interrupt is generated when the number of data words specified with the BUF has been transferred. The interrupt service program reads the received data from the data buffer register and then writes the data to be transmitted. The data buffer register is used for both transmitting and receiving; therefore, always write the data to be transmitted after reading the received data.

When the internal clock is used, a wait is initiated until the received data are read and the next data are written. A wait will not be initiated if even one data word has been written.

Note: The wait is also canceled by writing to a DBR not being used as a transmit data buffer register; therefore, during SIO do not use such DBR for other applications.

When an external clock is used, the shift operation is synchronized with the external clock; therefore, it is necessary to read the received data and write the data to be transmitted next before starting the next shift operation. When an external clock is used, the transfer speed is determined by the maximum delay between generation of an interrupt request and the received data are read and the data to be transmitted next are written.

When the receive is started, after the SIOF goes "high" output from the SO pin holds final bit of the last data until falling edge of the SCK.

The transmit/receive operation is ended by clearing SIOS to "0" or setting SIOINH to "1" in interrupt service program.

When SIOS is cleared, the current data are transferred to the data buffer register in 8-bit blocks. The transmit mode ends when the transfer is completed SIOF is cleared to "0" when receiving is ended and thus can be sensed by program to confirm that receiving has ended.

When SIOINH is set, the transmit/receive operation is immediately ended and SIOF is cleared to "0".

If it is necessary to change the number of words in external clock operation, SIOS should be cleared to "0", then BUF must be rewritten after confirming that Siof has been cleared to "0".

If it is necessary to change the number of words in internal clock, during automatic-wait operation which occurs after completion of transmit/receive operation, BUF must be rewritten before reading and writing of the receive/transmit data.

Note: The buffer contents are lost when the transfer mode is switched. If it should become necessary to switch the transfer mode, end receiving by clearing SIOS to "0", read the last data and then switch the transfer mode.

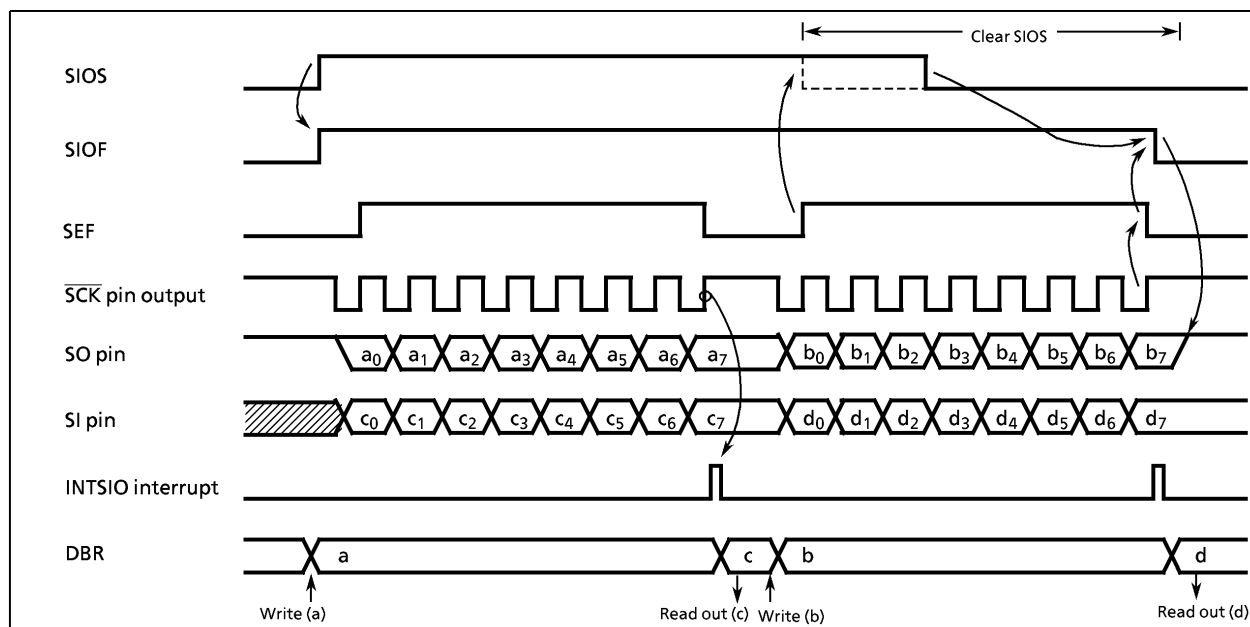


Figure 2-41. Transmit/Receive Mode (Example : 8-bit, 1word, internal clock)

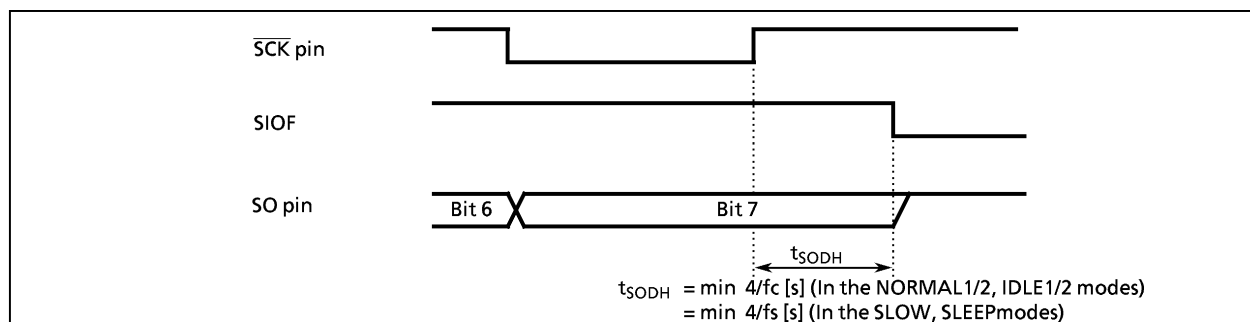


Figure 2-42. Transmitted Data Hold Time at End of Transmit/Receive

2.10 LCD Driver

The TMP87CM24A/P24A each have a driver and control circuit to directly drive the liquid crystal device (LCD). The pins to be connected to LCD are as follows:

- | | |
|--|--------------------------|
| ① Segment output port | 12 pins (SEG11 to SEG0) |
| ② Segment output or P6, P7, P8, P9 input/output port | 28 pins (SEG39 to SEG12) |
| ③ Common output port | 4 pins (COM3 to COM0) |

In addition, C0, C1, V1, V2, V3 pin are provided for the LCD driver's booster circuit.

The devices that can be directly driven is selectable from LCD of the following drive methods:

- | | | |
|--------------|----------------|--|
| ① 1/4 Duty | (1/3 Bias) LCD | Max 160 Segments (8-segment × 20 digits) |
| ② 1/3 Duty | (1/3 Bias) LCD | Max 120 Segments (8-segment × 15 digits) |
| ③ 1/2 Duty | (1/3 Bias) LCD | Max 80 Segments (8-segment × 10 digits) |
| ④ Static LCD | | Max 40 Segments (8-segment × 5 digits) |

2.10.1 Configuration

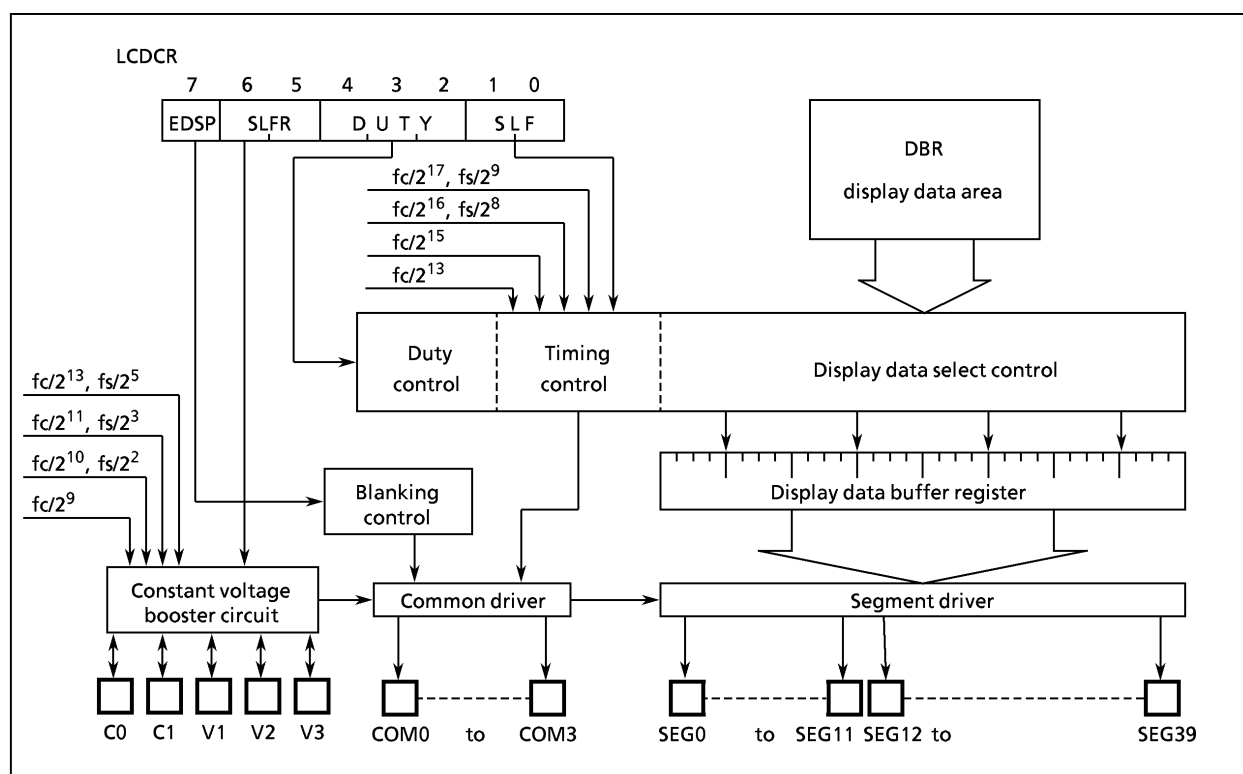


Figure 2-43. LCD Driver

(1) LCD driving methods

As for LCD driving method, 4 types can be selected by DUTY (bit 4 to bit 2 of LCDCR). The driving method is initialized in the initial program according to the LCD used.

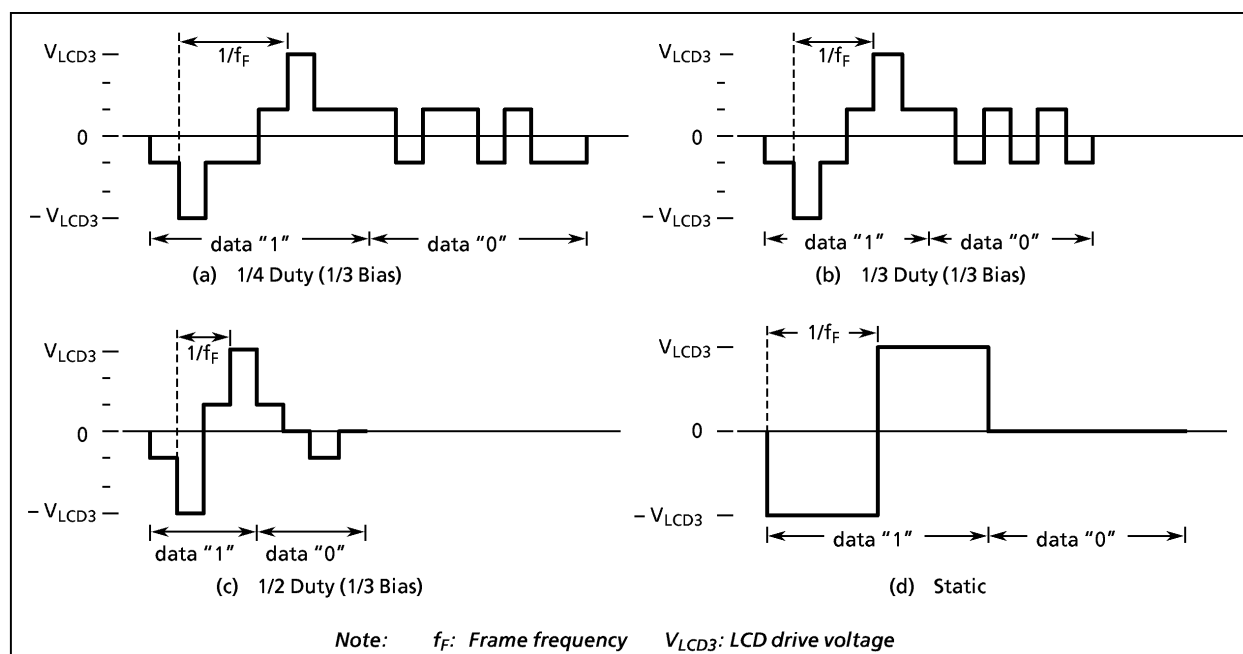


Figure 2-45. LCD Drive Waveform (COM – SEG pins)

(2) Frame frequency

Frame frequency (f_F) is set according to driving method and base frequency as shown in the following Table 2-9. The base frequency is selected by SLF (bit 1 and 0 of LCDCR) according to the frequency f_c and f_s of the basic clock to be used.

Table 2-9. Setting of LCD Frame Frequency

(a) At the single clock mode. At the dual clock mode (DV7CK = 0).

SLF	Base frequency [Hz]	Frame frequency [Hz]			
		1/4 Duty	1/3 Duty	1/2 Duty	Static
00	$\frac{f_c}{2^{17}}$	$\frac{f_c}{2^{17}}$	$\frac{4}{3} \cdot \frac{f_c}{2^{17}}$	$\frac{4}{2} \cdot \frac{f_c}{2^{17}}$	$\frac{f_c}{2^{17}}$
	($f_c = 8 \text{ MHz}$)	61	81	122	61
01	$\frac{f_c}{2^{16}}$	$\frac{f_c}{2^{16}}$	$\frac{4}{3} \cdot \frac{f_c}{2^{16}}$	$\frac{4}{2} \cdot \frac{f_c}{2^{16}}$	$\frac{f_c}{2^{16}}$
	($f_c = 4 \text{ MHz}$)	61	81	122	61
10	$\frac{f_c}{2^{15}}$	$\frac{f_c}{2^{15}}$	$\frac{4}{3} \cdot \frac{f_c}{2^{15}}$	$\frac{4}{2} \cdot \frac{f_c}{2^{15}}$	$\frac{f_c}{2^{15}}$
	($f_c = 4 \text{ MHz}$)	122	162	244	122
11	$\frac{f_c}{2^{13}}$	$\frac{f_c}{2^{13}}$	$\frac{4}{3} \cdot \frac{f_c}{2^{13}}$	$\frac{4}{2} \cdot \frac{f_c}{2^{13}}$	$\frac{f_c}{2^{13}}$
	($f_c = 1 \text{ MHz}$)	122	162	244	122

Note: f_c : High-frequency clock [Hz]

(b) At the dual clock mode (DV7CK = 1 or SYSCK = 1)

SLF	Base frequency [Hz]	Frame frequency [Hz]			
		1/4 Duty	1/3 Duty	1/2 Duty	Static
00	$\frac{f_s}{2^9}$	$\frac{f_s}{2^9}$	$\frac{4}{3} \cdot \frac{f_s}{2^9}$	$\frac{4}{2} \cdot \frac{f_s}{2^9}$	$\frac{f_s}{2^9}$
	($f_s = 32.768 \text{ kHz}$)	64	85	128	64
01	$\frac{f_s}{2^8}$	$\frac{f_s}{2^8}$	$\frac{4}{3} \cdot \frac{f_s}{2^8}$	$\frac{4}{2} \cdot \frac{f_s}{2^8}$	$\frac{f_s}{2^8}$
	($f_s = 32.768 \text{ kHz}$)	128	171	256	128

Note: f_s : Low-frequency clock [Hz]

(3) Booster circuit for LCD driver

The TMP87CM24A/P24A incorporate a booster circuit for the LCD driver (1V x 3 times) so that the LCD display does not flicker due to fluctuations in the power supply voltage.

The booster circuit boosts the output voltage for the segment/common signal by double (VLCD2) and triple (VLCD3) in relation to the on-chip output voltage (1V typ).

Figure 2-46 shows an example of a booster circuit for the LCD driver. It takes to maximum 1 s ($T_{opr} = -10^{\circ}\text{C}$) for the booster circuit to reach the specified voltage at return from reset or standby. If the LCD circuit is enabled before the specified voltage is reached boosting takes longer. The reference frequency of the booster circuit at initialization is 1 kHz. Selecting the frequency using the SLFR in the command register (LCDCR) raises the drive capability of segment/common. Table 2-10 shows the reference frequency of the booster circuit.

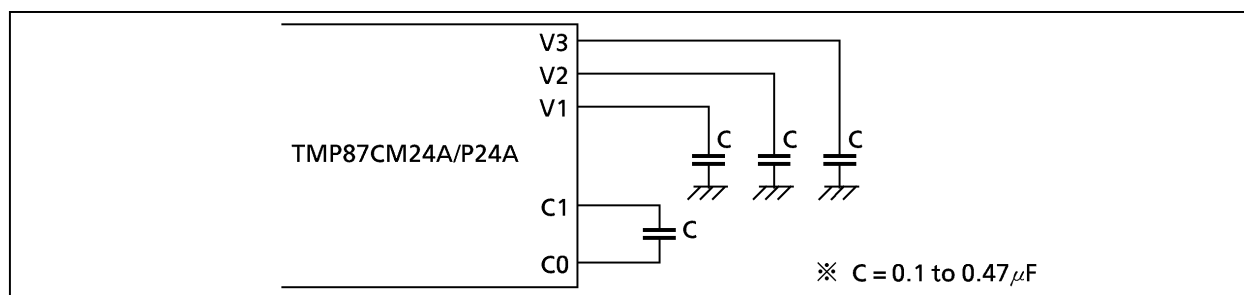


Figure 2-46. Example of a Booster Circuit

Table 2-10. Reference Frequency of the Booster Circuit

SLFR	Frequency	$f_c = 8 \text{ MHz}$	$f_s = 32.768 \text{ kHz}$
00	$f_c/2^{13}$ or $f_s/2^5$	0.98 kHz	1.02 kHz
01	$f_c/2^{11}$ or $f_s/2^3$	3.91 kHz	4.09 kHz
10	$f_c/2^{10}$ or $f_s/2^2$	7.81 kHz	8.19 kHz
11	$f_c/2^9$	15.63 kHz	—

Table 2-11. Selection of V3 Boosting Frequency

Boosting frequency	$f_c = 8 \text{ MHz}$	$f_c = 4 \text{ MHz}$	$f_c = 32.768 \text{ MHz}$
$f_c/2^{13}$ or $f_s/2^5$	40 ms	80 ms	40 ms
$f_c/2^{11}$ or $f_s/2^3$	10 ms	20 ms	10 ms
$f_c/2^{10}$ or $f_s/2^2$	5 ms	10 ms	5 ms
$f_c/2^9$	2.5 ms	5 ms	—

Note 1: $T_{opr} = 25^{\circ}\text{C}$, $0.1 \mu\text{F} \leq C \leq 0.47 \mu\text{F}$

Note 2: V3 booting time at VDD is stable.

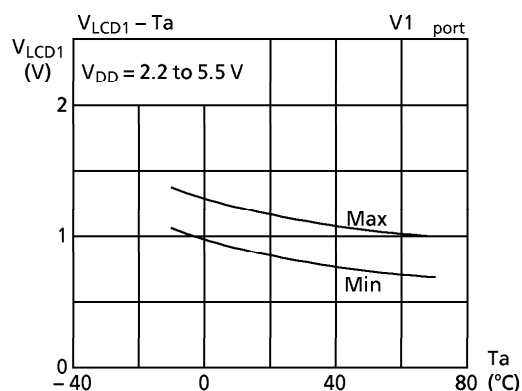


Figure 2-47. Temperature Characteristics of Voltage Booster Output

Notice of using LCD driver(1) The falling time and fluctuation of power supply voltage.

When LCD driver is used with the following condition, LCD may not be displayed temporarily, because the V1/V2/V3 pins output will be unstable by stopping of LCD booster circuit. Therefore, please take an enough time by software, before enabling LCD.

- a) When the falling time of power supply voltage is shorter than 1ms, within an operating voltage. (at 2.2V to 5.5V, $T_{opr} = -10$ to 70°C)
- b) When the fluctuation of power supply within 1ms is bigger than 0.7V.

(2) Power down of an instant.

When power supply voltage falls out of operating voltage and then rises within operating voltage, the maximum period that the V1/V2/V3 pins output will resume is 1 s. ($T_{opr} = -10^{\circ}\text{C}$). Therefore, please take an enough time by software, before enabling LCD

2.10.3 LCD Display Operation

(1) Display data setting

Display data is stored to the display data area (assigned to address 0F80 to 0F93_H) in the DBR. The display data which are stored in the display data area is automatically read out and sent to the LCD driver by the hardware. The LCD driver generates the segment signal and common signal according to the display data and driving method. Therefore, display patterns can be changed by only overwriting the contents of display data area by the program. Figure 2-48 shows the correspondence between the display data area and SEG/COM pins.

LCD light when display data is "1" and turn off when "0". According to the driving method of LCD, the number of pixels which can be driven becomes different, and the number of bits in the display data area which is used to store display data also becomes different.

Therefore, the bits which are not used to store display data as well as the data buffer which corresponds to the addresses not connected to LCD can be used to store general user process data (see Table 2-12.)

Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0F80 _H			SEG1				SEG0	
81			SEG3				SEG2	
82			SEG5				SEG4	
83			SEG7				SEG6	
84			SEG9				SEG8	
85			SEG11				SEG10	
86			SEG13				SEG12	
87			SEG15				SEG14	
88			SEG17				SEG16	
89			SEG19				SEG18	
8A			SEG21				SEG20	
8B			SEG23				SEG22	
8C			SEG25				SEG24	
8D			SEG27				SEG26	
8E			SEG29				SEG28	
8F			SEG31				SEG30	
90			SEG33				SEG32	
91			SEG35				SEG34	
92			SEG37				SEG36	
93			SEG39				SEG38	
	COM3	COM2	COM1	COM0	COM3	COM2	COM1	COM0

Figure 2-48. LCD Display Data Area (DBR)

Table 2-12. Driving Method and Bit for Display Data

Driving methods	Bit 7/3	Bit 6/2	Bit 5/1	Bit 4/0
1/4 Duty	COM3	COM2	COM1	COM0
1/3 Duty	—	COM2	COM1	COM0
1/2 Duty	—	—	COM1	COM0
Static	—	—	—	COM0

Note: —: This bit is not used for display data

(2) Blanking

Blanking is enabled when EDSP is cleared to "0".

Blanking turns off LCD through outputting a non-selective level to COM pin. A signal level is continuously output to SEG pin according to display data and driving method. For static drive, lights-out by data (clearing display data to "0") does not apply any voltage between pins COM and SEG. On the other hand, lights-out by blanking makes the output to COM pin at a non-selective level, so that the part between pins COM and SEG becomes in the state driven by non-selective level.

2.10.4 Control Method of LCD Driver

(1) Initial setting

Figure 2-49 shows the flowchart of initialization.

Example : To operate a 1/4 duty LCD of 40 segments x 4 com-mons at frame frequency $f_c/2^{16}$ [Hz]

```
LD      (LCDCR),00000001B    ; Sets LCD driving method and
                               ; frame frequency.
                               ; Boost frequency
LD      (P6CR),0FFH          ; Sets P6 port as segment
                               ; output .
                               ; Sets the initial value of
                               ; display data.
LD      (LCDCR),10000001B    ; Display enable
```

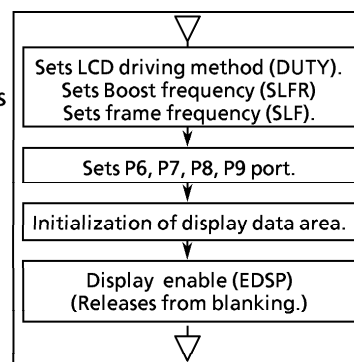


Figure 2-49. Initial Setting of LCD Driver

(2) Store of display data

Generally, display data are prepared as fixed data in program memory and stored in display data area by load command.

Example 1 : To display using 1/4 duty LCD a numerical value which corresponds to the LCD data stored in data memory at address 80H (when pins COM and SEG are connected to LCD as in Figure 2-50), display data become as shown in Table 2-12.

```
LD      A, (80H)
ADD     A, TABLE - $ - 5
LD      HL,0F80H
LD      (HL), (PC + A)
JRS     T, SNEXT
TABLE : DB 11011111B, 00000110B,
           11100011B, 10100111B,
           00110110B, 10110101B,
           11110101B, 00010111B,
           11110111B, 10110111B
SNEXT :
```

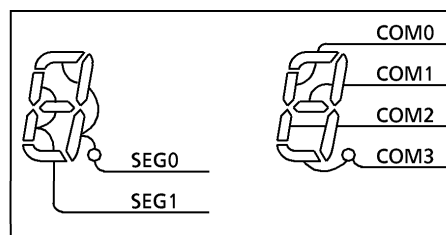








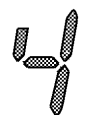



Figure 2-50. Example of COM, SEG Pin Connection (1/4 Duty)

Note : DB is a byte data definition instruction.

Table 2-13. Example of Display Data (1/4 Duty)

No.	display	display data	No.	display	display data
0		11011111	5		10110101
1		00000110	6		11110101
2		11100011	7		00000111
3		10100111	8		11110111
4		00110110	9		10110111

Example 2 : Table 2-14 shows an example of display data which are displayed using 1/2 duty LCD in the same way as Table 2-13. The connection between pins COM and SEG are the same as shown in Figure 2-51.

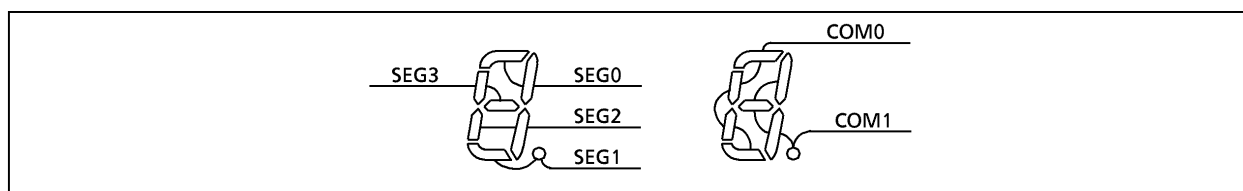


Figure 2-51. Example of COM, SEG Pin Connection

Table 2-14. Example of Display Data (1/2 Duty)

Number	Display data		Number	Display data	
	High order address	Low order address		High order address	Low order address
0	**01**11	**01**11	5	**11**10	**01**01
1	**00**10	**00**10	6	**11**11	**01**01
2	**10**01	**01**11	7	**01**10	**00**11
3	**10**10	**01**11	8	**11**11	**01**11
4	**11**10	**00**10	9	**11**10	**01**11

Note: *: Don't care

(3) Example of LCD drive output

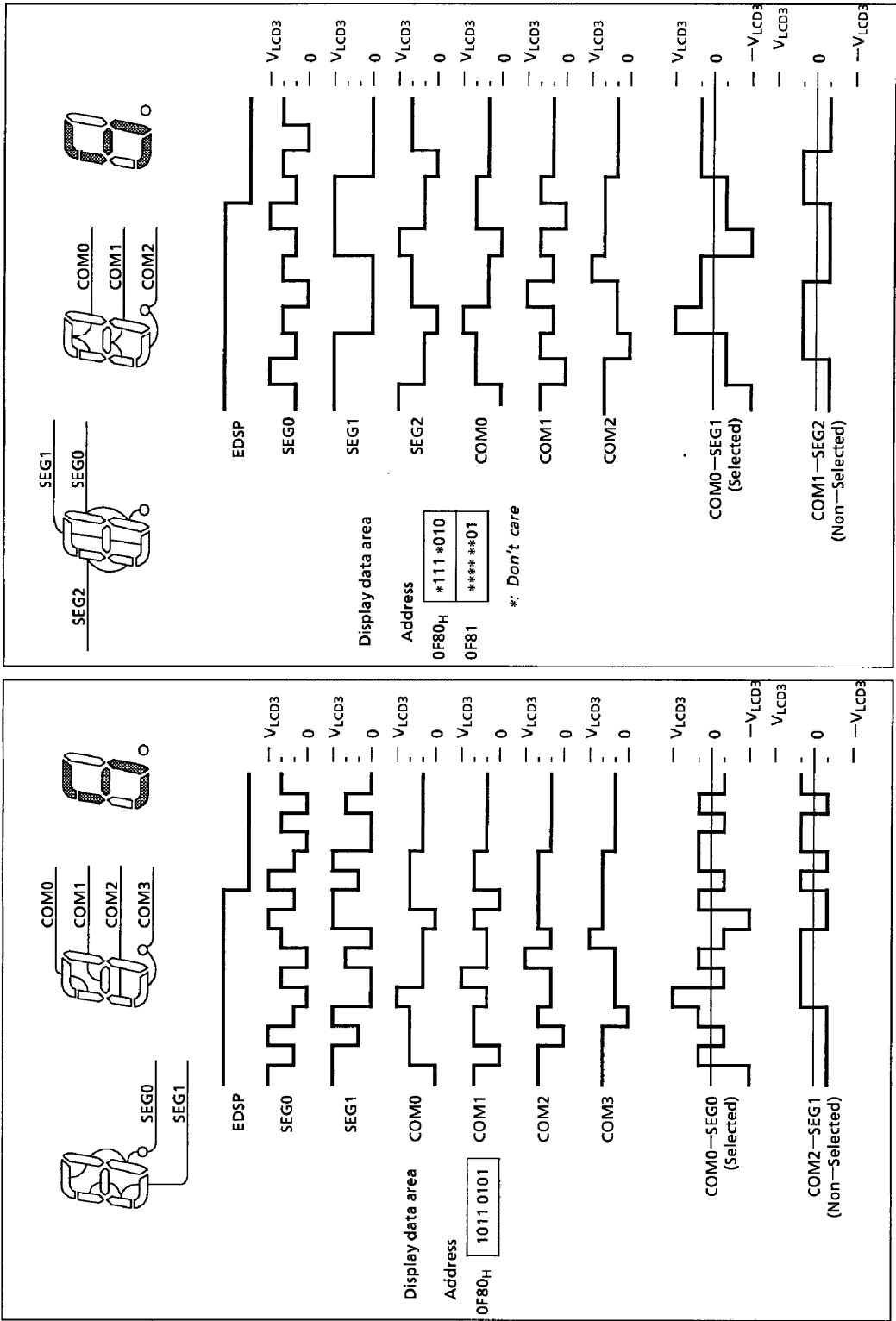


Figure 2-52. 1/4 Duty (1/3 Bias) Drive

Figure 2-53. 1/3 Duty (1/3 Bias) Drive

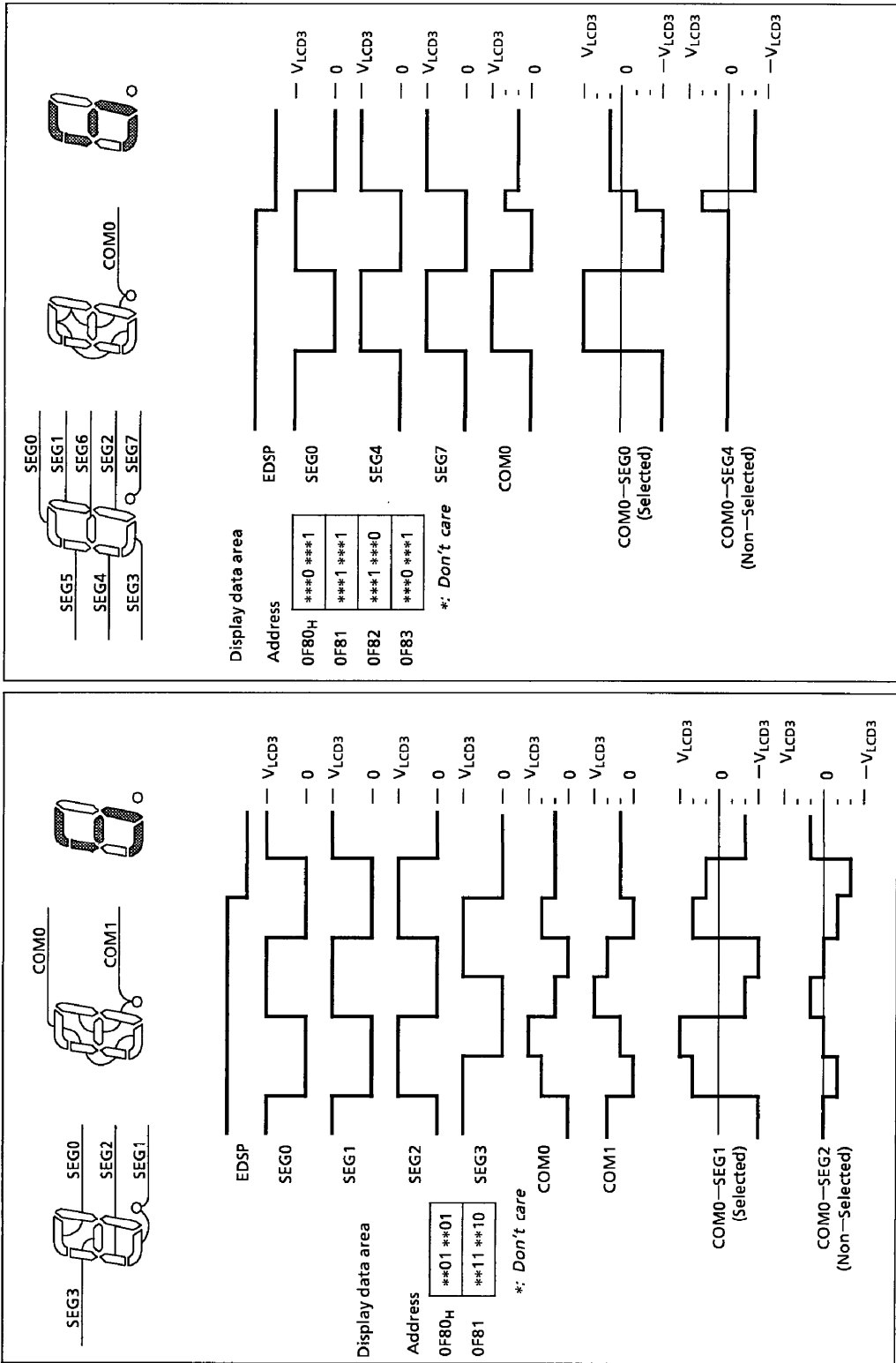


Figure 2-55. Static Drive

Figure 2-54. 1/2 Duty (1/3 Bias) Drive

Voltage Regulator for LCD Driver in TMP87CM24A/P24AF

Two phenomenon have been found that the Voltage Regulator for LCD Driver in TMP87CM24A/P24AF behaved unexpectedly.

The phenomena(1) occurs under the condition.

During driving LCD by using LCD Driver. Power Supply Voltage(Vdd)falls down in very short period(i.e. less than 1 msec.) and comes back within its operating voltage range.(please refer Figure 2-56)

Specification for the phenomena(1)

- a)The "Falling time"should be longer than 1 msec within the range of an operating voltage (at 2.2V to 5.5V,Topr = -10 to 70 °C)
- b)The "Fluctuation of Vdd" should be less than 0.7V,when falling time of Vdd is shorter than 1.msec(at Topr = -10 to 70°C)

The Voltage Regulator for LCD Driver would not generate proper voltage and/or it could take very long time to reach the proper voltage. Then LCD could not display any and/or it could take very long time before displaying any on LCD module.

We have confirmed that the phenomenon(1) can be avoid under the following conditions,

- (1)The Falling time is longer than 1 msec. within the range of an operating voltage (2.2v througe 5.5v),this phenomena will not occur.
- (2)The fluctuation of operating voltage is less than 0.7v with any falling time,this phenomena will not occur.

The phenomena (2) occurs under the condition.

Once the power supply voltage (Vdd) falls down below 2.2 V and comes back above 2.2 V for its operation.
(please refer Figure 2-57)

The Voltage Regulator for LCD Driver will require a few time (e.g. max 1 s/at $T_{opr} = -10^{\circ}\text{C}$) for its warm up. Then all pattern can not appear on LCD module for a few time.

Please enable the LCD control bit (EDSP which is bit 7 of LCDCR) to "1" after waiting for the enough warm up time (Maximum 1 s/ $T_{opr} = -10^{\circ}\text{C}$).

Specification of the phenomena (2)		$T_{opr} = -10 \text{ to } 70^{\circ}\text{C}$			
SYMBOL	ITEM (Conditions)	Min	Typ.	Max	Unit
C1)	Warm Up Time of V1	–	0.1	1	s
C2)	Warm Up Time of V1 (at initial power on)	–	0.1	–	
d)	Warm Up Time of (V2 and V3)				ms
	at $f_c = 8\text{MHz}$, Boost frequency = $f_c/2^{13}$	–	40	–	
	at $f_c = 8\text{MHz}$, Boost frequency = $f_c/2^{11}$	–	10	–	
	at $f_c = 8\text{MHz}$, Boost frequency = $f_c/2^{10}$	–	5	–	
	at $f_c = 8\text{MHz}$, Boost frequency = $f_c/2^9$	–	2.5	–	
	at $f_c = 4\text{MHz}$, Boost frequency = $f_c/2^{13}$	–	80	–	ms
	at $f_c = 4\text{MHz}$, Boost frequency = $f_c/2^{11}$	–	20	–	
	at $f_c = 4\text{MHz}$, Boost frequency = $f_c/2^{10}$	–	10	–	
	at $f_c = 4\text{MHz}$, Boost frequency = $f_c/2^9$	–	5	–	
	at $f_c = 2\text{MHz}$, Boost frequency = $f_c/2^{13}$	–	160	–	ms
	at $f_c = 2\text{MHz}$, Boost frequency = $f_c/2^{11}$	–	40	–	
	at $f_c = 2\text{MHz}$, Boost frequency = $f_c/2^{10}$	–	20	–	
	at $f_c = 2\text{MHz}$, Boost frequency = $f_c/2^9$	–	10	–	

Note 1: Typical value show those at $T_{opr} = 25^{\circ}\text{C}$

Note 2: Common condition for above C1), C2), d) : $0.1 \mu\text{F} \leq C \leq 0.47 \mu\text{F}$

Other specification for phenomena (2)

Please refer the Figure 2-57)

Topr = - 10 to 70 °C

Symbol	Item	Condition		Min	Typ.	Max	Unit
e)	T start of oscillator	fc = 8 MHz	MURATA CSACS8.00MT	—	100	—	μs
		Vdd = 5 V \pm 10%	KYOCERA KBR8.0M	—	100	—	μs
		Cin/out = 10 to 30 pF	TOYOKOM 210B 8.0000	—	1.5	—	ms
		Ta = 25°C	(X' tal)				
		fc = 4 MHz	MURATA CSAC4.00MGC	—	60	—	μs
		Vdd = 5 V \pm 10%	CSA4.00MG	—	60	—	
		Cin/out = 10 to 30 pF	CST4.00MGW	—	60	—	
		Ta = 25°C	KYOCERA KBR 4.0MS	—	60	—	ms
			TOYOKOM 204B 4.0000	—	3.0	—	
			(X' tal)				
		fc = 4 MHz	MURATA CSAC4.00MGC	—	200	—	μs
		Vdd = 3 V \pm 10%	CSA4.00MG	—	200	—	
		Cin/out = 10 to 30 pF	CST4.00MGW	—	200	—	
		Ta = 25°C	KYOCERA KBR 4.0MS	—	200	—	ms
			TOYOKOM 204B 4.0000	—	10	—	
			(X' tal)				
f)	Low pulse period of RESET	after power on		e) x5 + 12/fc	—	—	s

Note: Typical values show those at Topr = 25°C

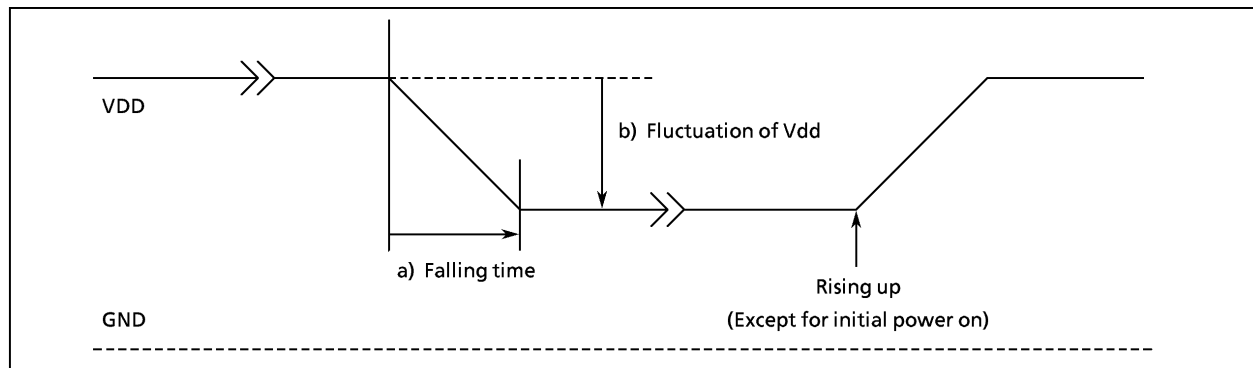


Figure 2-56. The Diagram for the Falling Time of Vdd

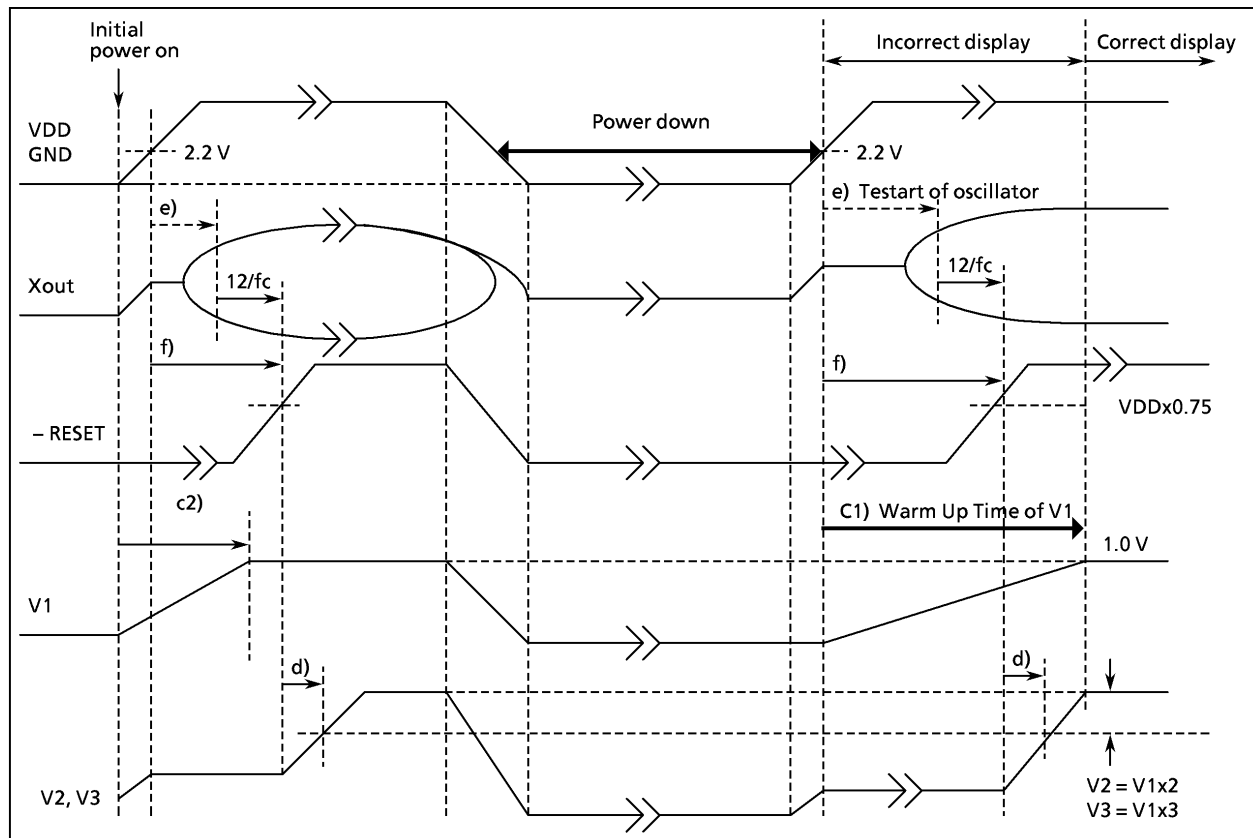


Figure 2-57. The Diagram for the Warm-Up Time of LCD Driver

2.11 8-Bit AD Converter (ADC)

The TMP87CM24A/P24A each have an 8-channel multiplexed-input 8-bit successive approximate type AD converter with sample and hold.

2.11.1 Configuration

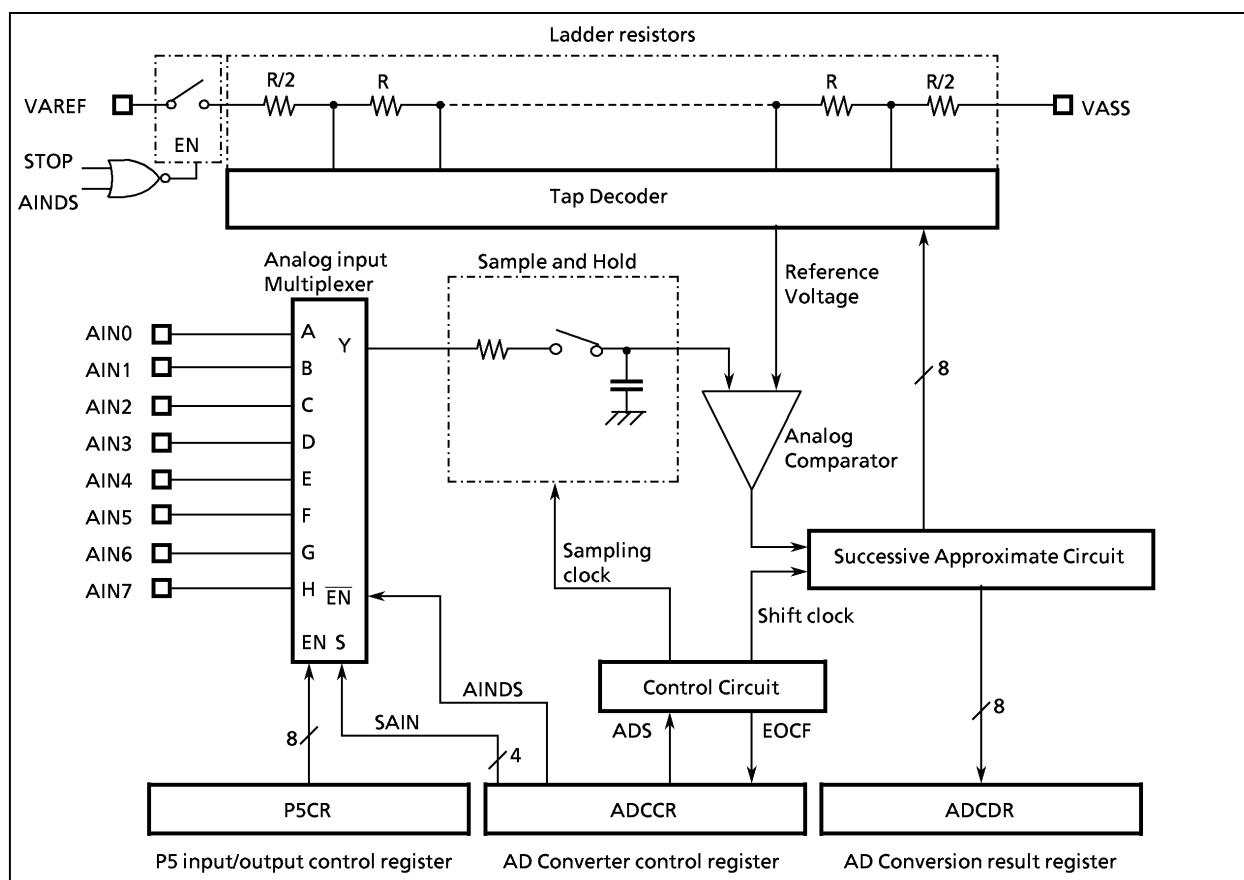
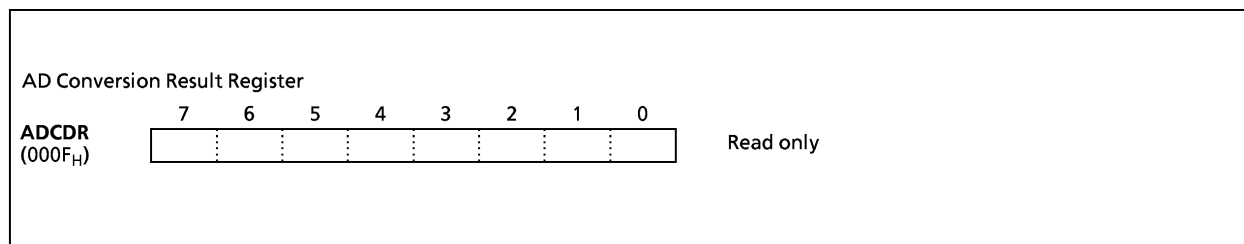


Figure 2-58. AD Converter

2.11.2 Control

The AD converter is controlled by the AD converter control register (ADCCR). Reading EOCF in ADCCR determines the AD converter operating state; reading the AD conversion value register (ADCDR) determines the AD conversion value.



AD Converter Control Register									
ADCCR (000E _H)									
7	6	5	4	3	2	1	0		
EOCF	ADS	ACK	AINDS	SAIN				(Initial value : 0000 0000)	
SAIN	Analog input selection			0000 : AIN0 0001 : AIN1 0010 : AIN2 0011 : AIN3 0100 : AIN4 0101 : AIN5 0110 : AIN6 0111 : AIN7 1*** : Reserved					R/W
AINDS	Analog input control			0 : Enable 1 : Disable					
ACK	Conversion time selection			0 : Conversion time = 23 μ s (at f_c = 8 MHz) 1 : Conversion time = 92 μ s					
ADS	AD conversion start			0 : – 1 : AD conversion start					
EOCF	End of AD conversion flag			0 : Under conversion or Before conversion 1 : End of conversion					

Note 1: *: Don't care

Note 2: Select analog input when AD converter stops.

Note 3: The ADS is automatically cleared to "0" after starting conversion.

Note 4: The EOCF is cleared to "0" when reading the ADCDR.

Note 5: The EOCF is read-only.

Figure 2-59. AD Converter Control Register and AD Conversion Result Register

2.11.3 Operation

The high side of an analog reference voltage is applied to VAREF pin, and the low side is applied to VASS pin. The reference voltage between VAREF and VASS is divided into the voltage corresponding with bits by radar resistance. The reference voltage is compared with an analog input voltage and AD conversion is performed.

(1) Start of AD conversion

Prior to AD conversion start, select one pin among analog input channels (AIN7 to AIN0) using the SAIN (bit 3 to 0 in ADCCR). Clear AINDS (bit 4 in ADDCCR) to 0 and clear the channel to be used for analog input using the P5 I/O control register (P5CR).

Note : Pins not used for analog input can be used as an I/O port; to maintain accuracy, do not use them for output during AD conversion.

Set AD conversion time using the ACK (bit 5 in ADCCR).

To start AD conversion, set AD conversion to "1" using the ADS (bit 6 in ADCCR).

AD conversion time is from AD conversion start to AD conversion result being set in ADCDR. When $ACK = 0$, $184/f_c$ [s] (46 machine cycles) is necessary. That is, when $f_c = 8$ MHz, the AD conversion time is 23 μ s.

After AD conversion, the EOCF (bit 7 in ADCCR) is set to "1" indicating end of conversion.

Setting the ADS to "1" during AD conversion resumes conversion from the beginning.

The analog input voltage is sampled every 4 machine cycles after AD conversion start.

(2) Reading of AD conversion result

After the end of conversion, read the conversion result from the ADCDR.

The EOCF is automatically cleared to "0" when reading the ADCDR. When the conversion result is read out during AD conversion, the invalid value is read out.

(3) AD conversion in STOP mode

When the MCU places in the STOP mode during the AD conversion, the conversion is terminated and the ADCDR contents become indefinite. Thus EOCF is maintained to "0" after returned from the STOP mode.

However, if the STOP mode is started after the end of conversion (EOCF = 1), the ADCDR contents are held.

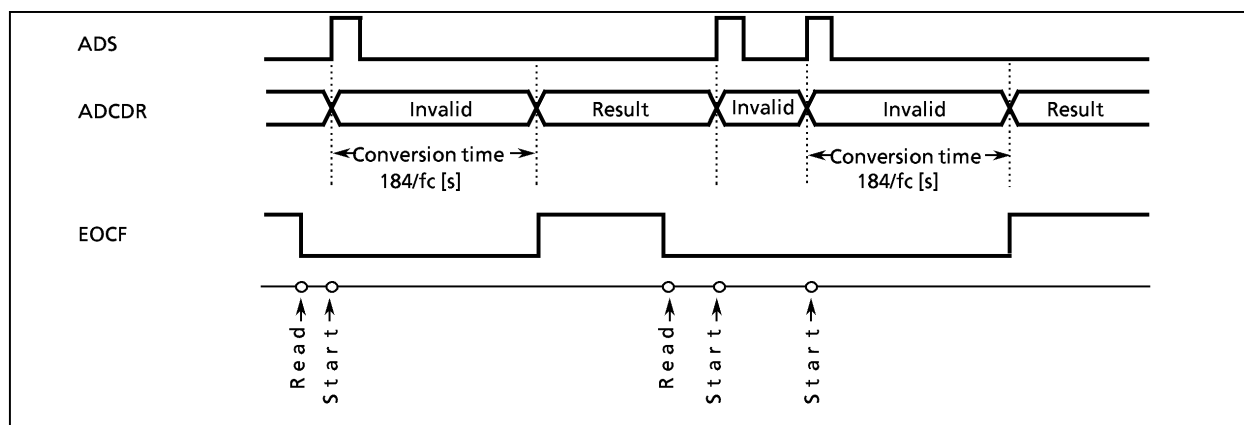


Figure 2-60. AD Conversion Timing Chart

Example: After AIN pin 4 is selected as an analog input channel, AD conversion is started. EOCF is confirmed and the converted result is read out. It is saved to address 009EH in RAM.

```

; AIN SELECT
LD      (ADCCR), 00100100B    ; selects AIN4
; AD CONVERT START
SET     (ADCCR). 6             ; ADS = 1
SLOOP   : TEST      (ADCCR). 7    ; EOCF = 1 ?
JRS     T, SLOOP
; RESULT DATA READ
LD      (9EH), (ADCCR)

```

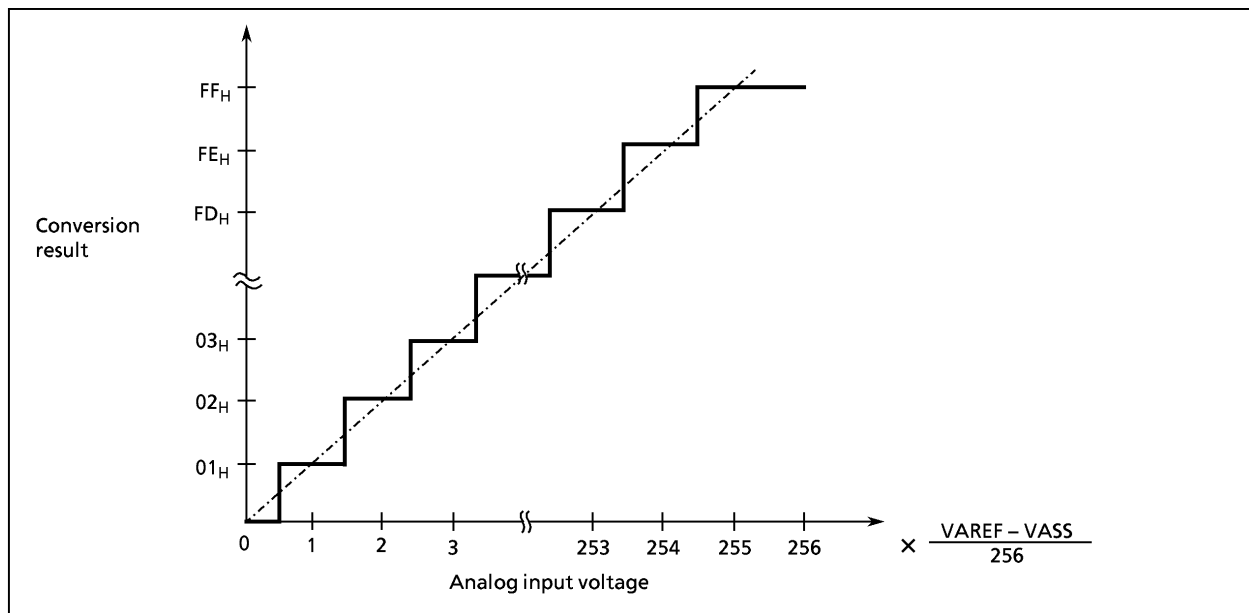


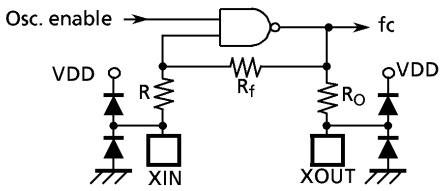
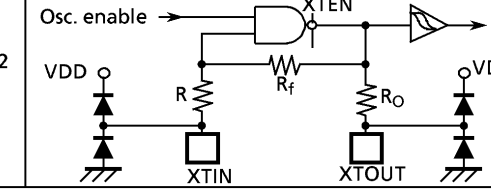
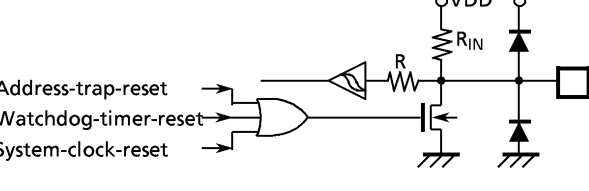
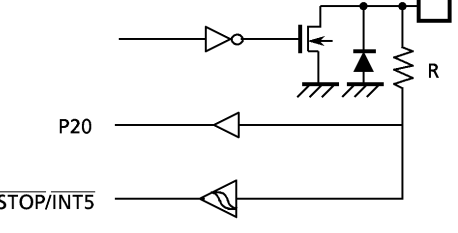
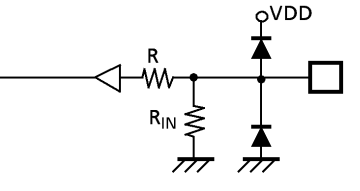
Figure 2-61. Analog Input Voltage vs AD Conversion Result (typ.)

Input/Output Circuitry

(1) Control pins

The input/output circuitries of the TMP87CM24A/P24A control pins are shown below.

Please specify either the single-clock mode or the dual-clock mode by a code (NM1 or NM2) as an option for an operating mode during reset.

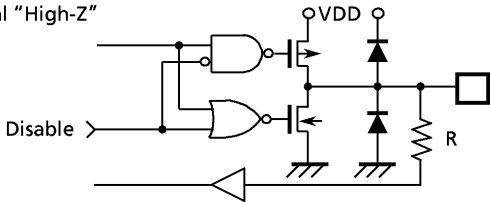
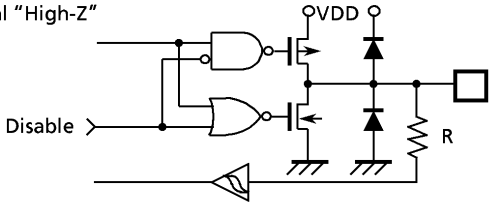
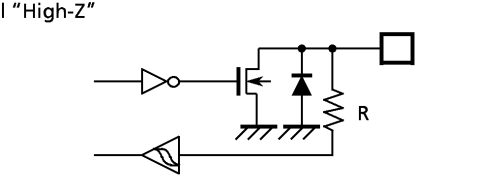
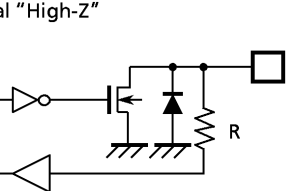
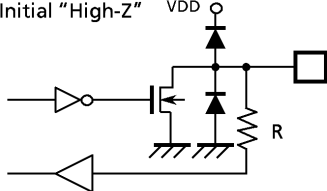
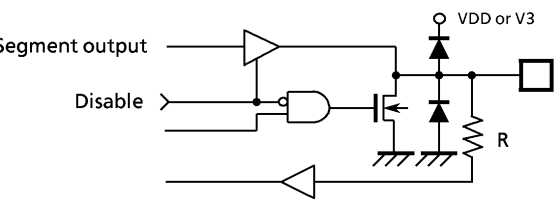
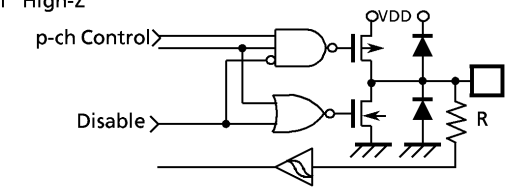
Control Pin	I/O	Input/Output Circuitry		Remarks
XIN XOUT	Input Output			Resonator connecting pins (high-frequency) $R_f = 1.2 \text{ M}\Omega$ (typ.) $R_o = 1.5 \text{ k}\Omega$ (typ.) $R = 1 \text{ k}\Omega$ (typ.)
XTIN XTOUT	Input Output	NM1 Refer to port P2	NM2 	Resonator connecting pins (low-frequency) $R_f = 6 \text{ M}\Omega$ (typ.) $R_o = 220 \text{ k}\Omega$ (typ.) $R = 1 \text{ k}\Omega$ (typ.)
$\overline{\text{RESET}}$	I/O			Sink open drain output Hysteresis input Pull-up resistor $R_{IN} = 220 \text{ k}\Omega$ (typ.) $R = 1 \text{ k}\Omega$ (typ.)
$\overline{\text{STOP/INT5}}$	Input			Hysteresis input $R = 1 \text{ k}\Omega$ (typ.)
TEST	Input			Pull-down resistor $R_{IN} = 70 \text{ k}\Omega$ (typ.) $R = 1 \text{ k}\Omega$ (typ.)

Note1 : The TEST pin of the TMP87PP24A does not have a pull-down resistor. Be sure to fix the TEST pin to low in MCU mode.

Note2 : The TMP87PP24A is placed in the single-clock mode during reset.

(2) Input/Output Ports

The input/output circuitries of the TMP87CM24A/P24A input/output ports are shown below.

Port	I/O	Input/Output Circuitry		
P0 P5	I/O	Initial "High-Z" 		Tri-state I/O R = 1 kΩ (typ.)
P1	I/O	Initial "High-Z" 		Tri-state I/O Hysteresis input R = 1 kΩ (typ.)
P3	I/O	Initial "High-Z" 		Sink open drain output Hysteresis input R = 1 kΩ (typ.)
P2	I/O	P20	P21, P22	Sink open drain output R = 1 kΩ (typ.)
		Initial "High-Z" 	Initial "High-Z" 	
P6 P7 P8 P9	I/O	Segment output Disable 		Sink open drain or Segment output R = 1 kΩ (typ.)
P4	I/O	Initial "High-Z" p-ch Control Disable 		Sink open drain or push-pull output Hysteresis input P41 Nch High current output R = 1 kΩ (typ.)

Electrical Characteristics

Absolute Maximum Ratings		(V _{SS} = 0 V)		
Parameter	Symbol	Pins	Ratings	Unit
Supply Voltage	V _{DD}		– 0.3 to 6.5	V
Input Voltage	V _{IN}		– 0.3 to V _{DD} + 0.3	
Output Voltage	V _{OUT1}	Except P20 and P3 ports	– 0.3 to V _{DD} + 0.3	
	V _{OUT2}	Ports P20, P3	– 0.3 to 5.5	
Output Current (Per 1 pin)	I _{OUT1}	Ports P0, P1, P2, P3, P5, P6, P7, P8, P9, P4 (except P41)	3.2	mA
	I _{OUT2}	P41	30	
Output Current (Total)	Σ I _{OUT1}	Ports P0, P1, P2, P3, P5, P6, P7, P8, P9, P4 (except P41)	120	
	Σ I _{OUT2}	P41	30	
Power Dissipation [T _{opr} = 70°C]	PD		350	mW
Soldering Temperature (time)	T _{sld}		260 (10 s)	°C
Storage Temperature	T _{stg}		– 55 to 125	
Operating Temperature	T _{opr}		– 10 to 70	

Note: The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

Recommended Operating Conditions			(V _{SS} = 0 V, T _{opr} = – 10 to 70°C)				
Parameter	Symbol	Pins	Conditions		Min	Max	Unit
Supply Voltage	V _{DD}		f _c = 8 MHz	NORMAL1, 2 mode	4.5	5.5	V
				IDLE1, 2 mode			
			f _c = 4.2 MHz	NORMAL1, 2 mode	2.2		
				IDLE1, 2 mode			
			f _s = 32.768 kHz	SLOW mode	2.0		
				SLEEP mode			
	STOP mode						
Input High Voltage	V _{IH1}	Except hysteresis input	V _{DD} ≥ 4.5 V		V _{DD} × 0.70	V _{DD}	
	V _{IH2}	Hysteresis input			V _{DD} × 0.75		
	V _{IH3}		V _{DD} < 4.5 V	V _{DD} × 0.90			
Input Low Voltage	V _{IL1}	Except hysteresis input	V _{DD} ≥ 4.5 V		0	V _{DD} × 0.30	
	V _{IL2}	Hysteresis input				V _{DD} × 0.25	
	V _{IL3}		V _{DD} < 4.5 V	V _{DD} × 0.10			
Clock Frequency	f _c	XIN, XOUT	V _{DD} = 4.5 to 5.5 V		0.4	8.0	MHz
			V _{DD} = 2.2 to 5.5 V			4.2	
	f _s	XTIN, XTOUT			30.0	34.0	kHz

Note 1: The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

Note 2: Clock frequency fc: Supply voltage range is specified in NORMAL1/2 mode and IDLE1/2 mode.

DC Characteristics

(V_{SS} = 0 V, T_{opr} = -10 to 70°C)

Parameter	Symbol	Pins	Conditions	Min	Typ.	Max	Unit
Hysteresis Voltage	V _{HS}	Hysteresis inputs		—	0.9	—	V
Input Current	I _{IN1}	TEST	V _{DD} = 5.5 V, V _{IN} = 5.5 V/0 V	—	—	± 2	μA
	I _{IN2}	Open-drain ports and tri-state ports					
	I _{IN3}	RESET, STOP					
Input Low Current	I _{IL}	Push-pull ports	V _{DD} = 5.5 V, V _{IN} = 0.4 V	—	—	– 2	mA
Input Resistance	R _{IN2}	RESET		100	220	450	kΩ
Output Leakage Current	I _{LO1}	Open drain ports	V _{DD} = 5.5 V, V _{OUT} = 5.5 V	—	—	2	μA
	I _{LO2}	Tri-state ports	V _{OUT} = 5.5 V/0 V	—	—	± 2	
Segment/Common Output Voltage	V _{LCD1}	SEG39 to SEG0 and COM3 to COM0		0.75	1.0	1.33	V
	V _{LCD2}			V _{LCD1} × 2			
	V _{LCD3}			V _{LCD1} × 3			
Output High Voltage	V _{OH1}	Push-pull ports (P4 port)	V _{DD} = 4.5 V, I _{OH} = – 200 μA	2.4	—	—	V
	V _{OH2}	Tri- state ports (P0, P1, P5 ports)	V _{DD} = 4.5 V, I _{OH} = – 0.7 mA	4.1	—	—	
Output Low Voltage	V _{OL}	Except XOUT and P41	V _{DD} = 4.5 V, I _{OL} = 1.6 mA	—	—	0.4	
Output Low Current	I _{OL3}	P41	V _{DD} = 4.5 V, V _{OL} = 1.0 V	—	20	—	
Supply Current in NORMAL 1, 2 mode	I _{DD}		V _{DD} = 5.5 V f _c = 8 MHz f _s = 32.768 kHz V _{IN} = 5.3 V/0.2 V	—	10	16	mA
Supply Current in IDLE 1, 2 mode				—	6	10	
Supply Current in SLOW mode			V _{DD} = 3.0 V f _s = 32.768 kHz V _{IN} = 2.8 V/0.2 V Voltage boost frequency = 1 kHz	—	30	70	μA
Supply Current in SLEEP mode				—	15	40	
Supply Current in STOP mode			V _{DD} = 5.5 V V _{IN} = 5.3 V/0.2 V	—	0.5	10	

Note 1: Typical values show those at T_{opr} = 25°C, V_{DD} = 5 V.

Note 2: Input Current; The current through pull-up or pull-down resistor is not included.

Note 3: I_{DD}; Except for I_{REF}Note 4: V_{LCD2} indicates an output voltage at the 2/3 level when operating in the 1/4 or 1/3 duty mode.Note 5: V_{LCD1} indicates an output voltage at the 1/3 level when operating in the 1/4 or 1/3 duty mode.

Note 6: SEG/COM output voltage indicates an output voltage at no local.

Topr [°C]	V _{LCD1}			Unit
	Min	typ.	Max	
-10	1.03	—	1.33	V
25	0.85	1.0	1.15	
70	0.75	—	1.00	

AD Conversion Characteristics (I)

(Topr = - 10 to 70°C)

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Analog Reference Voltage	V_{AREF}	$V_{AREF} - V_{ASS} \geq 2.5 \text{ V}$	2.7	—	V_{DD}	V
	V_{ASS}		V_{SS}	—	1.5	
Analog Input Voltage	ΔV_{AREF}		2.5	—	—	
Analog Input Voltage	V_{AIN}		V_{ASS}	—	V_{AREF}	
Analog Supply Current	I_{REF}	$V_{AREF} = 5.5 \text{ V}, V_{ASS} = 0.0 \text{ V}$	—	0.5	1.0	mA
Nonlinearity Error		$V_{DD} = 2.7 \text{ V to } 5.0 \text{ V}, V_{SS} = 0.0 \text{ V}$ $V_{AREF} = 5.000 \text{ V}, 2.700 \text{ V}$ $V_{ASS} = 0.000 \text{ V}$	—	—	± 1	LSB
Zero Point Error			—	—	± 1	
Full Scale Error			—	—	± 1	
Total Error			—	—	± 2	

Note: Quantizing error is not contained in those errors.

AD Conversion Characteristics (II)

(Topr = - 10 to 70°C)

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Analog Reference Voltage	V _{AREF}		2.2	—	V _{DD}	V
	V _{ASS}		V _{SS}			
Analog Input Voltage	△V _{AREF}		2.2	—	—	
Analog Input Voltage	V _{AIN}		V _{ASS}	—	V _{AREF}	
Analog Supply Current	I _{REF}	V _{AREF} = 5.5 V, V _{ASS} = 0.0 V	—	0.5	1.0	mA
Nonlinearity Error		V _{DD} = 2.2 V, V _{SS} = 0.0 V V _{AREF} = 2.200 V V _{ASS} = 0.000 V	—	—	± 2	LSB
Zero Point Error			—	—	± 2	
Full Scale Error			—	—	± 2	
Total Error			—	—	± 4	

Note: Quantizing error is not contained in those errors.

AC Characteristics (I)

(V_{SS} = 0 V, V_{DD} = 4.5 to 5.5 V, T_{opr} = – 10 to 70°C)

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Machine Cycle Time	t _{cy}	In NORMAL1, 2 modes	0.5	–	10	μs
		In IDLE 1, 2 modes				
		In SLOW mode	117.6	–	133.3	
		In SLEEP mode				
High Level Clock Pulse Width	t _{WCH}	For external clock operation (XIN input), f _c = 8 MHz	50	–	–	ns
Low Level Clock Pulse Width	t _{WCL}					
High Level Clock Pulse Width	t _{WSH}	For external clock operation (XTIN input), f _s = 32.768 kHz	14.7	–	–	μs
Low Level Clock Pulse Width	t _{WSL}					

AC Characteristics (II)

(V_{SS} = 0 V, V_{DD} = 2.2 to 5.5 V, T_{opr} = – 10 to 70°C)

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Machine Cycle Time	t _{cy}	In NORMAL1, 2 modes	0.95	–	10	μs
		In IDLE 1, 2 modes				
		In SLOW mode	117.6	–	133.3	
		In SLEEP mode				
High Level Clock Pulse Width	t _{WCH}	For external clock operation (XIN input), f _c = 4.2 MHz	110	–	–	ns
Low Level Clock Pulse Width	t _{WCL}					
High Level Clock Pulse Width	t _{WSH}	For external clock operation (XTIN input), f _s = 32.768 kHz	14.7	–	–	μs
Low Level Clock Pulse Width	t _{WSL}					

Recommended Oscillating Condition (I)

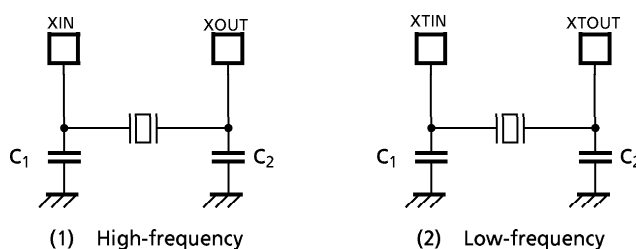
 $(V_{SS} = 0\text{ V}, V_{DD} = 4.5\text{ to }5.5\text{ V}, T_{opr} = -10\text{ to }70^{\circ}\text{C})$

Parameter	Oscillator	Frequency	Recommender Oscillator	Recommended Condition	
				C ₁	C ₂
High-frequency	Ceramic Resonator	8 MHz	KYOCERA KBR8.0M	30 pF	30 pF
			Standard/Lead Type (MURATA) CSA8.00MTZ CST8.00MTW	built-in 30 pF	built-in 30 pF
			Standard/SMP Type (MURATA) CSAC58.00MT	30 pF	30 pF
			Standard/Small Chip Type (MURATA) CSTCS8.00MT	built-in 30 pF	built-in 30 pF
	Crystal Oscillator	4 MHz	KYOCERA KBR4.0M5	30 pF	30 pF
		8 MHz	TOYOCOM 210B 8.0000	20 pF	20 pF
Low-frequency	Crystal Oscillator	4 MHz	TOYOCOM 204B 4.0000		
		32.768 kHz	NDK MX-38T	15 pF	15 pF

Recommended Oscillating Condition (II)

 $(V_{SS} = 0\text{ V}, V_{DD} = 2.2\text{ to }5.5\text{ V}, T_{opr} = -10\text{ to }70^{\circ}\text{C})$

Parameter	Oscillator	Frequency	Recommender Oscillator	Recommended Condition	
				C ₁	C ₂
High-frequency	Ceramic Resonator	4 MHz	Standard/Lead Type (MURATA) CSA4.00MG	30 pF	30 pF
			CST4.00MGW	built-in 30 pF	built-in 30 pF
			Standard/SMD Type (MURATA) CSA4.00MGC CSAC4.00MGCM CSTC4.00MG	30 pF	30 pF
				built-in 30 pF	built-in 30 pF
			Standard/Small Chip Type CSTCS4.00MG	built-in 10 pF	built-in 10 pF



Note1: When used in high electric field such as a picture tube, the package is recommended to be electrically shielded to maintain a regular operation.

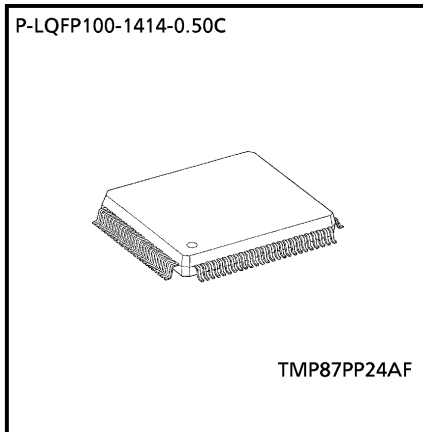
Note2: The product numbers and specifications of the resonators by Murata Manufacturing Co., Ltd. are subject to change. For up-to-date information, please refer to the following URL;
<http://www.murata.co.jp/search/index.html>

CMOS 8-Bit Microcontroller

TMP87PP24AF

The TMP87PP24A is a One-Time PROM microcontroller with low-power 384 Kbits electrically programmable read only memory for the TMP87CM24A/CP24A system evaluation. The TMP87PP24A is pin compatible with the TMP87CM24A/CP24A. The operations possible with the TMP87CM24A/CP24A can be performed by writing programs to PROM. The TMP87PP24A can write and verify in the same way as the TMM571000D using an adaptor socket BM11127 and an EPROM programmer.

Product No.	OTP	RAM	Package	OTP Adapter
TMP87PP24AF	48 K × 8 bits	2 K × 8 bits	P-LQFP100-1414-0.50C	BM11127

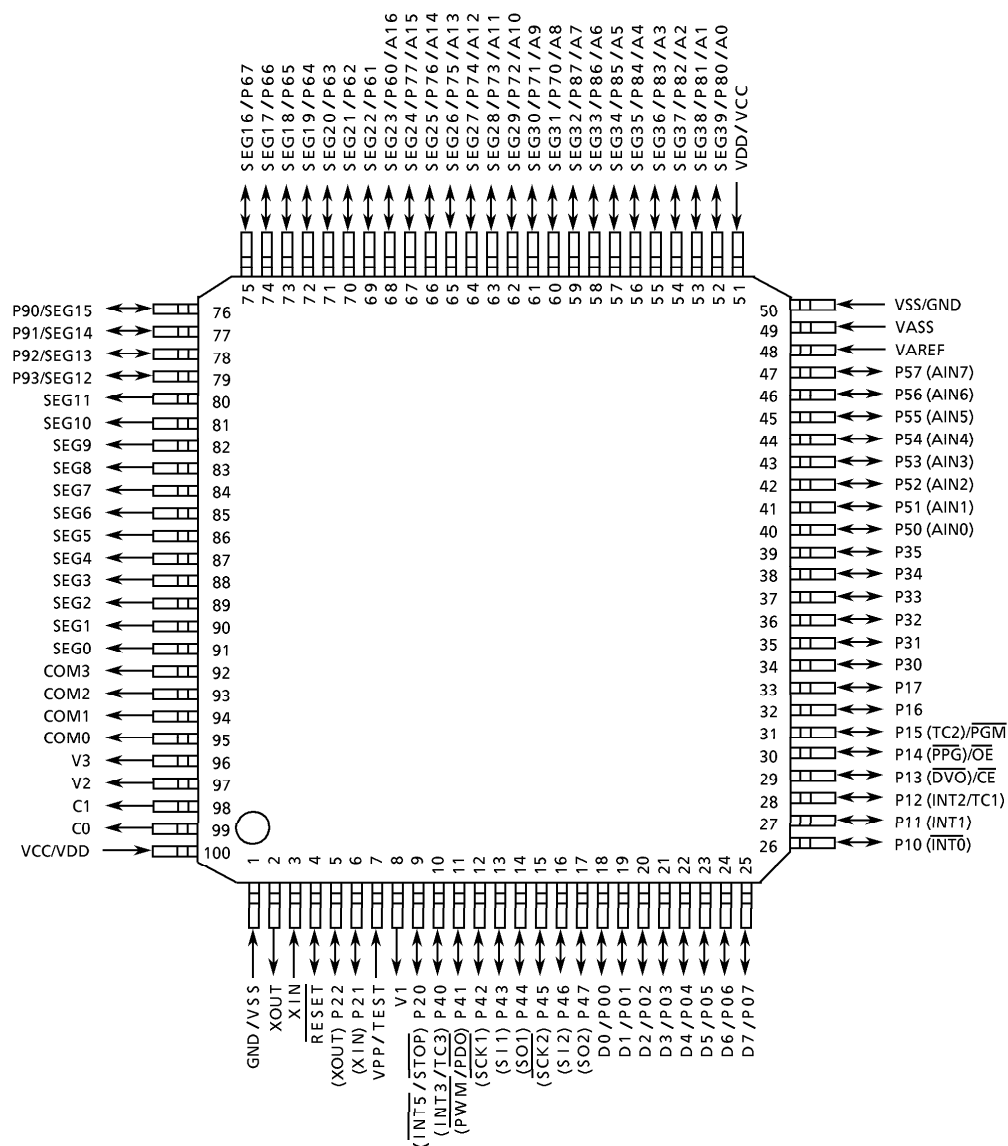


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- The information contained herein is subject to change without notice.

Pin Assignments (Top View)

P-LQFP100-1414-0.50C



Pin Function

The TMP87PP24A has two modes: MCU and PROM.

(1) MCU mode

In this mode, the TMP87PP24A is pin compatible with the TMP87CM24A/CP24A (fix the TEST pin at low level.)

(2) PROM mode

Pin Name (PROM mode)	Input/Output	Function	Pin Name (MCU mode)
A16	Input	PROM address inputs	P60
A15 to A8			P77 to P70
A7 to A0			P87 to P80
D7 to D0	I/O	PROM data input/outputs	P07 to P00
\overline{CE}	Input	Chip enable signal input (active low)	P13
\overline{OE}		Output enable signal input (active low)	P14
\overline{PGM}		Program mode signal input	P15
VPP	Power supply	+ 12.75 V/5 V (Program supply voltage)	TEST
VCC		+ 6.25 V/5 V	VDD
GND		0 V	VSS
P35 to P30	I/O	Pull-up with resistance for input processing.	
P47 to P40			
P57 to P50			
P67 to P62			
P93 to P90			
P11		PROM mode setting pin. Be fixed at high level.	
P21			
P31			
P61		PROM mode setting pin. Be fixed at low level.	
P17, P16, P12, P10			
P22, P20			
\overline{RESET}			
XIN	Input	Connect an 8 MHz oscillator to stabilize the internal state.	
XOUT	Output		
VAREF	Power supply	0 V (GND)	
VASS			
COM3 to COM0	Output	Open	
SEG11 to SEG0			
C0, C1, V1, V2, V3	Power supply		

Operational Description

The following explains the TMP87PP24A hardware configuration and operation. The configuration and functions of the TMP87PP24A are the same as those of the TMP87CM24A/CP24A, except in that a one-time PROM is used instead of an on-chip mask ROM.

The TMP87PP24A is placed in the *single-clock* mode during reset. To use the dual-clock mode, the low-frequency oscillator should be turned on by executing [SET (SYSCR2). XTEN] instruction at the beginning of the program.

1. Operating Mode

The TMP87PP24A has two modes: MCU and PROM.

1.1 MCU Mode

The MCU mode is activated by fixing the TEST/VPP pin at low level.

In the MCU mode, operation is the same as with the TMP87CM24A/CP24A (the TEST/VPP pin cannot be used open because it has no built-in pull-down resistance).

1.1.1 Program Memory

The TMP87PP24A has a 48K × 8-bit (addresses 4000_H to FFFF_H in the MCU mode, addresses 14000_H to 1FFFF_H in the PROM mode) of program memory (OTP).

When the TMP87PP24A is used as a system evaluation of the TMP87CM24A/CP24A, the data is written to the program storage area show in Figure 1-1.

Note : Either write the data FF_H to the unused area or set the PROM programmer to access only the program storage area.

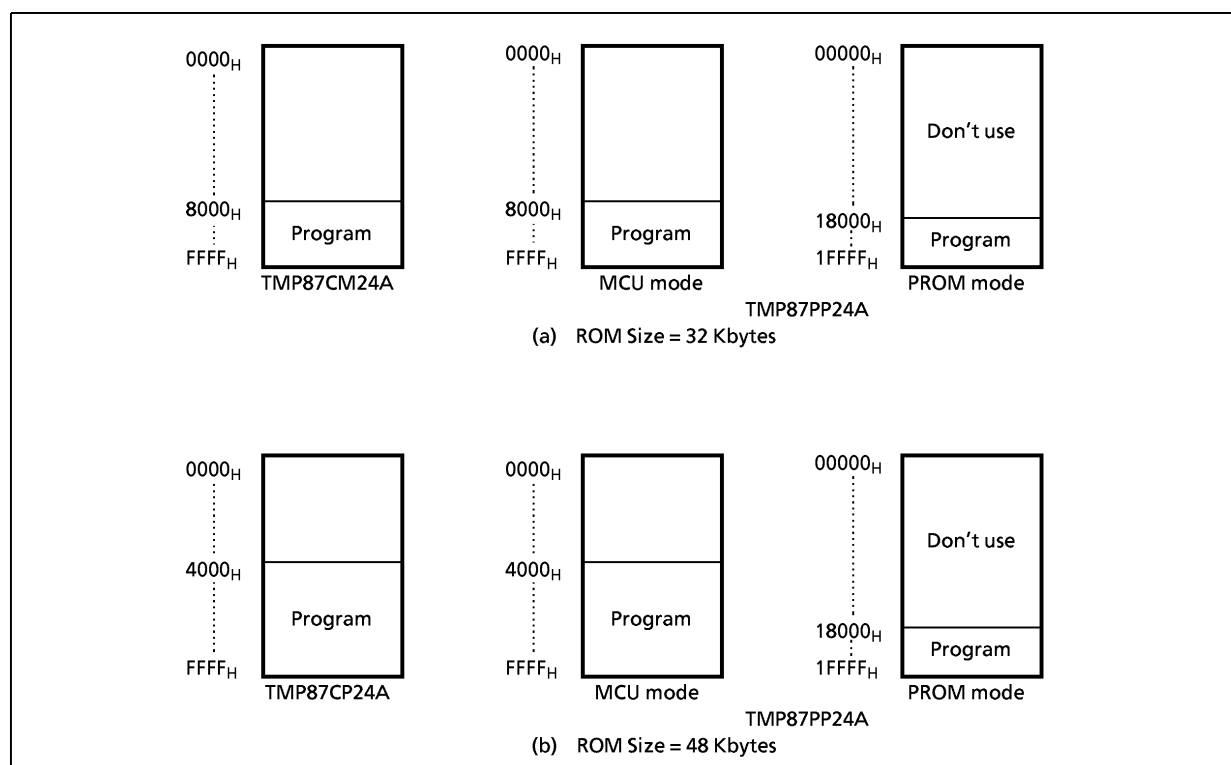


Figure 1-1. Program Memory Area

1.1.2 Data Memory

The TMP87PP24A has an on-chip 2K × 8-bit data memory (static RAM).

1.1.3 Input/Output Circuitry

(1) Control pins

The control pins of the TMP87PP24A are the same as those of the TMP87CM24A/CP24A except that the TEST pin has no built-in pull-down resistance.

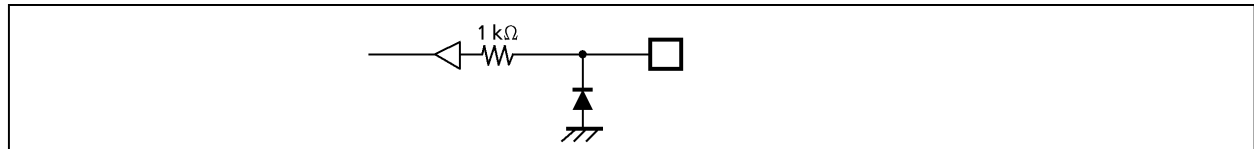


Figure 1-2. TEST Pin

(2) I/O ports

The I/O circuits of TMP87PP24A I/O ports are the same as those of TMP87CM24A/CP24A.

1.2 PROM Mode

The PROM mode is activated by setting the TEST, $\overline{\text{RESET}}$ pin and the ports P17 to P10, P22 to P20 and P61 as shown in Figure 1-3. The PROM mode is used to write and verify programs with a general-purpose PROM programmer.

Note: The high-speed programming mode can be used for program operation.

The TMP87PP24A is not supported an electric signature mode, so the ROM type must be set to TC571000D.

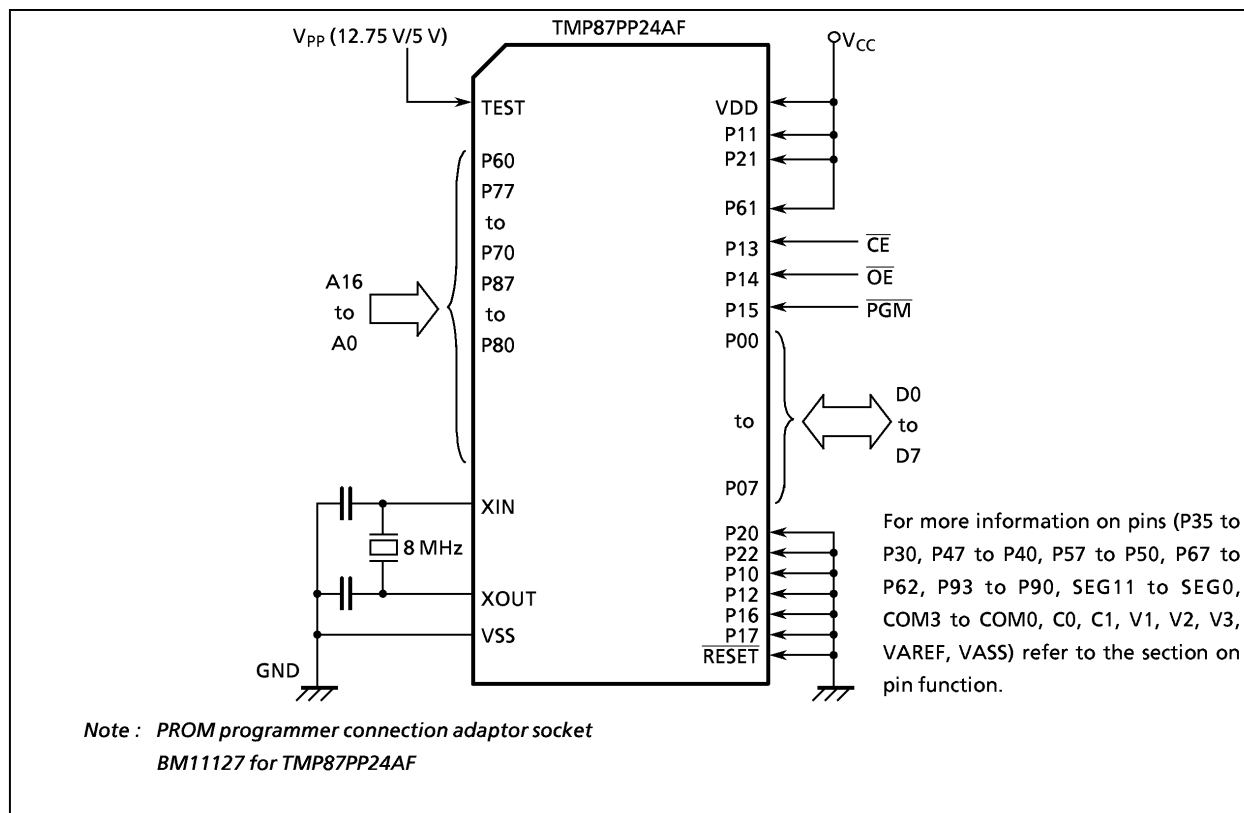


Figure 1-3. Setting for PROM Mode

1.2.1 Programming Flowchart (High-speed Programming Mode)

The high-speed programming mode is achieved by applying the program voltage (+ 12.75 V) to the VPP pin when $V_{CC} = 6.25$ V. After the address and input data are stable, the data is programmed by applying a single 0.1 ms program pulse to the \overline{PGM} input. The programmed data is verified. If incorrect, another 0.1 ms program pulse is applied. This process should be repeated (up to 25 times) until the program operates correctly. After that, change the address and input data, and program as before. When programming has been completed, the data in all addresses should be verified with $V_{CC} = V_{PP} = 5$ V.

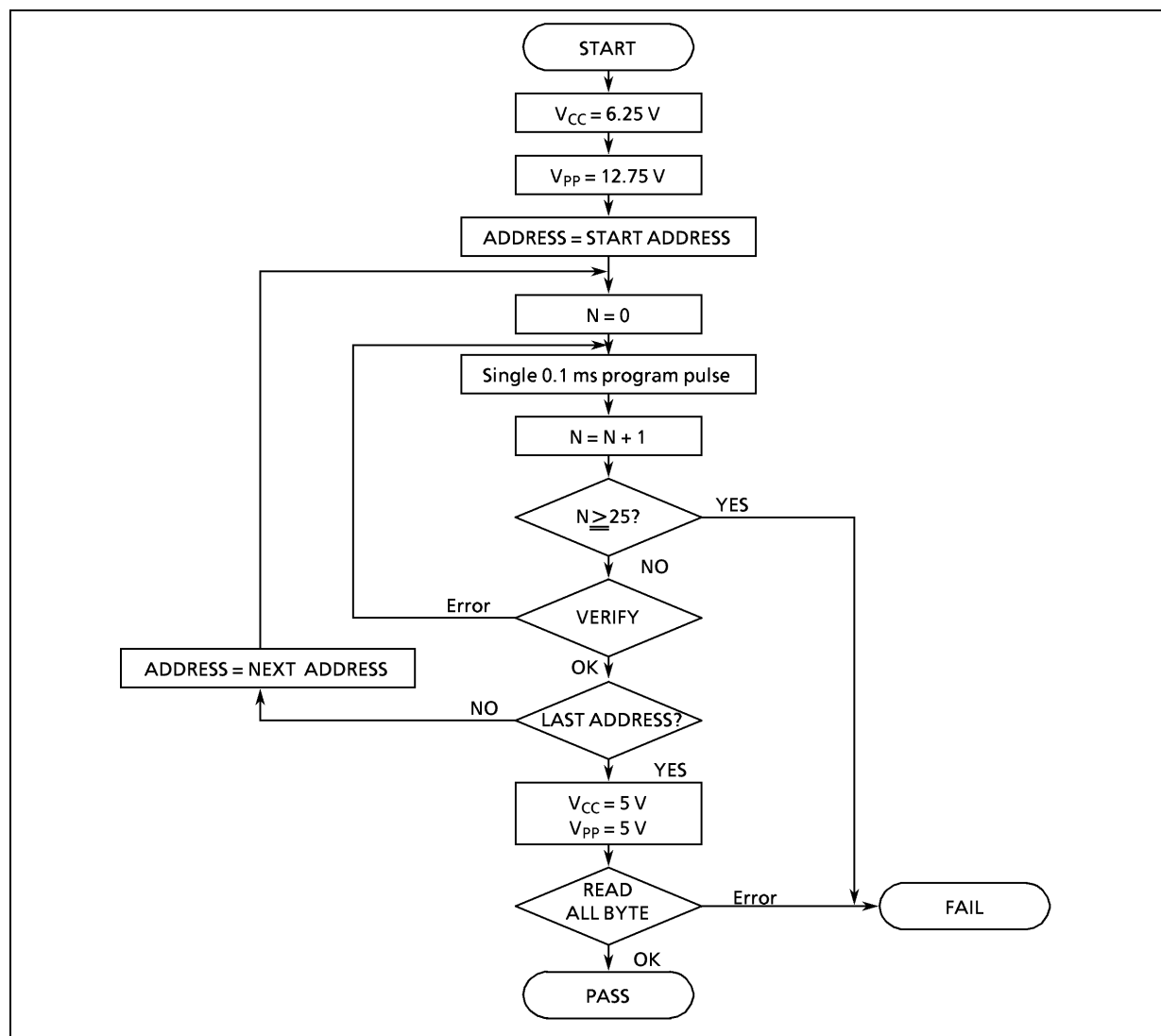


Figure 1-4. Flow Chart of High-speed Programming

1.2.2 Writing Method for General-purpose PROM Program

- (1) Adapters
BM11127 : TMP87PP24AF
- (2) Adapter setting
Switch (SW1) is set to side N.
- (3) PROM programmer specifying
 - i) PROM type is specified to TC571000D.
Writing voltage: 12.75 V (high-speed program mode)
 - ii) Data transfer (copy) (note 1)
In the TMP87PP24A, EPROM is within the addresses 14000_H to 1FFFF_H. Data is required to be transferred (copied) to the addresses where it is possible to write. The program area in MCU mode and PROM mode is referred to "Program memory area" in Figure 1-1.

Ex. In the block transfer (copy) mode, executed as below.
ROM capacity of 48KB : transferred addresses 04000_H to 0FFFF_H to addresses 14000 to 1FFFF_H
 - iii) Writing address is specified. (Note 1)
Start address : 14000_H
End address : 1FFFF_H
- (4) Writing
Writing/Verifying is required to be executed in accordance with PROM programmer operating procedure.

Note 1 : The specifying method is referred to the PROM programmer description. Either write the data FF_H to the unused area or set the PROM programmer to access only the program storage area.

Note 2 : When MCU is set to an adapter or the adapter is set to PROM programmer, a position of pin 1 must be adjusted. If the setting is reversed, MCU, the adapter and PROM program is damaged.

Note 3 : The TMP87PP24A does not support the electric signature mode (hereinafter referred to as "signature"). If the signature is used in PROM program, a device is damaged due to applying 12V ± 0.5V to the address pin 9 (A9). The signature must not be used.

Electrical Characteristics

Absolute Maximum Ratings

(V_{SS} = 0 V)

Parameter	Symbol	Pins	Ratings	Unit
Supply Voltage	V _{DD}		– 0.3 to 6.5	V
Program Voltage	V _{PP}	TEST/V _{PP}	– 0.3 to 13.0	
Input Voltage	V _{IN}		– 0.3 to V _{DD} + 0.3	
Output Voltage	V _{OUT1}	Except P20 and P3 ports	– 0.3 to V _{DD} + 0.3	
	V _{OUT2}	Ports P20, P3	– 0.3 to 5.5	
Output Current (Per 1 pin)	I _{OUT1}	Ports P0, P1, P2, P3, P5, P6, P7, P8, P9, P4 (except P41)	3.2	mA
	I _{OUT2}	P41	30	
Output Current (Total)	Σ I _{OUT1}	Ports P0, P1, P2, P3, P5, P6, P7, P8, P9, P4 (except P41)	120	
	Σ I _{OUT2}	P41	30	
Power Dissipation [Topr = 70°C]	PD		350	mW
Soldering Temperature (time)	Tsld		260 (10 s)	°C
Storage Temperature	Tstg		– 55 to 125	
Operating Temperature	Topr		– 10 to 70	

Note: The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

Recommended Operating Conditions

(V_{SS} = 0V, Topr = – 10 to 70°C)

Parameter	Symbol	Pins	Conditions		Min	Max	Unit
Supply Voltage	V _{DD}		f _c = 8 MHz	NORMAL1, 2 mode	4.5	5.5	V
				IDLE1, 2 mode			
			f _c = 4.2 MHz	NORMAL1, 2 mode	2.2		
				IDLE1, 2 mode			
			f _s = 32.768 kHz	SLOW mode			
				SLEEP mode			
	STOP mode	2.0					
Input High Voltage	V _{IH1}	Except hysteresis input	V _{DD} ≥ 4.5 V		V _{DD} × 0.70	V _{DD}	
	V _{IH2}	Hysteresis input			V _{DD} × 0.75		
	V _{IH3}		V _{DD} < 4.5 V	V _{DD} × 0.90			
Input Low Voltage	V _{IL1}	Except hysteresis input	V _{DD} ≥ 4.5 V		0	V _{DD} × 0.30	
	V _{IL2}	Hysteresis input				V _{DD} × 0.25	
	V _{IL3}		V _{DD} < 4.5 V	V _{DD} × 0.10			
Clock Frequency	f _c	XIN, XOUT	V _{DD} = 4.5 to 5.5 V		0.4	8.0	MHz
			V _{DD} = 2.2 to 5.5 V			4.2	
	f _s	XTIN, XTOUT			30.0	34.0	kHz

Note 1: The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

Note 2: Clock frequency fc: Supply voltage range is specified in NORMAL1/2 mode and IDLE1/2 mode.

DC Characteristics

(V_{SS} = 0 V, T_{opr} = – 10 to 70°C)

Parameter	Symbol	Pins	Conditions	Min	Typ.	Max	Unit
Hysteresis Voltage	V _{HS}	Hysteresis inputs		—	0.9	—	V
Input Current	I _{IN1}	TEST	V _{DD} = 5.5 V, V _{IN} = 5.5 V/0 V	—	—	± 2	μA
	I _{IN2}	Open drain ports and tri-state ports					
	I _{IN3}	RESET, STOP					
Input Resistance	R _{IN2}	RESET		100	220	450	kΩ
Output Leakage Current	I _{LO1}	Open drain ports	V _{DD} = 5.5 V, V _{OUT} = 5.5 V	—	—	2	μA
	I _{LO2}	Tri-state ports	V _{OUT} = 5.5 V/0 V	—	—	± 2	
Segment/Common Output Voltage	V _{LCD1}	SEG39 to SEG0 and COM3 to COM0		0.75	1.0	1.33	V
	V _{LCD2}			V _{LCD1} × 2			
	V _{LCD3}			V _{LCD1} × 3			
Output High Voltage	V _{OH1}	Push-pull ports (P4 port)	V _{DD} = 4.5 V, I _{OH} = – 200 μA	2.4	—	—	
	V _{OH2}	Tri-state ports (P0, P1, P5 ports)	V _{DD} = 4.5 V, I _{OH} = – 0.7 mA	4.1	—	—	
Output Low Voltage	V _{OL}	Except XOUT and P41	V _{DD} = 4.5 V, I _{OL} = 1.6 mA	—	—	0.4	
Output Low Current	I _{OL3}	P41	V _{DD} = 4.5 V, V _{OL} = 1.0 V	—	20	—	mA
Supply Current in NORMAL 1, 2 mode	I _{DD}		V _{DD} = 5.5 V f _c = 8 MHz f _s = 32.768 kHz V _{IN} = 5.3 V/0.2 V	—	12	18	
Supply Current in IDLE 1, 2 mode				—	6	10	
Supply Current in SLOW mode			V _{DD} = 3.0 V f _s = 32.768 kHz V _{IN} = 2.8 V/0.2 V Voltage boost frequency = 1 kHz	—	31	70	μA
Supply Current in SLEEP mode				—	16	40	
Supply Current in STOP mode			V _{DD} = 5.5 V V _{IN} = 5.3 V/0.2 V	—	0.5	10	

Note 1: Typical values show those at T_{opr} = 25°C, V_{DD} = 5 V.

Note 2: Input Current ; The current through pull-up or pull-down resistor is not included.

Note 3: I_{DD} ; Except for I_{REF}

Note 4: V_{LCD2} indicates an output voltage at the 2/3 level when operating in the 1/4 or 1/3 duty mode.

Note 5: V_{LCD1} indicates an output voltage at the 1/3 level when operating in the 1/4 or 1/3 duty mode.

AD Conversion Characteristics (I)

(V_{SS} = 0 V, V_{DD} = 2.7 to 5.5 V, T_{opr} = – 10 to 70°C)

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Analog Reference Voltage	V _{AREF}		2.7	–	V _{DD}	V
	V _{ASS}		V _{SS}	–	1.5	
Analog Input Voltage	V _{AIN}		V _{ASS}	–	V _{AREF}	
Analog Supply Current	I _{REF}	V _{AREF} = 5.5 V, V _{ASS} = 0.0 V	–	0.5	1.0	mA
Nonlinearity Error		V _{DD} = 5.0 V, V _{SS} = 0.0 V V _{AREF} = 5.000 V V _{ASS} = 0.000 V or V _{DD} = 2.7 V, V _{SS} = 0.0 V V _{AREF} = 2.700 V V _{ASS} = 0.000 V	–	–	± 1	LSB
Zero Point Error			–	–	± 1	
Full Scale Error			–	–	± 1	
Total Error			–	–	± 2	

Note: Quantizing error is not contained in those errors.

AD Conversion Characteristics (II)

(V_{SS} = 0V, V_{DD} = 2.2 to 2.7V, T_{opr} = – 10 to 70°C)

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Analog Reference Voltage	V _{AREF}		2.2	—	V _{DD}	V
	V _{ASS}		V _{SS}			
Analog Reference Voltage Range	△ V _{AREF}		2.2	—	—	
Analog Input Voltage	V _{AIN}		V _{ASS}	—	V _{AREF}	
Analog Supply Current	I _{REF}	V _{AREF} = 5.5 V, V _{ASS} = 0.0 V	—	0.5	1.0	mA
Nonlinearity Error		V _{DD} = 2.2 V, V _{SS} = 0.0 V V _{AREF} = 2.200 V V _{ASS} = 0.000 V	—	—	± 2	LSB
Zero Point Error			—	—	± 2	
Full Scale Error			—	—	± 2	
Total Error			—	—	± 4	

Note: Quantizing error is not contained in those errors.

AC Characteristics (I)

(V_{SS} = 0V, V_{DD} = 4.5 to 5.5V, T_{opr} = - 10 to 70°C)

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Machine Cycle Time	t _{cy}	In NORMAL 1, 2 mode	0.95	—	10	μs
		In IDLE 1, 2 mode				
		In SLOW mode	117.6	—	133.3	
		In SLEEP mode				
High Level Clock Pulse Width	t _{WCH}	For external clock operation (XIN input), f _c = 8 MHz	50	—	—	ns
Low Level Clock Pulse Width	t _{WCL}					
High Level Clock Pulse Width	t _{WSH}	For external clock operation (XTIN input), f _s = 32.768 kHz	14.7	—	—	μs
Low Level Clock Pulse Width	t _{WSL}					

AC Characteristics (II)

(V_{SS} = 0 V, V_{DD} = 2.2 to 5.5 V, T_{opr} = - 10 to 70°C)

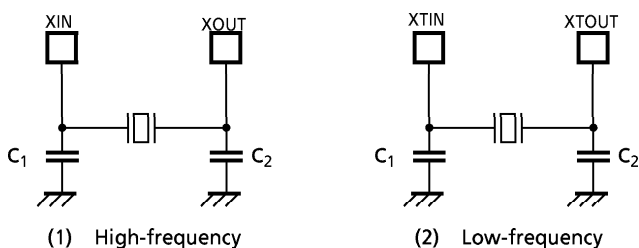
Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Machine Cycle Time	t _{cy}	In NORMAL 1, 2 mode	0.95	—	10	μs
		In IDLE 1, 2 mode				
		In SLOW mode	117.6	—	133.3	
		In SLEEP mode				
High Level Clock Pulse Width	t _{WCH}	For external clock operation (XIN input), f _c = 4.2 MHz	110	—	—	ns
Low Level Clock Pulse Width	t _{WCL}					
High Level Clock Pulse Width	t _{WSH}	For external clock operation (XTIN input), f _s = 32.768 kHz	14.7	—	—	μs
Low Level Clock Pulse Width	t _{WSL}					

Recommended Oscillating Condition (I) ($V_{SS} = 0\text{ V}$, $V_{DD} = 4.5\text{ to }5.5\text{ V}$, $T_{opr} = -10\text{ to }70^{\circ}\text{C}$)

Parameter	Oscillator	Frequency	Recommender Oscillator	Recommended Condition	
				C ₁	C ₂
High-frequency	Ceramic Resonator	8 MHz	KYOCERA KBR8.0M	30pF	30pF
			Standard/Lead Type (MURATA) CSA8.00MTZ CST8.00MTW	built-in 30pF	built-in 30pF
			Standard/SMP Type (MURATA) CSAC8.00MT	30pF	30pF
			Standard/Small ChipType (MURATA) CSTC8.00MT	built-in 30pF	built-in 30pF
	Crystal Oscillator	4 MHz	KYOCERA KBR4.0MS	30pF	30pF
		8 MHz	TOYOCOM 210B 8.0000	20pF	20pF
Low-frequency	Crystal Oscillator	4 MHz	TOYOCOM 204B 4.0000		
		32.768 kHz	NDK MX-38T	15pF	15pF

Recommended Oscillating Condition (II) ($V_{SS} = 0\text{ V}$, $V_{DD} = 2.2\text{ to }5.5\text{ V}$, $T_{opr} = -10\text{ to }70^{\circ}\text{C}$)

Parameter	Oscillator	Frequency	Recommender Oscillator	Recommended Condition	
				C ₁	C ₂
High-frequency	Ceramic Resonator	4 MHz	Standard/Lead Type (MURATA) CSA4.00MG	30pF	30pF
			CST4.00MGW	built-in 30pF	built-in 30pF
			Standard/SMD Type (MURATA) CSA4.00MGC CSAC4.00MGCM CSTC4.00MG	30pF	30pF
				built-in 30pF	built-in 30pF
			Standard/Small Chip Type CSTCS4.00MG	built-in 10pF	built-in 10pF



Note1: When used in high electric field such as a picture tube, the package is recommended to be electrically shielded to maintain a regular operation.

Note2: The product numbers and specifications of the resonators by Murata Manufacturing Co., Ltd. are subject to change. For up-to-date information, please refer to the following URL;
<http://www.murata.co.jp/search/index.html>

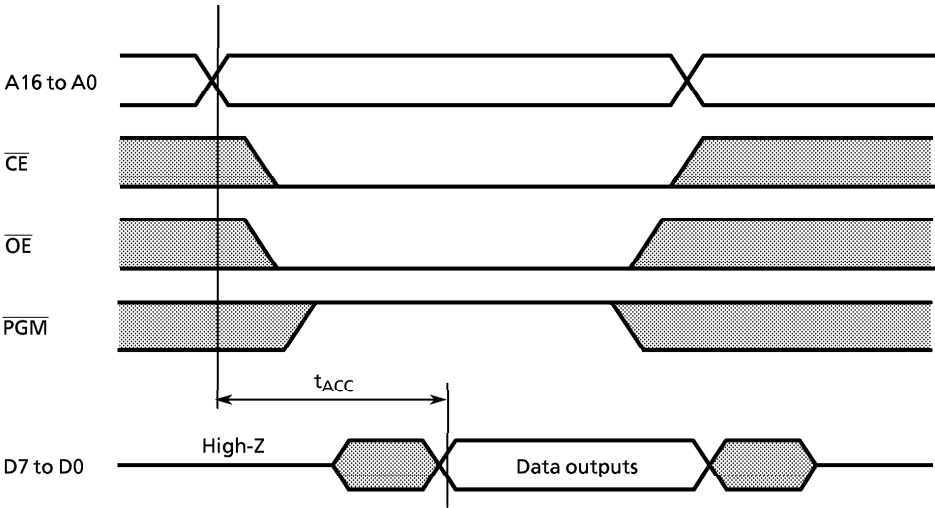
DC/AC Characteristics (PROM mode)

(V_{SS} = 0 V)

(1) Read Operation

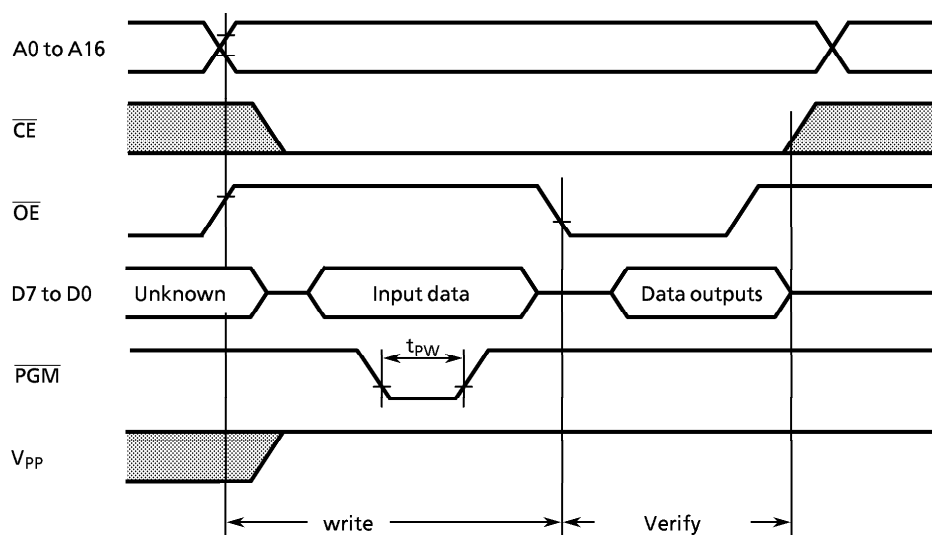
Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Input High Voltage	V _{IH4}		V _{CC} × 0.7	—	V _{CC}	V
Input Low Voltage	V _{IL4}		0	—	V _{CC} × 0.12	
Power Supply Voltage	V _{CC}		4.75	5.0	5.25	
Program Power Supply Voltage	V _{PP}					
Address Access Time	t _{ACC}	V _{CC} = 5.0 ± 0.25V	—	1.5t _{cyc} + 300	—	ns

Note: t_{cyc} = 500 ns at 8 MHz



(2) High-Speed Programming Operation ($T_{opr} = 25 \pm 5^{\circ}\text{C}$)

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Input High Voltage	V_{IH4}		$V_{CC} \times 0.7$	–	V_{CC}	V
Input Low Voltage	V_{IL4}		0	–	$V_{CC} \times 0.12$	
Power Supply Voltage	V_{CC}		6.0	6.25	6.5	
Program Power Supply Voltage	V_{PP}		12.5	12.75	13.0	
Initial Program Pulse Width	t_{PW}	$V_{CC} = 6.0\text{ V}$	0.095	0.1	0.105	ms



Note 1: When V_{CC} power supply is turned on or after, V_{PP} must be increased.

When V_{CC} power supply is turned off or before, V_{PP} must be increased.

Note 2: The device must not be set to the EPROM programmer or picked up from it under applying the program voltage ($12.5\text{ V} \pm 0.5\text{ V} = V$) to the V_{PP} pin as the device is damaged.

Note 3: Be sure to execute the recommended programming mode with the recommended programming adaptor. If a mode or an adaptor except the above, the misoperation sometimes occurs.

